

# DACx3004 12-Bit and 10-Bit, Ultra-Low-Power, Quad Voltage and Current Output Smart DACs With Auto-Detected I<sup>2</sup>C, PMBus™, or SPI

## 1 Features

- Programmable voltage or current outputs with flexible configuration:
  - Voltage outputs:
    - 1 LSB INL and DNL (10-bit)
    - Gains of 1x, 1.5x, 2x, 3x, and 4x
  - Current outputs:
    - 1 LSB INL and DNL (8-bit)
    - Unipolar and bipolar output range options from 25  $\mu$ A to 250  $\mu$ A
- 35- $\mu$ A/channel  $I_{DD}$  in voltage-output mode
- Programmable comparator mode for all channels
- High-impedance output when VDD is off
- High-impedance and resistive pulldown power-down modes
- 50-MHz SPI-compatible interface
- Automatically detected I<sup>2</sup>C, PMBus™, or SPI interface
  - 1.62-V  $V_{IH}$  with  $V_{DD} = 5.5$  V
- General-purpose input/output (GPIO) configurable as multiple functions
- Predefined waveform generation: sine wave, triangular, sawtooth
- User-programmable nonvolatile memory (NVM)
- Internal, external, or power-supply as reference
- Wide operating range:
  - Power supply: 1.8 V to 5.5 V
  - Temperature range: –40°C to +125°C
- Tiny package: 16-pin WQFN (3 mm × 3 mm)

## 2 Applications

- Land mobile radio
- Pulse oximeter
- Optical module
- Standard notebook PC

## 3 Description

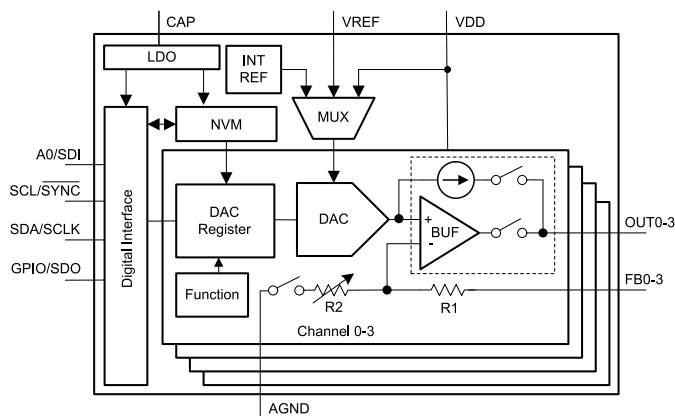
The 12-bit DAC63004 and 10-bit DAC53004 (DACx3004) are a pin-compatible family of ultra-low-power, quad-channel, buffered, voltage-output and current-output smart digital-to-analog converters (DACs). These DACx3004 support Hi-Z power-down mode and Hi-Z output during power-off condition. The DAC outputs provide a force-sense option for use as a programmable comparator and current sink. The multifunction GPIO, function generation, and NVM enable these smart DACs for processor-less applications and design reuse. These devices automatically detect I<sup>2</sup>C, PMBus, and SPI interfaces and contain an internal reference.

The feature set combined with the tiny package and ultra-low power make these smart DACs an excellent choice for applications such as land mobile radios, pulseoximeters, notebook PCs, and other battery-operated applications for biasing, calibration, and waveform generation.

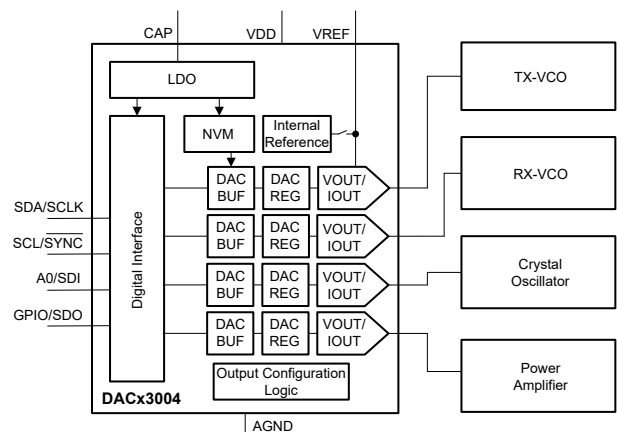
### Device Information

| PART NUMBER | PACKAGE <sup>(1)</sup> | BODY SIZE (NOM)   |
|-------------|------------------------|-------------------|
| DACx3004    | WQFN (16)              | 3.00 mm x 3.00 mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



**Simplified Block Diagram**



**DACx3004 for Biasing in Land Mobile Radio**



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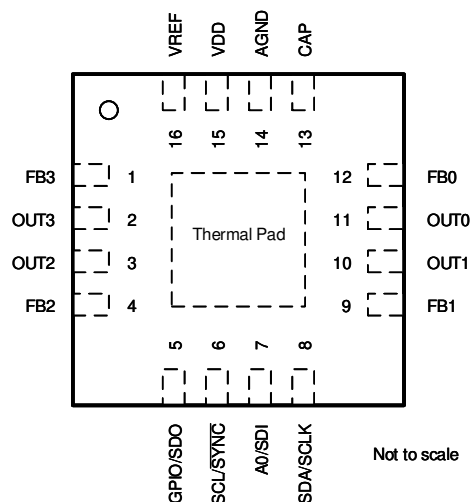
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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision * (April 2021) to Revision A (December 2021)                              | Page     |
|-------------------------------------------------------------------------------------------------|----------|
| • Changed DACx3004 devices from advanced information (preview) to production data (active)..... | <b>1</b> |

## 5 Pin Configuration and Functions



**Figure 5-1. RTE Package, 16-pin WQFN, Top View**

**Table 5-1. Pin Functions**

| PIN |             | TYPE         | DESCRIPTION                                                                                                                                                                                                                                                                                 |
|-----|-------------|--------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NO. | NAME        |              |                                                                                                                                                                                                                                                                                             |
| 1   | FB3         | Input        | Voltage feedback pin for channel 3. In voltage-output mode, connect to OUT3 for closed-loop amplifier output. In current-output mode, keep the FB3 pin unconnected to minimize leakage current.                                                                                             |
| 2   | OUT3        | Output       | Analog output voltage from DAC channel 3.                                                                                                                                                                                                                                                   |
| 3   | OUT2        | Output       | Analog output voltage from DAC channel 2.                                                                                                                                                                                                                                                   |
| 4   | FB2         | Input        | Voltage feedback pin for channel 2. In voltage-output mode, connect to OUT2 for closed-loop amplifier output. In current-output mode, keep the FB2 pin unconnected to minimize leakage current.                                                                                             |
| 5   | GPIO/SDO    | Input/Output | General-purpose input/output configurable as LDAC, PD, PROTECT, RESET, SDO, and STATUS. For STATUS and SDO, connect the pin to the IO voltage with an external pullup resistor. If unused, connect the GPIO pin to VDD or AGND using an external resistor. This pin can ramp up before VDD. |
| 6   | SCL/SYNC    | Output       | I <sup>2</sup> C serial interface clock or SPI chip select input. This pin must be connected to the IO voltage using an external pullup resistor. This pin can ramp up before VDD.                                                                                                          |
| 7   | A0/SDI      | Input        | Address configuration pin for I <sup>2</sup> C or serial data input for SPI. For A0, connect this pin to VDD, AGND, SDA, or SCL for address configuration (Section 7.5.2.2.1). For SDI, this pin need not be pulled up or pulled down. This pin can ramp up before VDD.                     |
| 8   | SDA/SCLK    | Input/Output | Bidirectional I <sup>2</sup> C serial data bus or SPI clock input. This pin must be connected to the IO voltage using an external pullup resistor in the I <sup>2</sup> C mode. This pin can ramp up before VDD.                                                                            |
| 9   | FB1         | Input        | Voltage feedback pin for channel 1. In voltage-output mode, connect to OUT1 for closed-loop amplifier output. In current-output mode, keep the FB1 pin unconnected to minimize leakage current.                                                                                             |
| 10  | OUT1        | Output       | Analog output voltage from DAC channel 1.                                                                                                                                                                                                                                                   |
| 11  | OUT0        | Output       | Analog output voltage from DAC channel 0.                                                                                                                                                                                                                                                   |
| 12  | FB0         | Input        | Voltage feedback pin for channel 0. In voltage-output mode, connect to OUT0 for closed-loop amplifier output. In current-output mode, keep the FB0 pin unconnected to minimize leakage current.                                                                                             |
| 13  | CAP         | Power        | External bypass capacitor for the internal LDO. Connect a capacitor (approximately 1.5 µF) between CAP and AGND.                                                                                                                                                                            |
| 14  | AGND        | Ground       | Ground reference point for all circuitry on the device.                                                                                                                                                                                                                                     |
| 15  | VDD         | Power        | Supply voltage.                                                                                                                                                                                                                                                                             |
| 16  | VREF        | Power        | External reference input. Connect a capacitor (approximately 0.1 µF) between VREF and AGND. Use a pullup resistor to VDD when the external reference is not used. This pin must not ramp up before VDD. In case an external reference is used, make sure the reference ramps up after VDD.  |
| —   | Thermal Pad | Ground       | Connect the thermal pad to AGND.                                                                                                                                                                                                                                                            |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                          | MIN  | MAX                   | UNIT |
|------------------|----------------------------------------------------------|------|-----------------------|------|
| V <sub>DD</sub>  | Supply voltage, V <sub>DD</sub> to A <sub>GND</sub>      | −0.3 | 6                     | V    |
|                  | Digital inputs to A <sub>GND</sub>                       | −0.3 | V <sub>DD</sub> + 0.3 | V    |
|                  | CAP to A <sub>GND</sub>                                  | −0.3 | 1.65                  | V    |
|                  | V <sub>FBX</sub> to A <sub>GND</sub>                     | −0.3 | V <sub>DD</sub> + 0.3 | V    |
|                  | V <sub>OUTX</sub> to A <sub>GND</sub>                    | −0.3 | V <sub>DD</sub> + 0.3 | V    |
| V <sub>REF</sub> | External reference, V <sub>REF</sub> to A <sub>GND</sub> | −0.3 | V <sub>DD</sub> + 0.3 | V    |
|                  | Current into any pin except the OUTx pins                | −10  | 10                    | mA   |
| T <sub>J</sub>   | Junction temperature                                     | −40  | 150                   | °C   |
| T <sub>stg</sub> | Storage temperature                                      | −65  | 150                   | °C   |

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.

### 6.2 ESD Ratings

|                    |                         |                                                                                 | VALUE | UNIT |
|--------------------|-------------------------|---------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>     | ±2000 | V    |
|                    |                         | Charged device model (CDM), per ANSI/ESDA/JEDEC JS-002, all pins <sup>(2)</sup> | ±500  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.  
 (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                  |                                                             | MIN  | NOM | MAX             | UNIT |
|------------------|-------------------------------------------------------------|------|-----|-----------------|------|
| V <sub>DD</sub>  | Positive supply voltage to ground (A <sub>GND</sub> )       | 1.7  |     | 5.5             | V    |
| V <sub>REF</sub> | External reference to ground (A <sub>GND</sub> )            | 1.7  |     | V <sub>DD</sub> | V    |
| V <sub>IH</sub>  | Digital input high voltage, 1.7 V < V <sub>DD</sub> ≤ 5.5 V | 1.62 |     |                 | V    |
| V <sub>IL</sub>  | Digital input low voltage                                   |      |     | 0.4             | V    |
| C <sub>CAP</sub> | External capacitor on CAP pin                               | 0.5  |     | 15              | μF   |
| T <sub>A</sub>   | Ambient temperature                                         | −40  |     | 125             | °C   |

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | DACx3004   | UNIT |
|-------------------------------|----------------------------------------------|------------|------|
|                               |                                              | RTE (WQFN) |      |
|                               |                                              | 16 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 49         | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 50         | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 24.1       | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 1.1        | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 24.1       | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | 8.7        | °C/W |

- (1) For information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application report](#).

## 6.5 Electrical Characteristics: Voltage Output

all minimum/maximum specifications at  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$  and typical specifications at  $T_A = 25^\circ\text{C}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , DAC reference tied to VDD, gain = 1x, DAC output pin (OUT) loaded with resistive load ( $R_L = 5\text{ k}\Omega$  to AGND) and capacitive load ( $C_L = 200\text{ pF}$  to AGND), and digital inputs at VDD or AGND (unless otherwise noted)

| PARAMETER          |                                                         | TEST CONDITIONS                                                                                                                                      | MIN                                                                                                                                                                                                                                                                                             | TYP  | MAX  | UNIT              |
|--------------------|---------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|------|-------------------|
| STATIC PERFORMANCE |                                                         |                                                                                                                                                      |                                                                                                                                                                                                                                                                                                 |      |      |                   |
|                    | Resolution                                              | DAC63004                                                                                                                                             | 12                                                                                                                                                                                                                                                                                              |      |      | Bits              |
|                    |                                                         | DAC53004                                                                                                                                             | 10                                                                                                                                                                                                                                                                                              |      |      |                   |
| INL                | Integral nonlinearity <sup>(1)</sup>                    | DAC63004                                                                                                                                             | −4                                                                                                                                                                                                                                                                                              |      |      | LSB               |
|                    |                                                         | DAC53004                                                                                                                                             | −1                                                                                                                                                                                                                                                                                              |      |      |                   |
| DNL                | Differential nonlinearity <sup>(1)</sup>                |                                                                                                                                                      | −1                                                                                                                                                                                                                                                                                              |      |      | LSB               |
|                    | Zero-code error <sup>(4)</sup>                          | Code 0d into DAC, external reference, V <sub>DD</sub> = 5.5 V                                                                                        | 6                                                                                                                                                                                                                                                                                               |      |      | mV                |
|                    |                                                         | Code 0d into DAC, internal V <sub>REF</sub> , gain = 4x, V <sub>DD</sub> = 5.5 V                                                                     | 6                                                                                                                                                                                                                                                                                               |      |      |                   |
|                    | Zero-code error temperature coefficient <sup>(4)</sup>  | Code 0d into DAC                                                                                                                                     | ±10                                                                                                                                                                                                                                                                                             |      |      | μV/°C             |
|                    | Offset error <sup>(4) (6)</sup>                         | 1.7 V ≤ V <sub>DD</sub> < 2.7 V, FBx pin shorted to OUTx, DAC code: 32d for 12-bit resolution, 8d for 10-bit resolution                              | −0.75                                                                                                                                                                                                                                                                                           | 0.3  | 0.75 | %FSR              |
|                    |                                                         | 2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V, FBx pin shorted to OUTx, DAC code: 32d for 12-bit resolution, 8d for 10-bit resolution                              | −0.5                                                                                                                                                                                                                                                                                            | 0.25 | 0.5  |                   |
|                    | Offset-error temperature coefficient <sup>(4)</sup>     | FBx pin shorted to OUTx, DAC code: 32d for 12-bit resolution, 8d for 10-bit resolution                                                               | ±0.0003                                                                                                                                                                                                                                                                                         |      |      | %FSR/°C           |
|                    | Gain error <sup>(4)</sup>                               | Between end-point codes: 32d to 4064d for 12-bit resolution, 8d to 1016d for 10-bit resolution                                                       | −0.5                                                                                                                                                                                                                                                                                            | 0.25 | 0.5  | %FSR              |
|                    | Gain-error temperature coefficient <sup>(4)</sup>       | Between end-point codes: 32d to 4064d for 12-bit resolution, 8d to 1016d for 10-bit resolution                                                       | ±0.0008                                                                                                                                                                                                                                                                                         |      |      | %FSR/°C           |
|                    | Full-scale error <sup>(4) (6)</sup>                     | 1.7 V ≤ V <sub>DD</sub> < 2.7 V, DAC at full-scale                                                                                                   | −1                                                                                                                                                                                                                                                                                              |      |      | %FSR              |
|                    |                                                         | 2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V, DAC at full-scale                                                                                                   | −0.5                                                                                                                                                                                                                                                                                            |      |      |                   |
|                    | Full-scale-error temperature coefficient <sup>(4)</sup> | DAC at full-scale                                                                                                                                    | ±0.0008                                                                                                                                                                                                                                                                                         |      |      | %FSR/°C           |
| OUTPUT             |                                                         |                                                                                                                                                      |                                                                                                                                                                                                                                                                                                 |      |      |                   |
|                    | Output voltage                                          | Reference tied to V <sub>DD</sub>                                                                                                                    | 0                                                                                                                                                                                                                                                                                               |      |      | V <sub>DD</sub> V |
| C <sub>L</sub>     | Capacitive load <sup>(2)</sup>                          | R <sub>L</sub> = infinite, phase margin = 30°                                                                                                        | 200                                                                                                                                                                                                                                                                                             |      |      | pF                |
|                    |                                                         | Phase margin = 30°                                                                                                                                   | 1000                                                                                                                                                                                                                                                                                            |      |      |                   |
|                    | Short-circuit current                                   | V <sub>DD</sub> = 1.7 V, full-scale output shorted to A <sub>GND</sub> or zero-scale output shorted to V <sub>DD</sub>                               | 15                                                                                                                                                                                                                                                                                              |      |      | mA                |
|                    |                                                         | V <sub>DD</sub> = 2.7 V, full-scale output shorted to A <sub>GND</sub> or zero-scale output shorted to V <sub>DD</sub>                               | 50                                                                                                                                                                                                                                                                                              |      |      |                   |
|                    |                                                         | V <sub>DD</sub> = 5.5 V, full-scale output shorted to A <sub>GND</sub> or zero-scale output shorted to V <sub>DD</sub>                               | 60                                                                                                                                                                                                                                                                                              |      |      |                   |
|                    | Output-voltage headroom <sup>(2)</sup>                  | To V <sub>DD</sub> (DAC output unloaded, internal reference = 1.21 V), V <sub>DD</sub> ≥ 1.21 V × gain + 0.2 V                                       | 0.2                                                                                                                                                                                                                                                                                             |      |      | V                 |
|                    |                                                         | To V <sub>DD</sub> and A <sub>GND</sub> (DAC output unloaded, external reference at V <sub>DD</sub> , gain = 1x, the VREF pin is not shorted to VDD) | 0.8                                                                                                                                                                                                                                                                                             |      |      |                   |
|                    |                                                         |                                                                                                                                                      | To V <sub>DD</sub> and A <sub>GND</sub> (I <sub>LOAD</sub> = 10 mA at V <sub>DD</sub> = 5.5 V, I <sub>LOAD</sub> = 3 mA at V <sub>DD</sub> = 2.7 V, I <sub>LOAD</sub> = 1 mA at V <sub>DD</sub> = 1.8 V), external reference at V <sub>DD</sub> , gain = 1x, the VREF pin is not shorted to VDD | 10   |      |                   |
| Z <sub>O</sub>     | V <sub>FB</sub> dc output impedance <sup>(3)</sup>      | DAC output enabled, internal reference (gain = 1.5x or 2x) or external reference at V <sub>DD</sub> (gain = 1x), the VREF pin is not shorted to VDD  | 400                                                                                                                                                                                                                                                                                             | 500  | 600  | kΩ                |
|                    |                                                         | DAC output enabled, internal V <sub>REF</sub> , gain = 3x or 4x                                                                                      | 325                                                                                                                                                                                                                                                                                             | 400  | 485  |                   |
|                    | Power supply rejection ratio (dc)                       | Internal V <sub>REF</sub> , gain = 2x, DAC at midscale, V <sub>DD</sub> = 5 V ±10%                                                                   | 0.25                                                                                                                                                                                                                                                                                            |      |      | mV/V              |

## 6.5 Electrical Characteristics: Voltage Output (continued)

all minimum/maximum specifications at  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$  and typical specifications at  $T_A = 25^\circ\text{C}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , DAC reference tied to VDD, gain = 1x, DAC output pin (OUT) loaded with resistive load ( $R_L = 5\text{ k}\Omega$  to AGND) and capacitive load ( $C_L = 200\text{ pF}$  to AGND), and digital inputs at VDD or AGND (unless otherwise noted)

| PARAMETER                  |                                                  | TEST CONDITIONS                                                                                                                       | MIN | TYP  | MAX | UNIT                           |
|----------------------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|--------------------------------|
| <b>DYNAMIC PERFORMANCE</b> |                                                  |                                                                                                                                       |     |      |     |                                |
| $t_{\text{sett}}$          | Output voltage settling time                     | 1/4 to 3/4 scale and 3/4 to 1/4 scale settling to 10%FSR, $V_{DD} = 5.5\text{ V}$                                                     |     | 20   |     | $\mu\text{s}$                  |
|                            |                                                  | 1/4 to 3/4 scale and 3/4 to 1/4 scale settling to 10%FSR, $V_{DD} = 5.5\text{ V}$ , internal $V_{REF}$ , gain = 4x                    |     | 25   |     |                                |
|                            | Slew rate                                        | $V_{DD} = 5.5\text{ V}$                                                                                                               |     | 0.3  |     | V/ $\mu\text{s}$               |
|                            | Power-on glitch magnitude                        | At startup (DAC output disabled)                                                                                                      |     | 75   |     | mV                             |
|                            |                                                  | At startup (DAC output disabled), $R_L = 100\text{ k}\Omega$                                                                          |     | 200  |     |                                |
|                            | Output-enable glitch magnitude                   | DAC output disabled to enabled (DAC registers at zero scale), $R_L = 100\text{ k}\Omega$                                              |     | 250  |     | mV                             |
| $V_n$                      | Output noise voltage (peak to peak)              | $f = 0.1\text{ Hz}$ to $10\text{ Hz}$ , DAC at midscale, $V_{DD} = 5.5\text{ V}$                                                      |     | 50   |     | $\mu\text{V}_{PP}$             |
|                            |                                                  | Internal $V_{REF}$ , gain = 4x, $f = 0.1\text{ Hz}$ to $10\text{ Hz}$ , DAC at midscale, $V_{DD} = 5.5\text{ V}$                      |     | 90   |     |                                |
|                            | Output noise density                             | $f = 1\text{ kHz}$ , DAC at midscale, $V_{DD} = 5.5\text{ V}$                                                                         |     | 0.35 |     | $\mu\text{V}/\sqrt{\text{Hz}}$ |
|                            |                                                  | Internal $V_{REF}$ , gain = 4x, $f = 1\text{ kHz}$ , DAC at midscale, $V_{DD} = 5.5\text{ V}$                                         |     | 0.9  |     |                                |
|                            | Power supply rejection ratio (ac) <sup>(3)</sup> | Internal $V_{REF}$ , gain = 4x, 200-mV 50-Hz or 60-Hz sine wave superimposed on power supply voltage, DAC at midscale                 |     | -68  |     | dB                             |
|                            | Code change glitch impulse                       | $\pm 1$ LSB change around midscale (including feedthrough)                                                                            |     | 10   |     | nV-s                           |
|                            | Code change glitch impulse magnitude             | $\pm 1$ LSB change around midscale (including feedthrough)                                                                            |     | 15   |     | mV                             |
| <b>POWER</b>               |                                                  |                                                                                                                                       |     |      |     |                                |
| $I_{DD}$                   | Current flowing into VDD <sup>(4) (5)</sup>      | Normal operation, DACs at full scale, digital pins static, external reference at $V_{DD}$ but the $V_{REF}$ pin is not shorted to VDD |     | 35   | 50  | $\mu\text{A}/\text{ch}$        |

- (1) Measured with DAC output unloaded. For external reference and internal reference  $V_{DD} \geq 1.21 \times \text{gain} + 0.2\text{ V}$ , between end-point codes: 32d to 4064d for 12-bit resolution, 8d to 1016d for 10-bit resolution.
- (2) Specified by design and characterization, not production tested.
- (3) Specified with 200-mV headroom with respect to reference value when internal reference is used.
- (4) Measured with DAC output unloaded.
- (5) The total power consumption is calculated by  $I_{DD} \times (\text{total number of channels powered on}) + (\text{sleep-mode current})$ .
- (6) When a DAC channel is configured in IOUT mode for long term and then switched to VOUT mode, the VOUT mode can show parametric drift.

## 6.6 Electrical Characteristics: Current Output

all minimum/maximum specifications at  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$  and typical specifications at  $T_A = 25^\circ\text{C}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $\pm 250\mu\text{A}$  output range, and digital inputs at VDD or AGND (unless otherwise noted)

| PARAMETER           |                                                     | TEST CONDITIONS                                                                                                                                             | MIN  | TYP | MAX              | UNIT |
|---------------------|-----------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|------|-----|------------------|------|
| STATIC PERFORMANCE  |                                                     |                                                                                                                                                             |      |     |                  |      |
|                     | Resolution                                          |                                                                                                                                                             | 8    |     |                  | Bits |
| INL                 | Integral nonlinearity                               | DAC codes between 10d and 255d for current output range of 0 μA to 25 μA, DAC codes between 0d and 255d for other ranges                                    | −1   |     | 1                | LSB  |
| DNL                 | Differential nonlinearity                           | DAC codes between 10d and 255d for current output range of 0 μA to 25 μA, DAC codes between 0d and 255d for other ranges                                    | −1   |     | 1                | LSB  |
|                     | Offset error                                        | DAC output range: 0 μA to 25 μA, DAC at code 10d                                                                                                            | ±1.5 |     | %FSR             |      |
|                     |                                                     | DAC output ranges: 0 μA to 50 μA, 0 μA to 125 μA, and 0 μA to 250 μA; DAC at zero-scale                                                                     | 5    |     |                  |      |
|                     |                                                     | all unipolar negative ranges, DAC at zero-scale                                                                                                             | -5   |     |                  |      |
|                     |                                                     | DAC output ranges: ±25 μA, ±50 μA, ±125 μA, and ±250 μA; DAC at midscale                                                                                    | ±1   |     |                  |      |
|                     | Gain error                                          | DAC output range: 0 μA to 25 μA, DAC codes between 10d and 255d                                                                                             | ±1.5 |     | %FSR             |      |
|                     |                                                     | DAC output ranges: 0 μA to 50 μA, 0 μA to 125 μA, and 0 μA to 250 μA; DAC codes between 0d and 255d                                                         | ±1.5 |     |                  |      |
|                     |                                                     | all unipolar negative ranges, DAC codes between 0d and 255d                                                                                                 | ±5   |     |                  |      |
|                     |                                                     | DAC output ranges: ±25 μA, ±50 μA, ±125 μA, and ±250 μA; DAC codes between 0d and 255d                                                                      | ±1.3 |     |                  |      |
| OUTPUT              |                                                     |                                                                                                                                                             |      |     |                  |      |
|                     | Output compliance voltage <sup>(1)</sup>            | DAC output range: 0 μA to 25 μA, to V <sub>DD</sub> and to A <sub>GND</sub>                                                                                 | 200  |     | mV               |      |
|                     |                                                     | DAC output ranges: 0 μA to 50 μA, 0 μA to 125 μA, and 0 μA to 250 μA; to V <sub>DD</sub>                                                                    | 400  |     |                  |      |
|                     |                                                     | all unipolar negative ranges, to V <sub>DD</sub>                                                                                                            | 400  |     |                  |      |
|                     |                                                     | DAC output ranges: ±25 μA, ±50 μA, ±125 μA, and ±250 μA; to V <sub>DD</sub> and to A <sub>GND</sub>                                                         | 400  |     |                  |      |
| Z <sub>O</sub>      | I <sub>OUT</sub> dc output impedance <sup>(2)</sup> | DAC at midscale, DAC output kept at V <sub>DD</sub> /2                                                                                                      | 60   |     | MΩ               |      |
|                     | Power supply rejection ratio (dc)                   | DAC at midscale, output range: 0 μA to 25 μA, V <sub>DD</sub> changed from 4.5 V to 5.5 V                                                                   | 0.28 |     | LSB/V            |      |
|                     |                                                     | DAC at midscale, all unipolar positive ranges, V <sub>DD</sub> changed from 4.5 V to 5.5V                                                                   | 0.33 |     |                  |      |
|                     |                                                     | DAC at midscale, all unipolar negative ranges, V <sub>DD</sub> changed from 4.5 V to 5.5V                                                                   | 0.83 |     |                  |      |
|                     |                                                     | DAC at midscale, all bipolar ranges, V <sub>DD</sub> changed from 4.5V to 5.5V                                                                              | 0.23 |     |                  |      |
| DYNAMIC PERFORMANCE |                                                     |                                                                                                                                                             |      |     |                  |      |
| t <sub>sett</sub>   | Output current settling time                        | 1/4 to 3/4 scale and 3/4 to 1/4 scale settling to 1 LSB at 8-bit resolution, V <sub>DD</sub> = 5.5 V, common-mode voltage at OUTx pin is V <sub>DD</sub> /2 | 60   |     | μs               |      |
| V <sub>n</sub>      | Output noise current (peak to peak)                 | 0.1 Hz to 10 Hz, DAC at midscale, V <sub>DD</sub> = 5.5 V, ±250-μA output range                                                                             | 150  |     | nA <sub>pp</sub> |      |
|                     | Output noise density                                | f = 1 kHz, DAC at midscale, V <sub>DD</sub> = 5.5 V, ±250-μA output range                                                                                   | 1    |     | nA/√Hz           |      |
|                     | Power supply rejection ratio (ac) <sup>(3)</sup>    | ±250 μA output range, 200-mV 50-Hz or 60-Hz sine wave superimposed on power-supply voltage, DAC at midscale                                                 | 0.65 |     | LSB/V            |      |



## 6.6 Electrical Characteristics: Current Output (continued)

all minimum/maximum specifications at  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$  and typical specifications at  $T_A = 25^\circ\text{C}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $\pm 250\mu\text{A}$  output range, and digital inputs at VDD or AGND (unless otherwise noted)

| PARAMETER    |                                             | TEST CONDITIONS                                                                                      | MIN | TYP | MAX | UNIT             |
|--------------|---------------------------------------------|------------------------------------------------------------------------------------------------------|-----|-----|-----|------------------|
| <b>POWER</b> |                                             |                                                                                                      |     |     |     |                  |
| $I_{DD}$     | Current flowing into VDD <sup>(3) (4)</sup> | Normal operation, DACs at midscale, all unipolar output ranges, digital pins static                  |     | 18  | 24  | $\mu\text{A/ch}$ |
|              |                                             | Normal operation, DACs at full scale, $\pm 25\text{-}\mu\text{A}$ output range, digital pins static  |     | 42  | 50  |                  |
|              |                                             | Normal operation, DACs at full scale, $\pm 50\text{-}\mu\text{A}$ output range, digital pins static  |     | 56  | 70  |                  |
|              |                                             | Normal operation, DACs at full scale, $\pm 125\text{-}\mu\text{A}$ output range, digital pins static |     | 98  | 120 |                  |
|              |                                             | Normal operation, DACs at full scale, $\pm 250\text{-}\mu\text{A}$ output range, digital pins static |     | 167 | 200 |                  |

(1) Measured between DAC codes 0d and 255d.

(2) Specified by design and characterization, not production tested.

(3) The current flowing into  $V_{DD}$  does not account for the load current sourced or sinked on the OUTx pins. The VREF pin is connected to  $V_{DD}$ .

(4) The total power consumption is calculated by  $I_{DD} \times (\text{total number of channels powered on}) + (\text{sleep-mode current})$ .

## 6.7 Electrical Characteristics: Comparator Mode

all minimum/maximum specifications at  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$  and typical specifications at  $T_A = 25^\circ\text{C}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , DAC reference tied to VDD, gain = 1x in voltage output mode, DAC output pin (OUT) loaded with resistive load ( $R_L = 5\text{ k}\Omega$  to AGND) and capacitive load ( $C_L = 200\text{ pF}$  to AGND), and digital inputs at VDD or AGND (unless otherwise noted)

| PARAMETER                  |                                        | TEST CONDITIONS                                                                                                                                                                                                                                                                                                                                                 | MIN | TYP | MAX                    | UNIT          |
|----------------------------|----------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------------------------|---------------|
| <b>STATIC PERFORMANCE</b>  |                                        |                                                                                                                                                                                                                                                                                                                                                                 |     |     |                        |               |
|                            | Offset error <sup>(1) (2)</sup>        | $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , DAC at midscale, comparator input at Hi-Z, and DAC operating with external reference                                                                                                                                                                                                                             | -5  | 0   | 5                      | mV            |
|                            | Offset error time drift <sup>(1)</sup> | $V_{DD} = 5.5\text{ V}$ , external reference, $T_A = 125^\circ\text{C}$ , FBx in Hi-Z mode, DAC at full scale and $V_{FB}$ at 0 V or DAC at zero scale and $V_{FB}$ at 1.84 V, drift specified for 10 years of continuous operation                                                                                                                             |     | 4   |                        | mV            |
| <b>OUTPUT</b>              |                                        |                                                                                                                                                                                                                                                                                                                                                                 |     |     |                        |               |
|                            | Input voltage                          | VREF connected to VDD, FBx resistor network connected to ground                                                                                                                                                                                                                                                                                                 | 0   |     | $V_{DD}$               | V             |
|                            |                                        | VREF connected to VDD, FBx resistor network disconnected from ground                                                                                                                                                                                                                                                                                            | 0   |     | $V_{DD} (1/3 - 1/100)$ |               |
| $V_{OL}$                   | Logic low output voltage               | $I_{LOAD} = 100\text{ }\mu\text{A}$ , output in open-drain mode                                                                                                                                                                                                                                                                                                 |     | 0.1 |                        | V             |
| <b>DYNAMIC PERFORMANCE</b> |                                        |                                                                                                                                                                                                                                                                                                                                                                 |     |     |                        |               |
| $t_{resp}$                 | Output response time                   | DAC at midscale with 10-bit resolution, FBx input at Hi-Z, and transition step at FBx node is ( $V_{DAC} - 2\text{ LSB}$ ) to ( $V_{DAC} + 2\text{ LSB}$ ), transition time measured between 10% and 90% of output, output current of $100\text{ }\mu\text{A}$ , comparator output configured in push-pull mode, load capacitor at DAC output is $25\text{ pF}$ |     | 10  |                        | $\mu\text{s}$ |

(1) Specified by design and characterization, not production tested.

(2) This specification does not include the total unadjusted error (TUE) of the DAC.



## 6.8 Electrical Characteristics: General

all minimum/maximum specifications at  $T_A = -40^\circ\text{C}$  to  $+125^\circ\text{C}$  and typical specifications at  $T_A = 25^\circ\text{C}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , DAC reference tied to VDD, gain = 1x in voltage output mode or  $\pm 250\mu\text{A}$  output range in current output mode, DAC output pin (OUT) loaded with resistive load ( $R_L = 5\text{ k}\Omega$  to AGND) in voltage-output mode and capacitive load ( $C_L = 200\text{ pF}$  to AGND), and digital inputs at VDD or AGND (unless otherwise noted)

| PARAMETER             |                                                             | TEST CONDITIONS                                                                                                                                     | MIN                                                                        | TYP   | MAX   | UNIT   |
|-----------------------|-------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------|-------|-------|--------|
| INTERNAL REFERENCE    |                                                             |                                                                                                                                                     |                                                                            |       |       |        |
|                       | Initial accuracy                                            | T <sub>A</sub> = 25°C                                                                                                                               | 1.1979                                                                     | 1.212 | 1.224 | V      |
|                       | Reference output temperature coefficient <sup>(1) (2)</sup> |                                                                                                                                                     |                                                                            |       | 50    | ppm/°C |
| EXTERNAL REFERENCE    |                                                             |                                                                                                                                                     |                                                                            |       |       |        |
|                       | V <sub>REF</sub> input impedance <sup>(1) (3)</sup>         |                                                                                                                                                     |                                                                            | 192   |       | kΩ/ch  |
| EEPROM                |                                                             |                                                                                                                                                     |                                                                            |       |       |        |
|                       | Endurance <sup>(1)</sup>                                    | −40°C ≤ T <sub>A</sub> ≤ +85°C                                                                                                                      |                                                                            | 20000 |       | Cycles |
|                       |                                                             | T <sub>A</sub> = 125°C                                                                                                                              |                                                                            | 1000  |       |        |
|                       | Data retention <sup>(1)</sup>                               | T <sub>A</sub> = 25°C                                                                                                                               |                                                                            | 50    |       | Years  |
|                       | EEPROM programming write cycle time <sup>(1)</sup>          |                                                                                                                                                     |                                                                            |       | 200   | ms     |
|                       | Device boot-up time <sup>(1)</sup>                          | Time taken from power valid (V <sub>DD</sub> ≥ 1.7 V) to output valid state (output state as programmed in EEPROM), 0.5-μF capacitor on the CAP pin |                                                                            | 5     |       | ms     |
| DIGITAL INPUTS        |                                                             |                                                                                                                                                     |                                                                            |       |       |        |
|                       | Digital feedthrough                                         | Voltage output mode, DAC output static at midscale, fast mode plus, SCL toggling                                                                    |                                                                            | 20    |       | nV-s   |
|                       | Pin capacitance                                             | Per pin                                                                                                                                             |                                                                            | 10    |       | pF     |
| POWER-DOWN MODE       |                                                             |                                                                                                                                                     |                                                                            |       |       |        |
| I <sub>DD</sub>       | Current flowing into VDD <sup>(1)</sup>                     | DAC in sleep mode, internal reference powered down, external reference at 5.5 V                                                                     |                                                                            |       | 28    | μA     |
|                       |                                                             | DAC in sleep mode, internal reference enabled, additional current through internal reference                                                        |                                                                            |       | 10    |        |
|                       |                                                             | DAC channels enabled, internal reference enabled, additional current through internal reference per DAC channel in voltage-output mode              |                                                                            |       | 12.5  |        |
|                       |                                                             | Current flowing into VDD                                                                                                                            | DAC in deep-sleep mode, internal reference powered down, SDO mode disabled |       |       | 1.5    |
| HIGH-IMPEDANCE OUTPUT |                                                             |                                                                                                                                                     |                                                                            |       |       |        |
| I <sub>LEAK</sub>     | Current flowing into V <sub>OUTx</sub> and V <sub>FBx</sub> | DAC in Hi-Z output mode, 1.7 V ≤ V <sub>DD</sub> ≤ 5.5 V                                                                                            |                                                                            |       | 10    | nA     |
|                       |                                                             | V <sub>DD</sub> = 0 V, V <sub>OUT</sub> ≤ 1.5 V, decoupling capacitor between V <sub>DD</sub> and AGND = 0.1 μF                                     |                                                                            |       | 200   |        |
|                       |                                                             | V <sub>DD</sub> = 0 V, 1.5 V < V <sub>OUT</sub> ≤ 5.5 V, decoupling capacitor between V <sub>DD</sub> and AGND = 0.1 μF                             |                                                                            |       | 500   |        |
|                       |                                                             | 100 kΩ between V <sub>DD</sub> and AGND, V <sub>OUT</sub> ≤ 1.25 V, series resistance of 10 kΩ at OUTx pin                                          |                                                                            |       | ±2    | μA     |

(1) Specified by design and characterization, not production tested.

(2) Measured at  $-40^\circ\text{C}$  and  $+125^\circ\text{C}$  and calculated the slope.

(3) Impedances for the DAC channels are connected in parallel.

## 6.9 Timing Requirements: I<sup>2</sup>C Standard Mode

all input signals are timed from VIL to 70% of  $V_{pull-up}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ , and  $1.7\text{ V} \leq V_{pull-up} \leq V_{DD}\text{ V}$

|                     |                                                 | MIN  | NOM | MAX  | UNIT |
|---------------------|-------------------------------------------------|------|-----|------|------|
| f <sub>SCLK</sub>   | SCL frequency                                   |      |     | 100  | kHz  |
| t <sub>BUF</sub>    | Bus free time between stop and start conditions | 4.7  |     |      | μs   |
| t <sub>HDSTA</sub>  | Hold time after repeated start                  | 4    |     |      | μs   |
| t <sub>SUSTA</sub>  | Repeated start setup time                       | 4.7  |     |      | μs   |
| t <sub>SUSTO</sub>  | Stop condition setup time                       | 4    |     |      | μs   |
| t <sub>HDDAT</sub>  | Data hold time                                  | 0    |     |      | ns   |
| t <sub>SUDAT</sub>  | Data setup time                                 | 250  |     |      | ns   |
| t <sub>LOW</sub>    | SCL clock low period                            | 4700 |     |      | ns   |
| t <sub>HIGH</sub>   | SCL clock high period                           | 4000 |     |      | ns   |
| t <sub>F</sub>      | Clock and data fall time                        |      |     | 300  | ns   |
| t <sub>R</sub>      | Clock and data rise time                        |      |     | 1000 | ns   |
| t <sub>VD_DAT</sub> | Data valid time                                 |      |     | 3.45 | μs   |
| t <sub>VD_ACK</sub> | Data valid acknowledge time                     |      |     | 3.45 | μs   |

## 6.10 Timing Requirements: I<sup>2</sup>C Fast Mode

all input signals are timed from VIL to 70% of  $V_{pull-up}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ , and  $1.7\text{ V} \leq V_{pull-up} \leq V_{DD}\text{ V}$

|                     |                                                 | MIN  | NOM | MAX | UNIT |
|---------------------|-------------------------------------------------|------|-----|-----|------|
| f <sub>SCLK</sub>   | SCL frequency                                   |      |     | 400 | kHz  |
| t <sub>BUF</sub>    | Bus free time between stop and start conditions | 1.3  |     |     | μs   |
| t <sub>HDSTA</sub>  | Hold time after repeated start                  | 0.6  |     |     | μs   |
| t <sub>SUSTA</sub>  | Repeated start setup time                       | 0.6  |     |     | μs   |
| t <sub>SUSTO</sub>  | Stop condition setup time                       | 0.6  |     |     | μs   |
| t <sub>HDDAT</sub>  | Data hold time                                  | 0    |     |     | ns   |
| t <sub>SUDAT</sub>  | Data setup time                                 | 100  |     |     | ns   |
| t <sub>LOW</sub>    | SCL clock low period                            | 1300 |     |     | ns   |
| t <sub>HIGH</sub>   | SCL clock high period                           | 600  |     |     | ns   |
| t <sub>F</sub>      | Clock and data fall time                        |      |     | 300 | ns   |
| t <sub>R</sub>      | Clock and data rise time                        |      |     | 300 | ns   |
| t <sub>VD_DAT</sub> | Data valid time                                 |      |     | 0.9 | μs   |
| t <sub>VD_ACK</sub> | Data valid acknowledge time                     |      |     | 0.9 | μs   |

## 6.11 Timing Requirements: I<sup>2</sup>C Fast Mode Plus

all input signals are timed from VIL to 70% of  $V_{pull-up}$ ,  $1.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ , and  $1.7\text{ V} \leq V_{pull-up} \leq V_{DD}\text{ V}$

|                     |                                                 | MIN  | NOM | MAX  | UNIT |
|---------------------|-------------------------------------------------|------|-----|------|------|
| f <sub>SCLK</sub>   | SCL frequency                                   |      |     | 1    | MHz  |
| t <sub>BUF</sub>    | Bus free time between stop and start conditions | 0.5  |     |      | μs   |
| t <sub>HDSTA</sub>  | Hold time after repeated start                  | 0.26 |     |      | μs   |
| t <sub>SUSTA</sub>  | Repeated start setup time                       | 0.26 |     |      | μs   |
| t <sub>SUSTO</sub>  | Stop condition setup time                       | 0.26 |     |      | μs   |
| t <sub>HDDAT</sub>  | Data hold time                                  | 0    |     |      | ns   |
| t <sub>SUDAT</sub>  | Data setup time                                 | 50   |     |      | ns   |
| t <sub>LOW</sub>    | SCL clock low period                            | 0.5  |     |      | μs   |
| t <sub>HIGH</sub>   | SCL clock high period                           | 0.26 |     |      | μs   |
| t <sub>F</sub>      | Clock and data fall time                        |      |     | 120  | ns   |
| t <sub>R</sub>      | Clock and data rise time                        |      |     | 120  | ns   |
| t <sub>VD_DAT</sub> | Data valid time                                 |      |     | 0.45 | μs   |
| t <sub>VD_ACK</sub> | Data valid acknowledge time                     |      |     | 0.45 | μs   |

## 6.12 Timing Requirements: SPI Write Operation

all input signals are specified with  $t_r = t_f = 1 \text{ V/ns}$  (10% to 90% of  $V_{IO}$ ) and timed from a voltage level of  $(V_{IL} + V_{IH}) / 2$ ,  $1.7 \text{ V} \leq V_{IO} \leq 5.5 \text{ V}$ ,  $1.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ , and  $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$

|                        |                                                         | MIN | NOM | MAX | UNIT          |
|------------------------|---------------------------------------------------------|-----|-----|-----|---------------|
| $f_{\text{SCLK}}$      | Serial clock frequency                                  |     |     | 50  | MHz           |
| $t_{\text{SCLKHIGH}}$  | SCLK high time                                          | 9   |     |     | ns            |
| $t_{\text{SCLKLOW}}$   | SCLK low time                                           | 9   |     |     | ns            |
| $t_{\text{SDIS}}$      | SDI setup time                                          | 8   |     |     | ns            |
| $t_{\text{SDIH}}$      | SDI hold time                                           | 8   |     |     | ns            |
| $t_{\text{CSS}}$       | $\overline{\text{CS}}$ to SCLK falling edge setup time  | 18  |     |     | ns            |
| $t_{\text{CSH}}$       | SCLK falling edge to $\overline{\text{CS}}$ rising edge | 10  |     |     | ns            |
| $t_{\text{CSHIGH}}$    | $\overline{\text{CS}}$ hight time                       | 50  |     |     | ns            |
| $t_{\text{DACWAIT}}$   | Sequential DAC update wait time for same channel        | 2   |     |     | $\mu\text{s}$ |
| $t_{\text{BCASTWAIT}}$ | Broadcast DAC update wait time                          | 2   |     |     | $\mu\text{s}$ |

## 6.13 Timing Requirements: SPI Read and Daisy Chain Operation (FSDO = 0)

all input signals are specified with  $t_r = t_f = 1 \text{ V/ns}$  (10% to 90% of  $V_{IO}$ ) and timed from a voltage level of  $(V_{IL} + V_{IH}) / 2$ ,  $1.7 \text{ V} \leq V_{IO} \leq 5.5 \text{ V}$ ,  $1.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$ , and  $\text{FSDO} = 0$

|                       |                                                                                            | MIN | NOM | MAX  | UNIT          |
|-----------------------|--------------------------------------------------------------------------------------------|-----|-----|------|---------------|
| $f_{\text{SCLK}}$     | Serial clock frequency                                                                     |     |     | 1.25 | MHz           |
| $t_{\text{SCLKHIGH}}$ | SCLK high time                                                                             | 350 |     |      | ns            |
| $t_{\text{SCLKLOW}}$  | SCLK low time                                                                              | 350 |     |      | ns            |
| $t_{\text{SDIS}}$     | SDI setup time                                                                             | 8   |     |      | ns            |
| $t_{\text{SDIH}}$     | SDI hold time                                                                              | 8   |     |      | ns            |
| $t_{\text{CSS}}$      | $\overline{\text{SYNC}}$ to SCLK falling edge setup time                                   | 400 |     |      | ns            |
| $t_{\text{CSH}}$      | SCLK falling edge to $\overline{\text{SYNC}}$ rising edge                                  | 400 |     |      | ns            |
| $t_{\text{CSHIGH}}$   | $\overline{\text{SYNC}}$ hight time                                                        | 1   |     |      | $\mu\text{s}$ |
| $t_{\text{SDODLY}}$   | SCLK rising edge to SDO falling edge, $I_{OL} \leq 5 \text{ mA}$ , $C_L = 20 \text{ pF}$ . |     |     | 300  | ns            |

## 6.14 Timing Requirements: SPI Read and Daisy Chain Operation (FSDO = 1)

all input signals are specified with  $t_r = t_f = 1 \text{ V/ns}$  (10% to 90% of  $V_{IO}$ ) and timed from a voltage level of  $(V_{IL} + V_{IH}) / 2$ ,  $1.7 \text{ V} \leq V_{IO} \leq 5.5 \text{ V}$ ,  $1.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ ,  $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$ , and  $\text{FSDO} = 1$

|                       |                                                                                            | MIN | NOM | MAX | UNIT          |
|-----------------------|--------------------------------------------------------------------------------------------|-----|-----|-----|---------------|
| $f_{\text{SCLK}}$     | Serial clock frequency                                                                     |     |     | 2.5 | MHz           |
| $t_{\text{SCLKHIGH}}$ | SCLK high time                                                                             | 175 |     |     | ns            |
| $t_{\text{SCLKLOW}}$  | SCLK low time                                                                              | 175 |     |     | ns            |
| $t_{\text{SDIS}}$     | SDI setup time                                                                             | 8   |     |     | ns            |
| $t_{\text{SDIH}}$     | SDI hold time                                                                              | 8   |     |     | ns            |
| $t_{\text{CSS}}$      | $\overline{\text{SYNC}}$ to SCLK falling edge setup time                                   | 300 |     |     | ns            |
| $t_{\text{CSH}}$      | SCLK falling edge to $\overline{\text{SYNC}}$ rising edge                                  | 300 |     |     | ns            |
| $t_{\text{CSHIGH}}$   | $\overline{\text{SYNC}}$ hight time                                                        | 1   |     |     | $\mu\text{s}$ |
| $t_{\text{SDODLY}}$   | SCLK rising edge to SDO falling edge, $I_{OL} \leq 5 \text{ mA}$ , $C_L = 20 \text{ pF}$ . |     |     | 300 | ns            |

## 6.15 Timing Requirements: GPIO

all input signals are specified with  $t_r = t_f = 1 \text{ V/ns}$  (10% to 90% of  $V_{IO}$ ) and timed from a voltage level of  $(V_{IL} + V_{IH}) / 2$ ,  $1.7 \text{ V} \leq V_{IO} \leq 5.5 \text{ V}$ ,  $1.7 \text{ V} \leq V_{DD} \leq 5.5 \text{ V}$ , and  $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$

|                |                                                                                | MIN | NOM | MAX | UNIT          |
|----------------|--------------------------------------------------------------------------------|-----|-----|-----|---------------|
| $t_{GPIHIGH}$  | GPI high time <sup>(1)</sup>                                                   | 2   |     |     | $\mu\text{s}$ |
| $t_{GPILOW}$   | GPI low time <sup>(1)</sup>                                                    | 2   |     |     | $\mu\text{s}$ |
| $t_{GPAWGD}$   | $\overline{\text{LDAC}}$ falling edge to DAC update delay <sup>(2)</sup>       |     |     | 2   | $\mu\text{s}$ |
| $t_{CS2LDAC}$  | $\overline{\text{SYNC}}$ rising edge to $\overline{\text{LDAC}}$ falling edge  | 1   |     |     | $\mu\text{s}$ |
| $t_{STP2LDAC}$ | I <sup>2</sup> C stop bit rising edge to $\overline{\text{LDAC}}$ falling edge | 1   |     |     | $\mu\text{s}$ |
| $t_{LDACW}$    | $\overline{\text{LDAC}}$ low time                                              | 2   |     |     | $\mu\text{s}$ |

- (1) The SCL, SDA, A0, and A1 pins can be configured as GPIOs that perform different channel-specific or independent operations. The actual response time of the GPIO is determined by the delay provided by the configured function and the settling time of the DAC.
- (2) The GPIOs can be configured as channel-specific or global  $\overline{\text{LDAC}}$  function.

## 6.16 Timing Diagrams

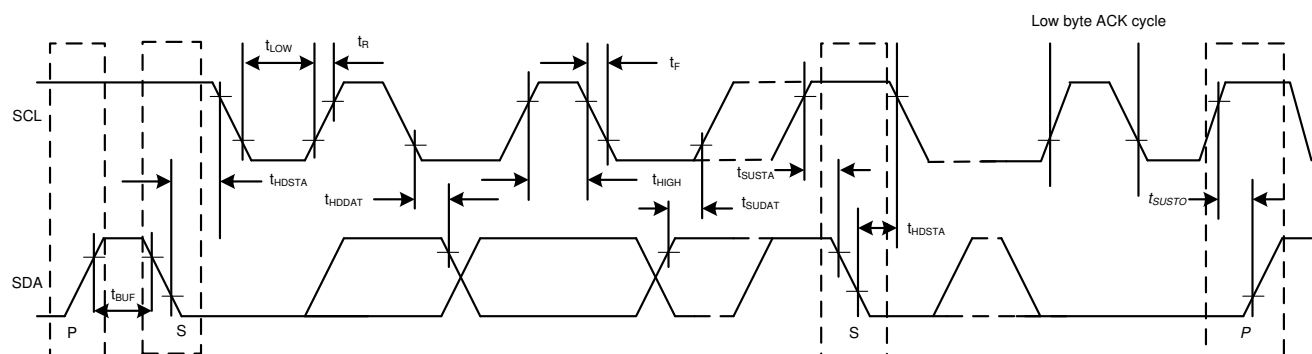


Figure 6-1. I<sup>2</sup>C Timing Diagram

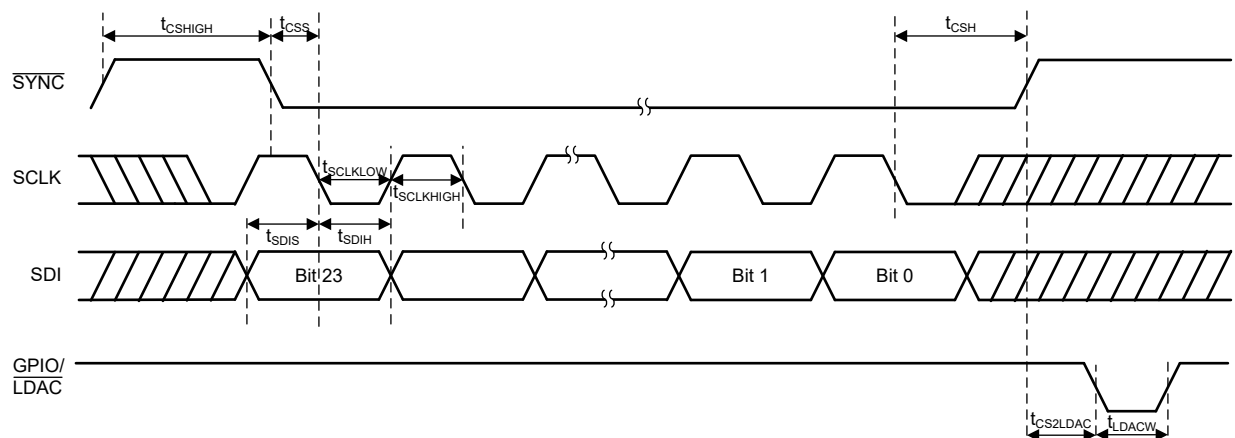


Figure 6-2. SPI Write Timing Diagram



## 6.17 Typical Characteristics: Voltage Output

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , external reference =  $5.5\text{ V}$ , gain =  $1\times$ , 12-bit resolution, and DAC outputs unloaded (unless otherwise noted)

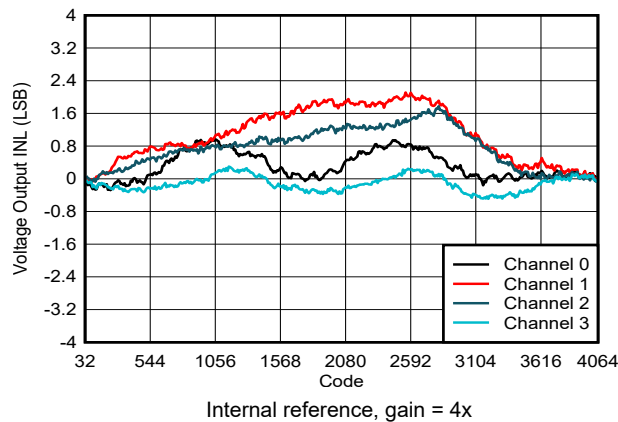


Figure 6-4. Voltage Output INL vs Digital Input Code

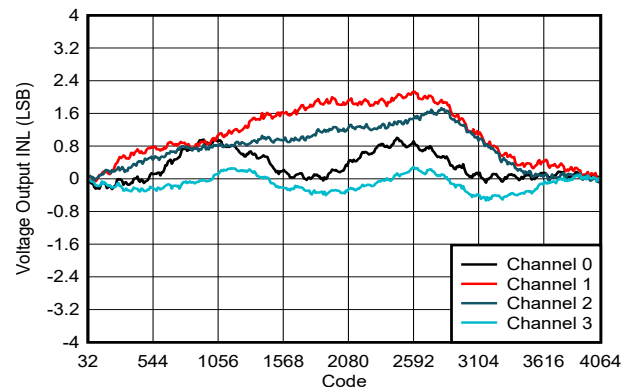


Figure 6-5. Voltage Output INL vs Digital Input Code

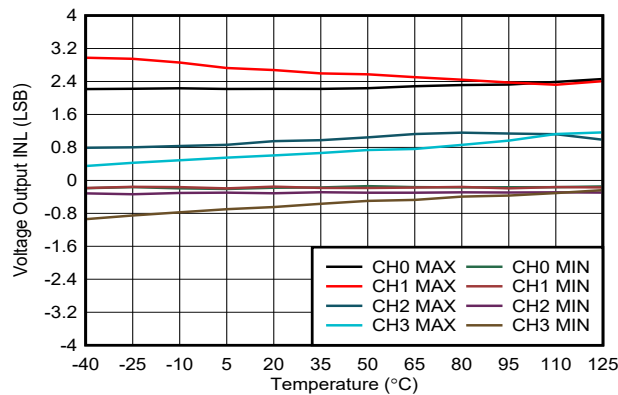


Figure 6-6. Voltage Output INL vs Temperature

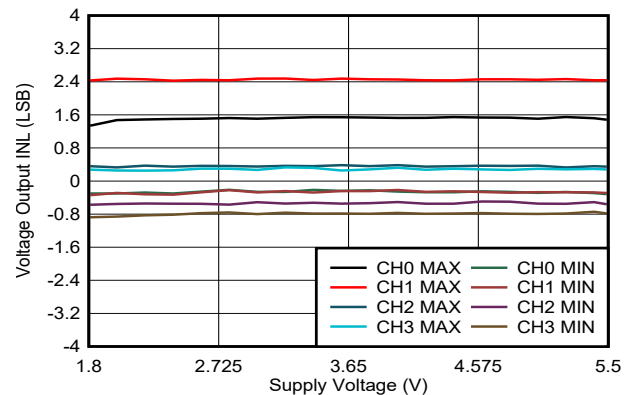


Figure 6-7. Voltage Output INL vs Supply Voltage

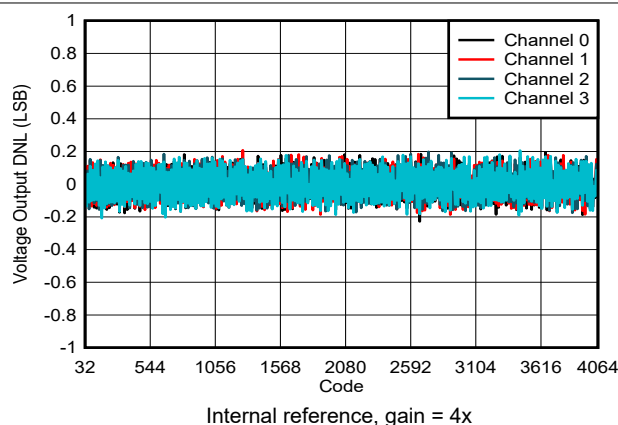


Figure 6-8. Voltage Output DNL vs Digital Input Code

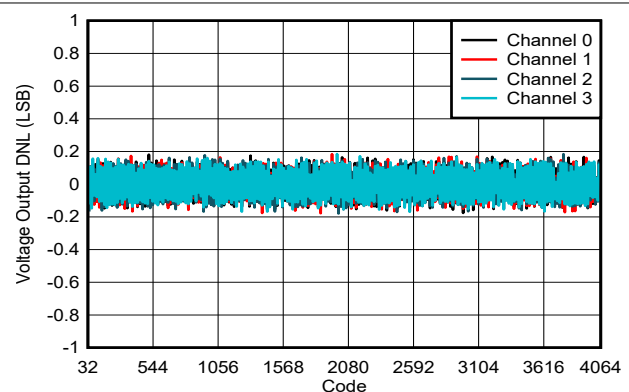
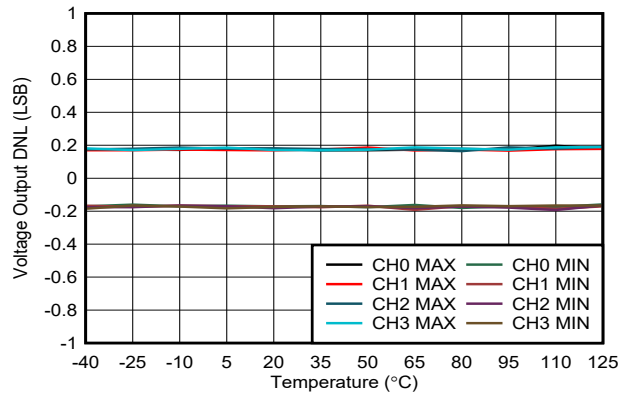


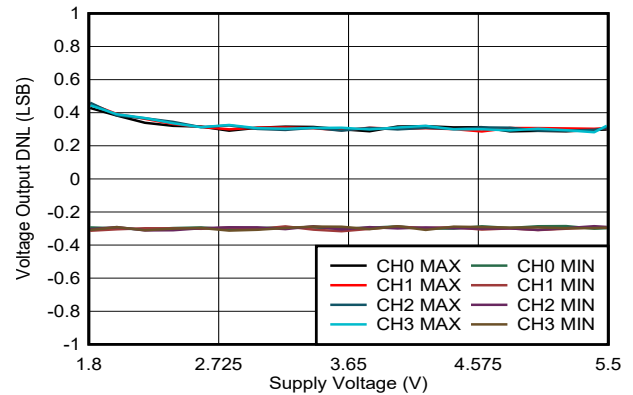
Figure 6-9. Voltage Output DNL vs Digital Input Code

## 6.17 Typical Characteristics: Voltage Output (continued)

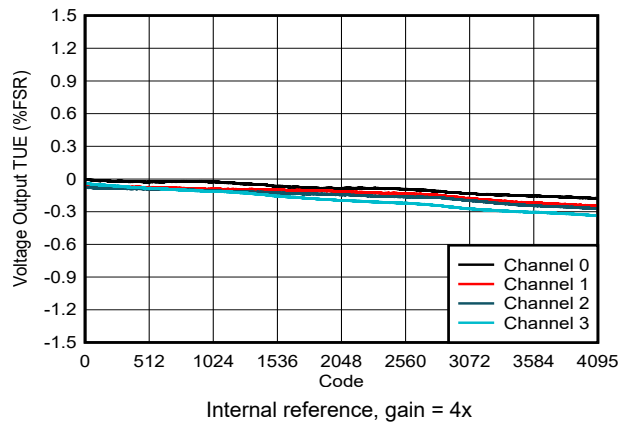
at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , external reference =  $5.5\text{ V}$ , gain =  $1\times$ , 12-bit resolution, and DAC outputs unloaded (unless otherwise noted)



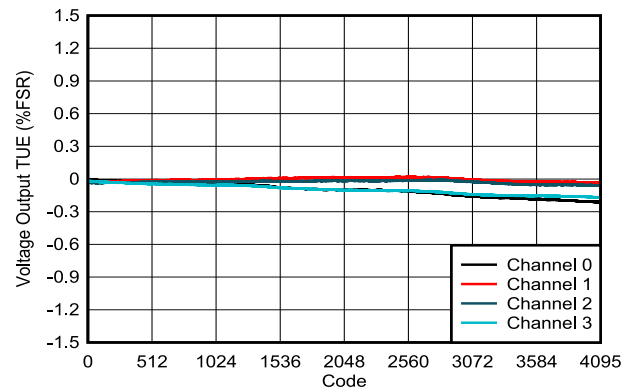
**Figure 6-10. Voltage Output DNL vs Temperature**



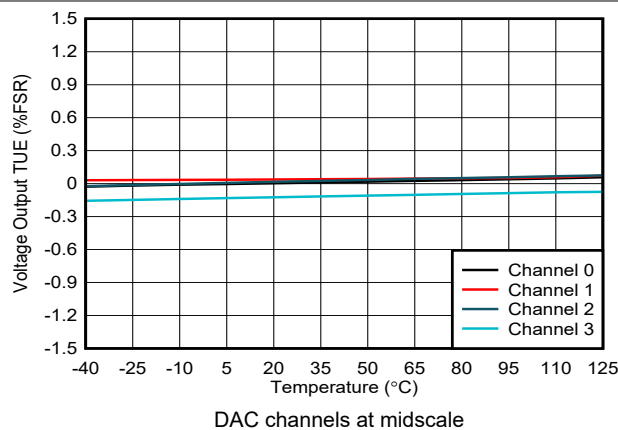
**Figure 6-11. Voltage Output DNL vs Supply Voltage**



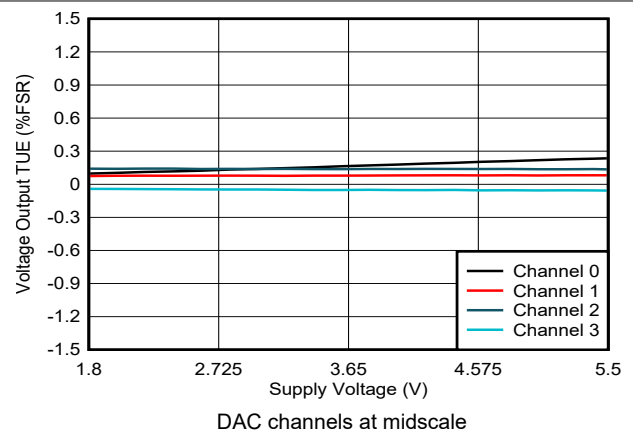
**Figure 6-12. Voltage Output TUE vs Digital Input Code**



**Figure 6-13. Voltage Output TUE vs Digital Input Code**



**Figure 6-14. Voltage Output TUE vs Temperature**



**Figure 6-15. Voltage Output TUE vs Supply Voltage**



## 6.17 Typical Characteristics: Voltage Output (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , external reference =  $5.5\text{ V}$ , gain =  $1\times$ , 12-bit resolution, and DAC outputs unloaded (unless otherwise noted)

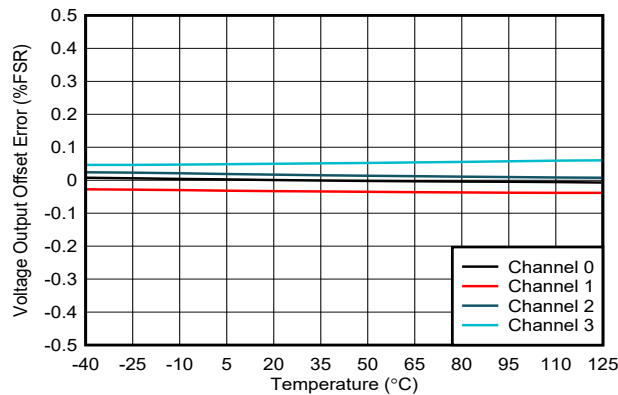


Figure 6-16. Voltage Output Offset Error vs Temperature

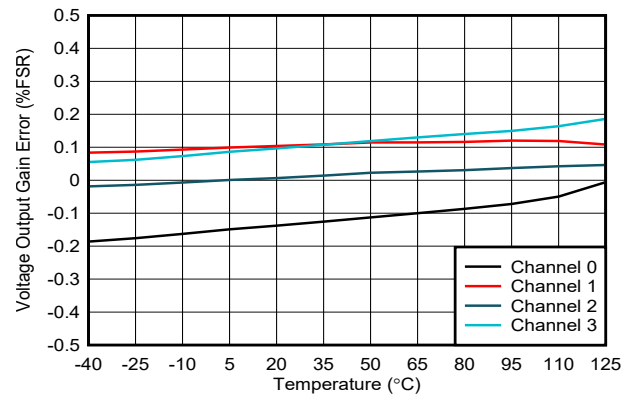


Figure 6-17. Voltage Output Gain Error vs Temperature

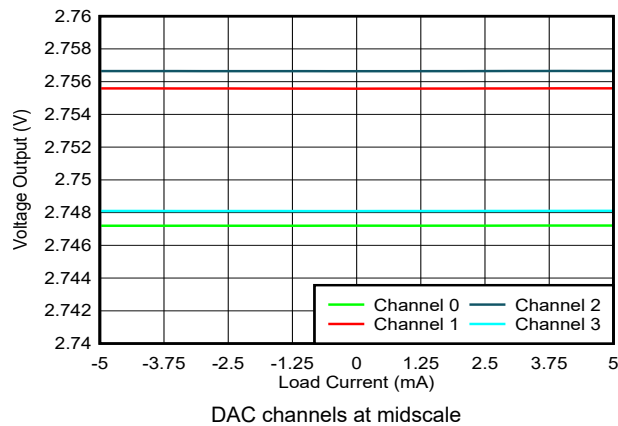


Figure 6-18. Voltage Output vs Load Current

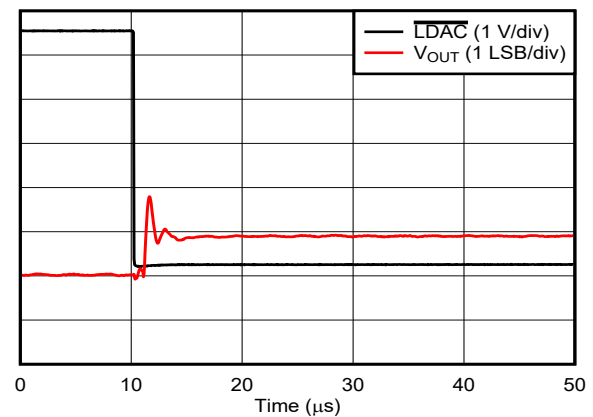


Figure 6-19. Voltage Output Code-to-Code Glitch - Rising Edge

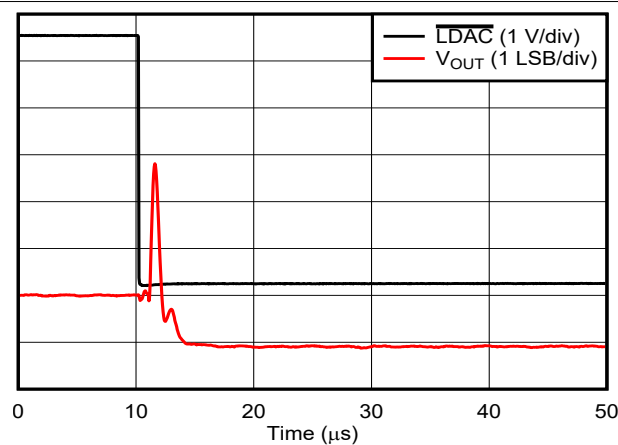


Figure 6-20. Voltage Output Code-to-Code Glitch - Falling Edge

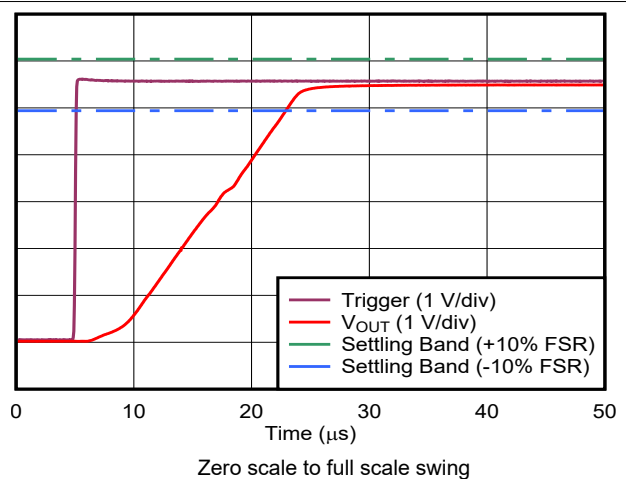
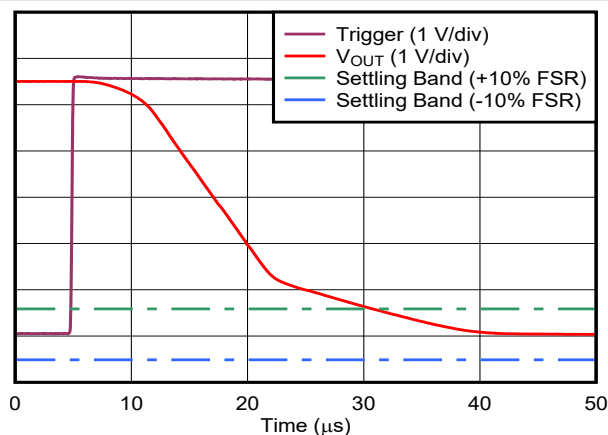


Figure 6-21. Voltage Output Setting Time - Rising Edge

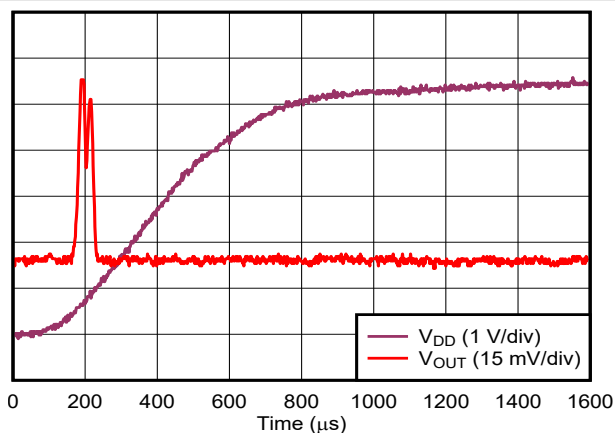
## 6.17 Typical Characteristics: Voltage Output (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , external reference =  $5.5\text{ V}$ , gain =  $1\times$ , 12-bit resolution, and DAC outputs unloaded (unless otherwise noted)



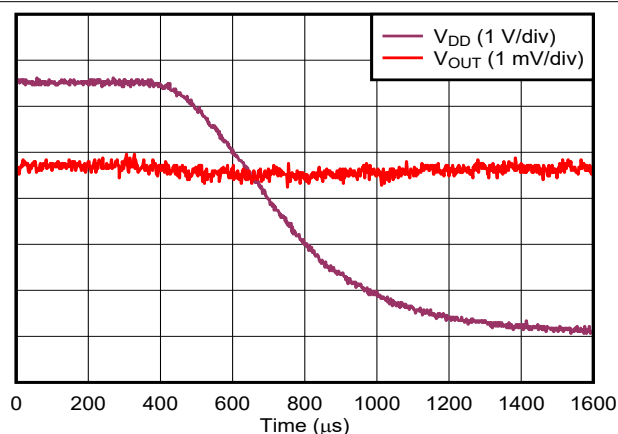
Full scale to zero scale swing

**Figure 6-22. Voltage Output Setting Time - Falling Edge**



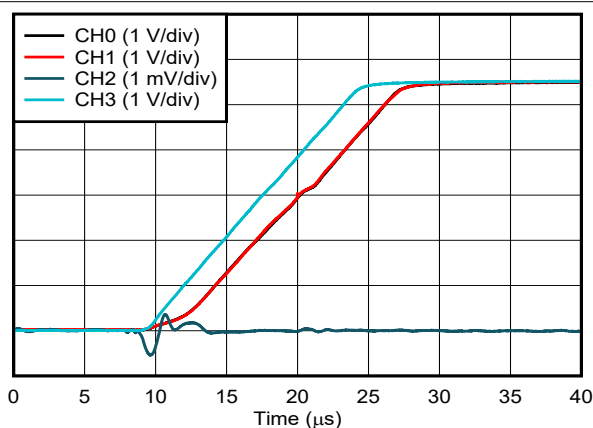
DAC in Hi-Z power-down mode

**Figure 6-23. Voltage Output Power-On Glitch**



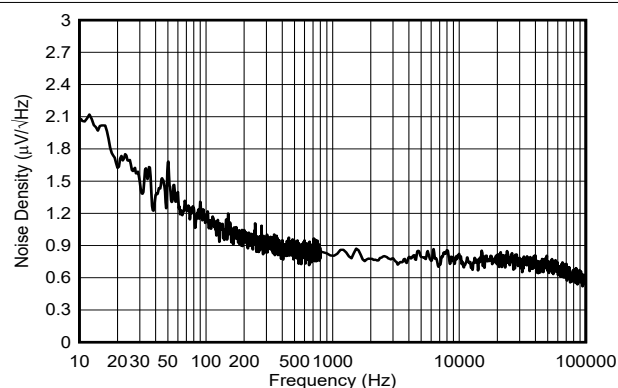
DAC at zero scale

**Figure 6-24. Voltage Output Power-Off Glitch**



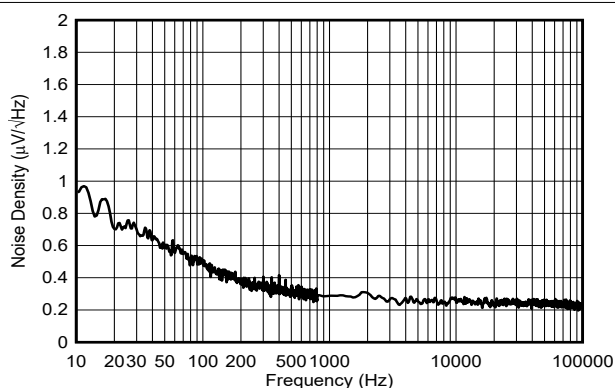
Channel 2 is victim, all other channels are aggressors

**Figure 6-25. Voltage Output Channel-to-Channel Crosstalk**



Internal reference, gain =  $4\times$

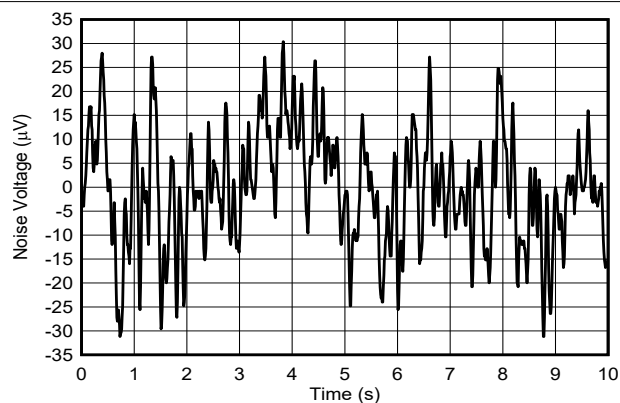
**Figure 6-26. Voltage Output Noise Density**



**Figure 6-27. Voltage Output Noise Density**

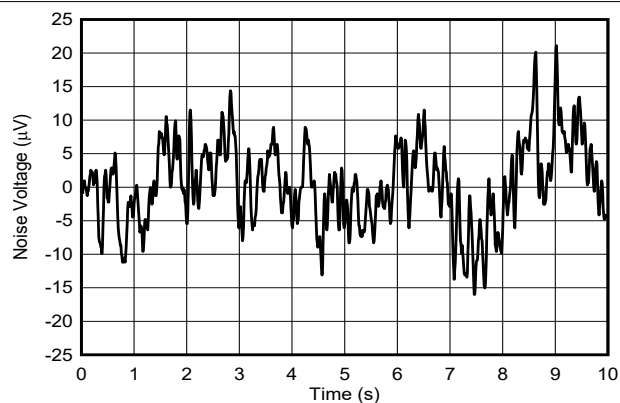
## 6.17 Typical Characteristics: Voltage Output (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , external reference =  $5.5\text{ V}$ , gain =  $1\times$ , 12-bit resolution, and DAC outputs unloaded (unless otherwise noted)



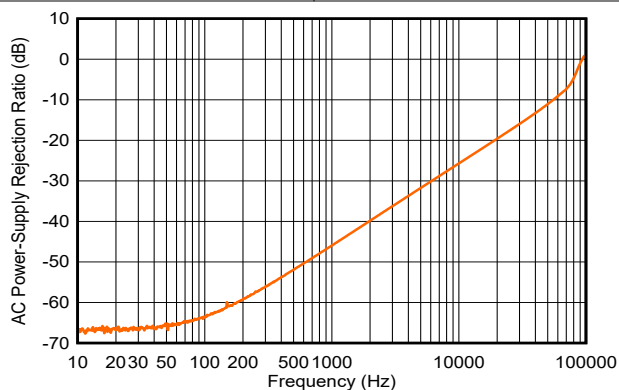
Internal reference, gain =  $4\times$ ,  $f = 0.1\text{ Hz to }10\text{ Hz}$

**Figure 6-28. Voltage Output Flicker Noise**



$f = 0.1\text{ Hz to }10\text{ Hz}$

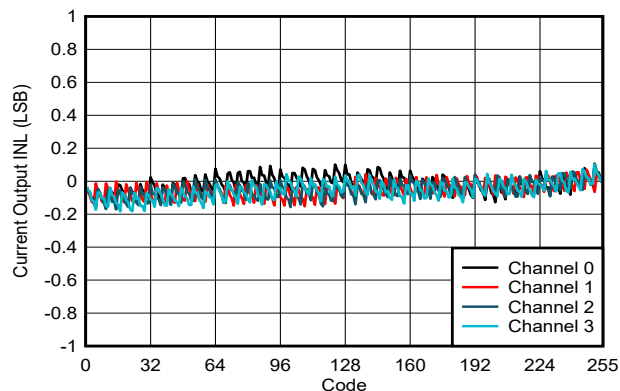
**Figure 6-29. Voltage Output Flicker Noise**



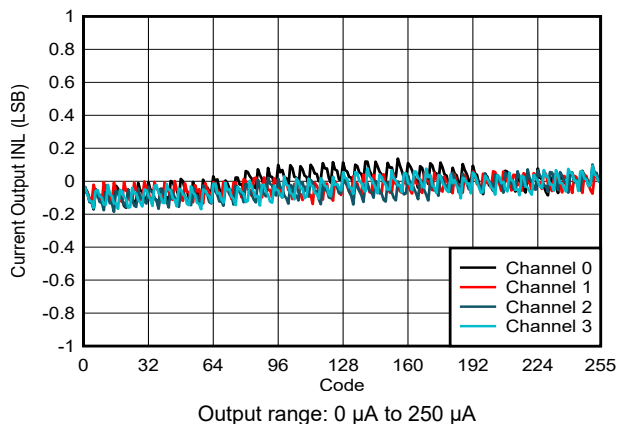
**Figure 6-30. Voltage Output AC PSRR vs Frequency**

## 6.18 Typical Characteristics: Current Output

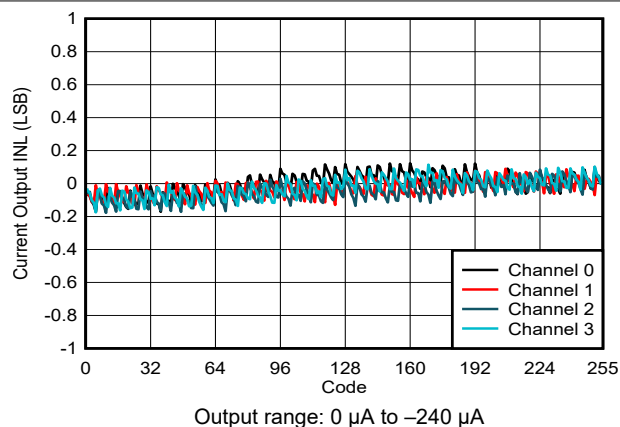
at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , output range:  $\pm 250\text{ }\mu\text{A}$  (unless otherwise noted)



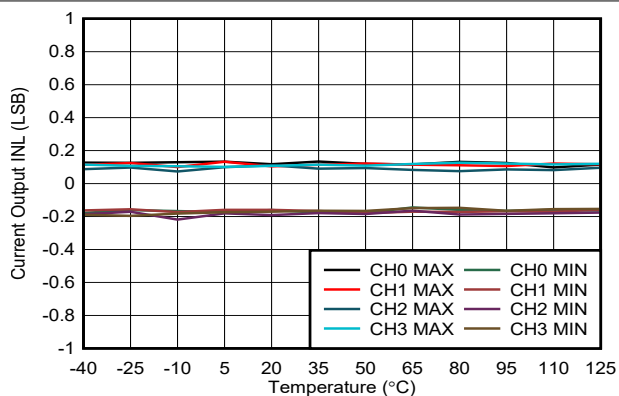
**Figure 6-31. Current Output INL vs Digital Input Code**



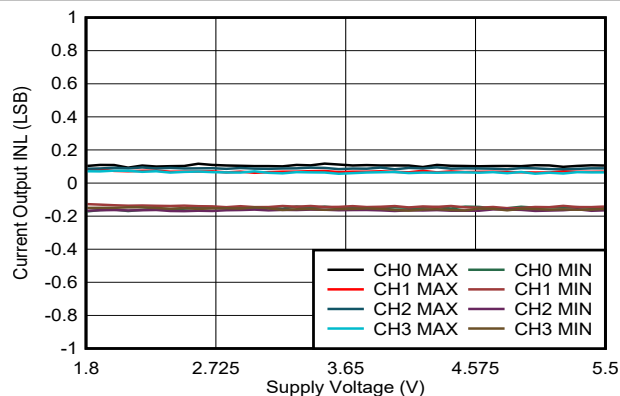
**Figure 6-32. Current Output INL vs Digital Input Code**



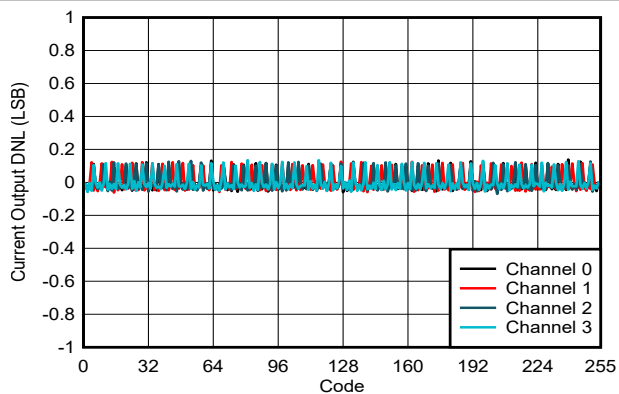
**Figure 6-33. Current Output INL vs Digital Input Code**



**Figure 6-34. Current Output INL vs Temperature**



**Figure 6-35. Current Output INL vs Supply Voltage**



**Figure 6-36. Current Output DNL vs Digital Input Code**

## 6.18 Typical Characteristics: Current Output (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , output range:  $\pm 250\text{ }\mu\text{A}$  (unless otherwise noted)

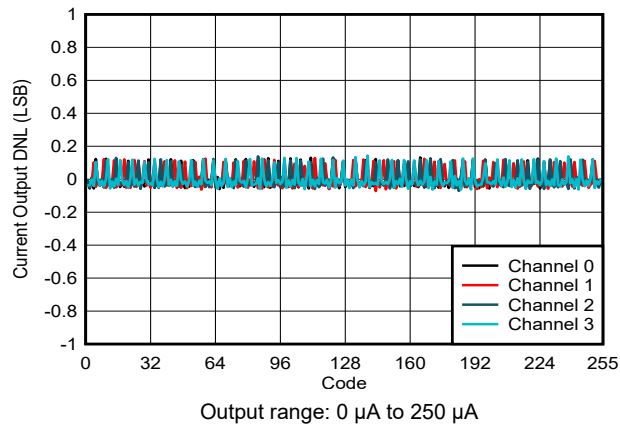


Figure 6-37. Current Output DNL vs Digital Input Code

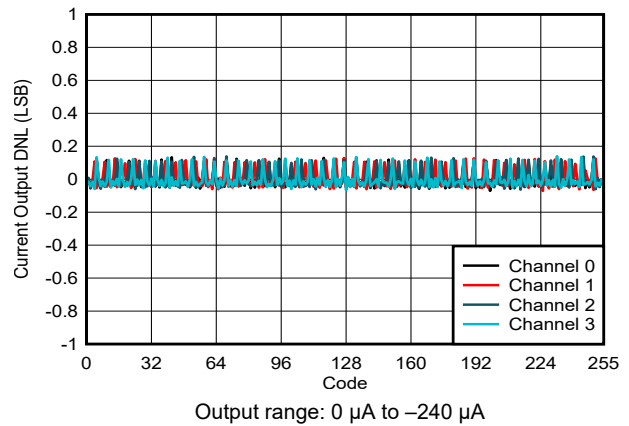


Figure 6-38. Current Output DNL vs Digital Input Code

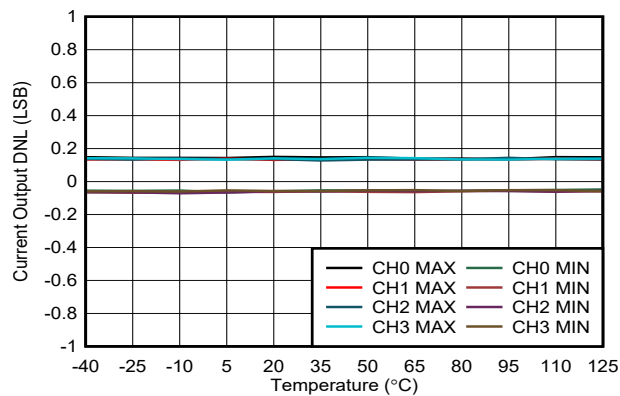


Figure 6-39. Current Output DNL vs Temperature

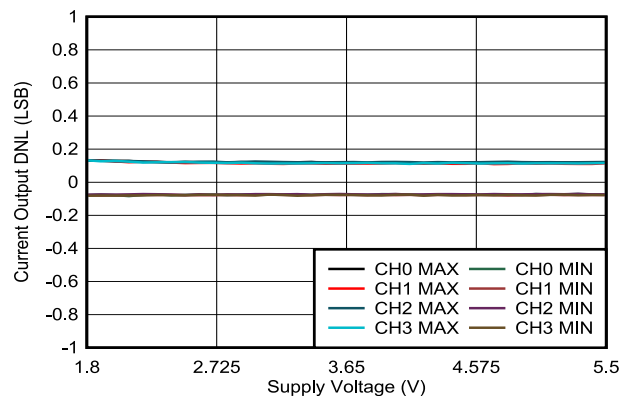


Figure 6-40. Current Output DNL vs Supply Voltage

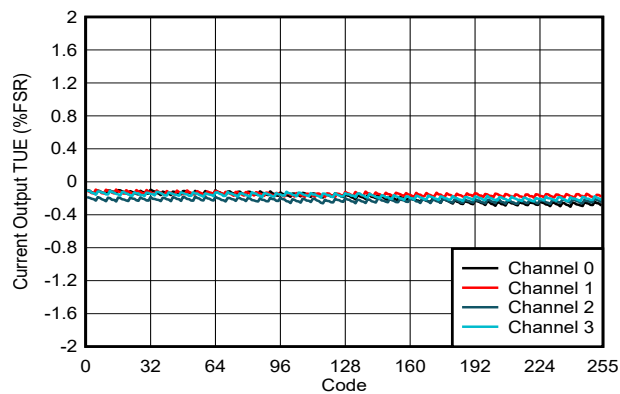


Figure 6-41. Current Output TUE vs Digital Input Code

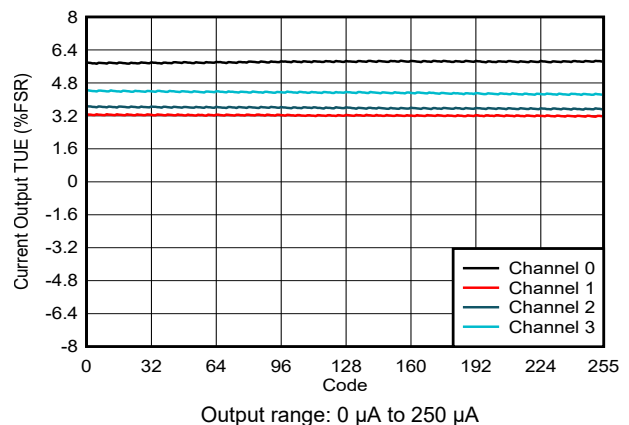
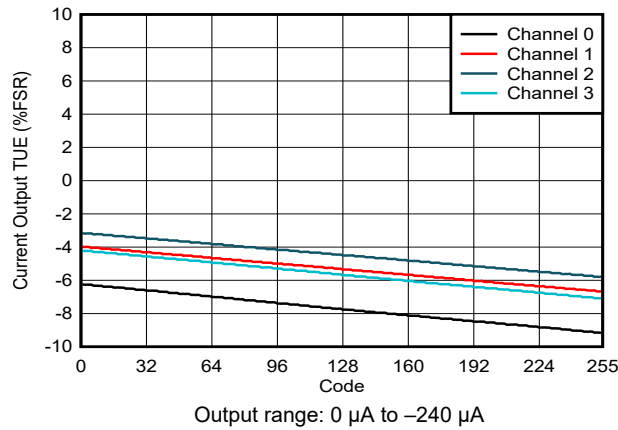


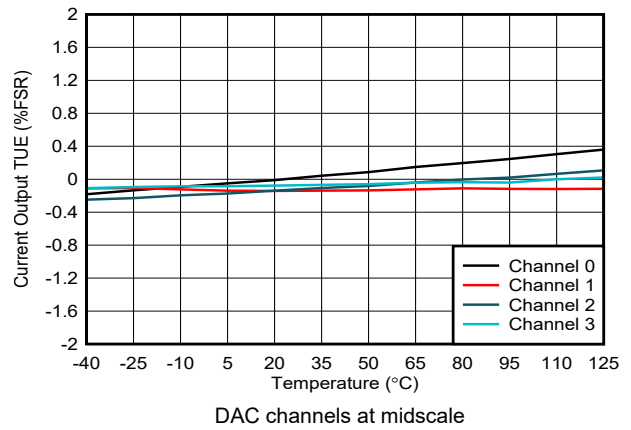
Figure 6-42. Current Output TUE vs Digital Input Code

## 6.18 Typical Characteristics: Current Output (continued)

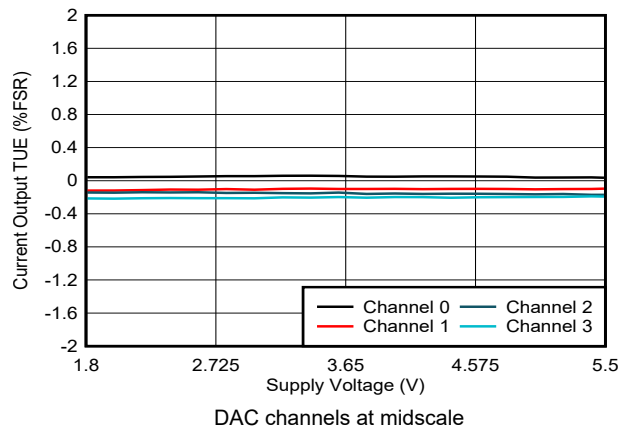
at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , output range:  $\pm 250\text{ }\mu\text{A}$  (unless otherwise noted)



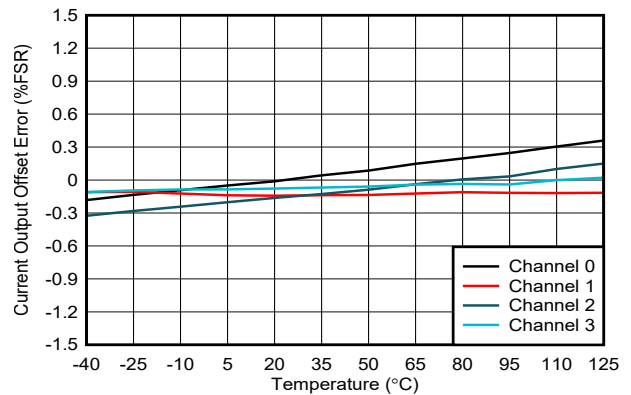
**Figure 6-43. Current Output TUE vs Digital Input Code**



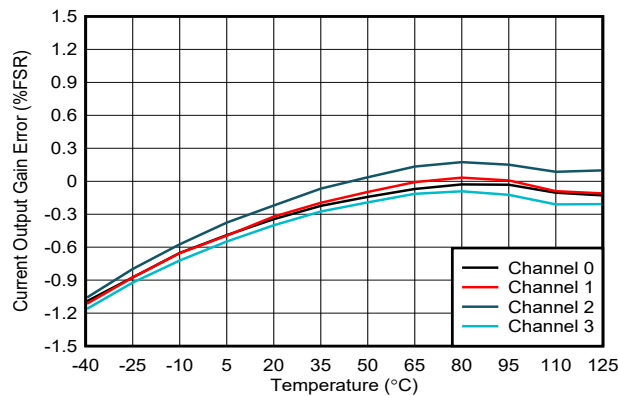
**Figure 6-44. Current Output TUE vs Temperature**



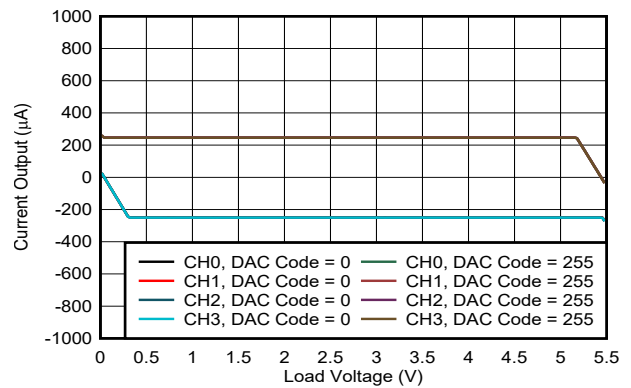
**Figure 6-45. Current Output TUE vs Supply Voltage**



**Figure 6-46. Current Output Offset Error vs Temperature**



**Figure 6-47. Current Output Gain Error vs Temperature**



**Figure 6-48. Current Output vs Load Voltage**

## 6.18 Typical Characteristics: Current Output (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , output range:  $\pm 250\text{ }\mu\text{A}$  (unless otherwise noted)

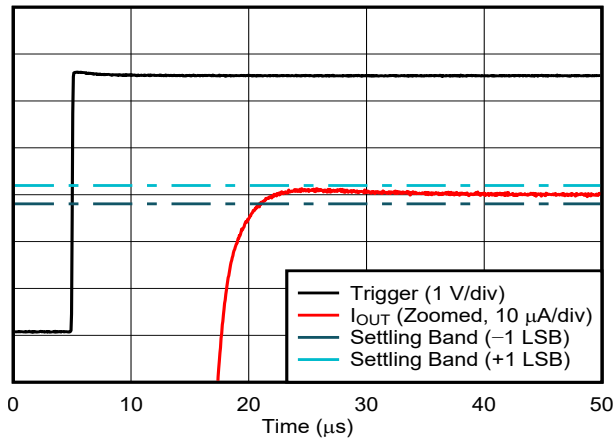


Figure 6-49. Current Output Setting Time, Rising Edge

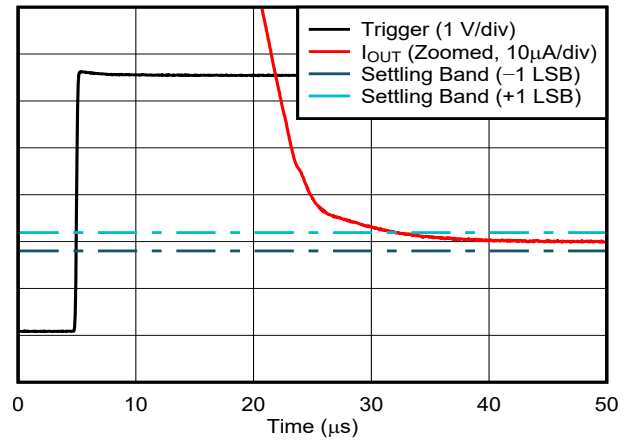
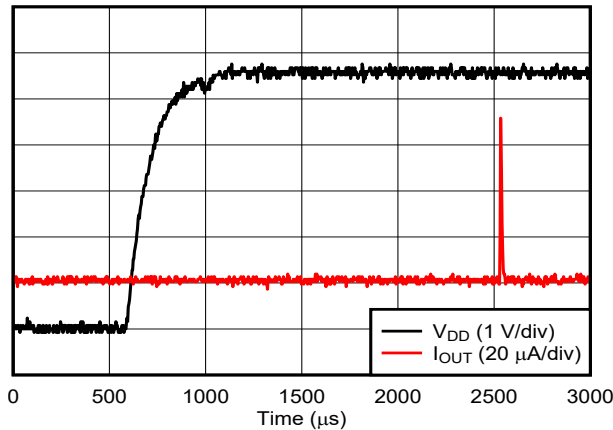
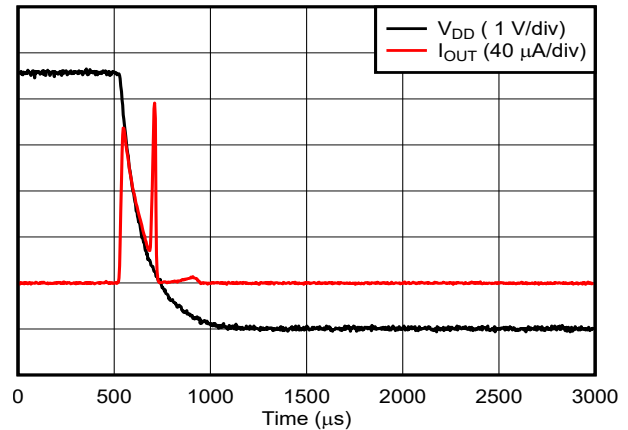


Figure 6-50. Current Output Setting Time, Falling Edge



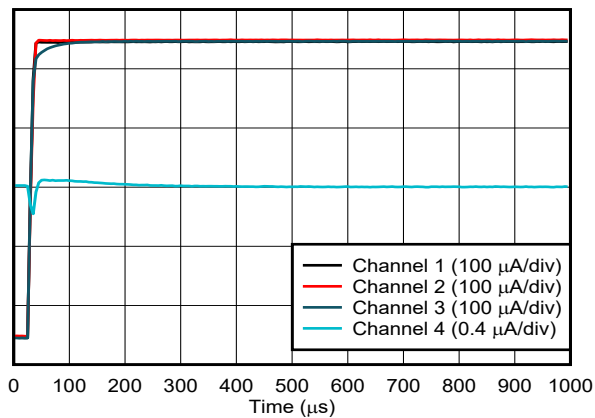
DAC at mid scale (0  $\mu\text{A}$ ) stored in EEPROM

Figure 6-51. Current Output Power-On Glitch



DAC at mid scale (0  $\mu\text{A}$ )

Figure 6-52. Current Output Power-Off Glitch



Channel 4 is victim, all other channels are aggressors

Figure 6-53. Current Output Channel-to-Channel Crosstalk

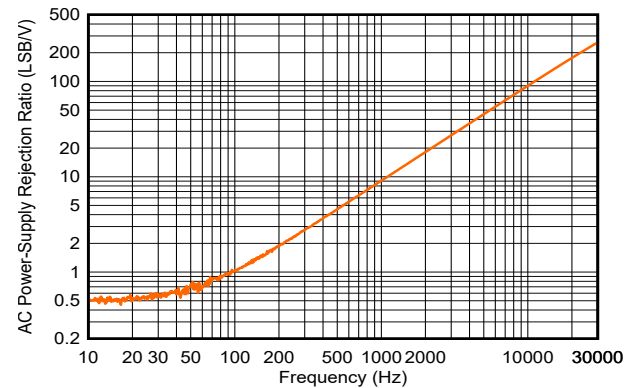
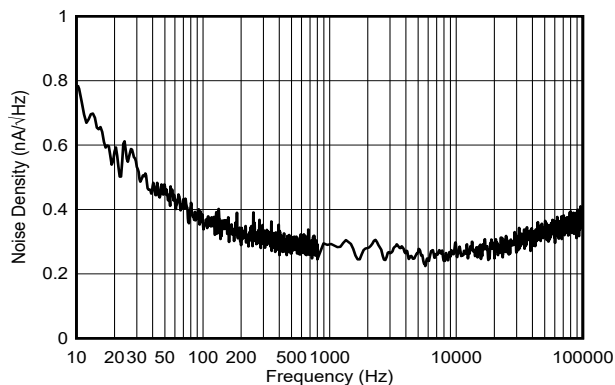


Figure 6-54. Current Output AC PSRR vs Frequency

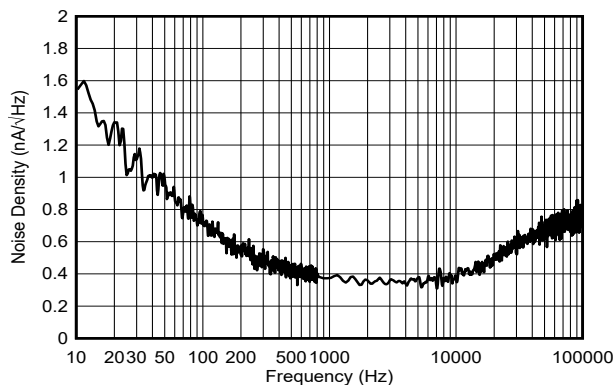
## 6.18 Typical Characteristics: Current Output (continued)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , output range:  $\pm 250\text{ }\mu\text{A}$  (unless otherwise noted)

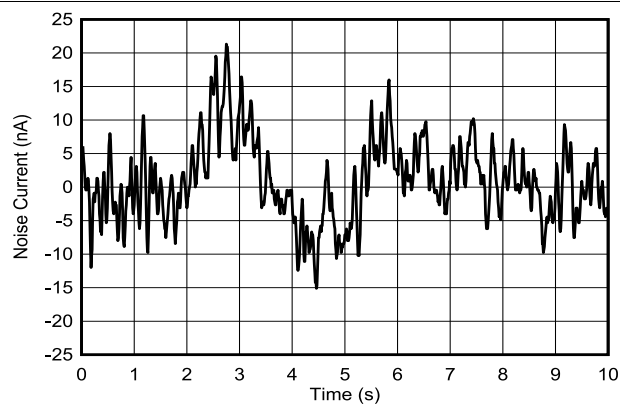


Output range:  $0\text{ }\mu\text{A}$  to  $250\text{ }\mu\text{A}$

**Figure 6-55. Current Output Noise Density**

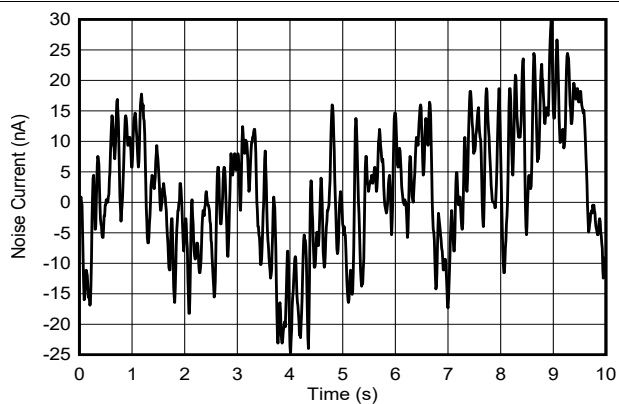


**Figure 6-56. Current Output Noise Density**



Output range:  $0\text{ }\mu\text{A}$  to  $250\text{ }\mu\text{A}$ ,  $f = 0.1\text{ Hz}$  to  $10\text{ Hz}$

**Figure 6-57. Current Output Flicker Noise**



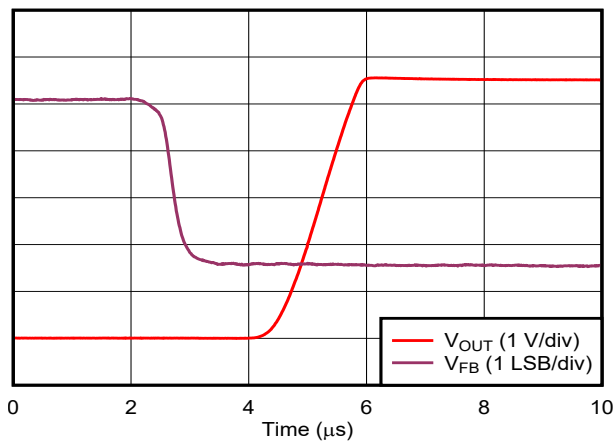
$f = 0.1\text{ Hz}$  to  $10\text{ Hz}$

**Figure 6-58. Current Output Flicker Noise**

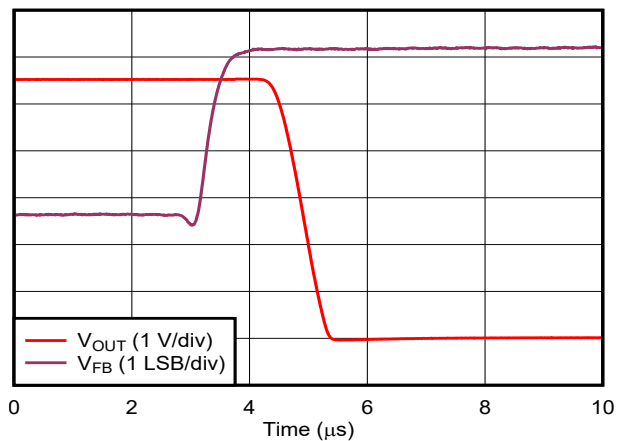


## 6.19 Typical Characteristics: Comparator

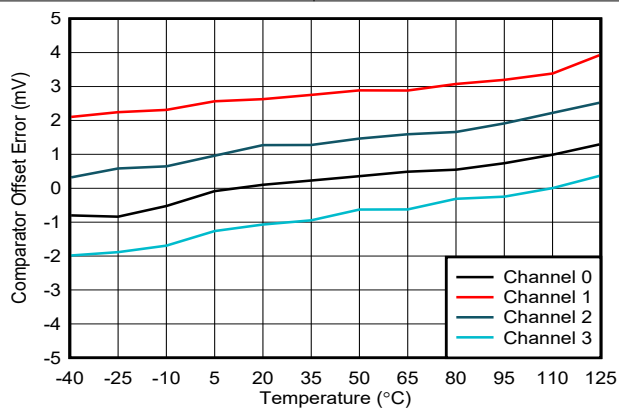
at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , external reference =  $5.5\text{ V}$ , gain = 1x, 12-bit resolution, FBx pin in Hi-Z mode, and DAC outputs unloaded (unless otherwise noted)



Comparator output in push-pull mode  
**Figure 6-59. Comparator Response Time: Low-to-High Transition**



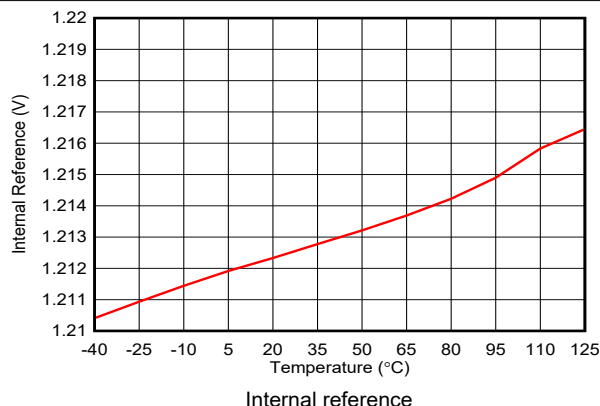
Comparator output in push-pull mode  
**Figure 6-60. Comparator Response Time: High-to-Low Transition**



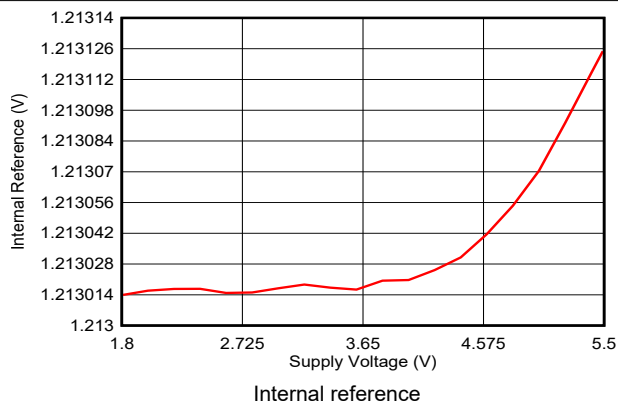
**Figure 6-61. Comparator Offset Error vs Temperature**

## 6.20 Typical Characteristics: General

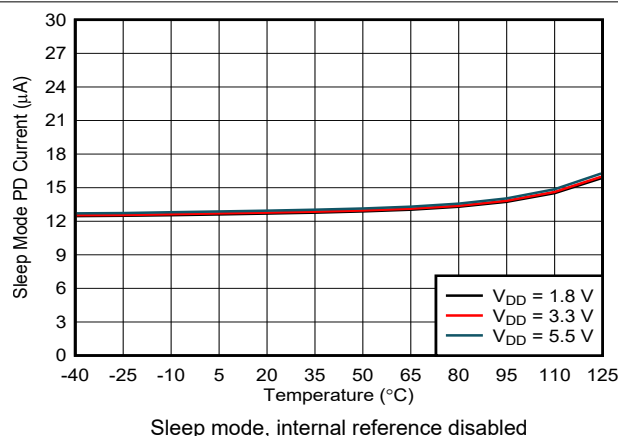
at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5.5\text{ V}$ , and DAC outputs unloaded (unless otherwise noted)



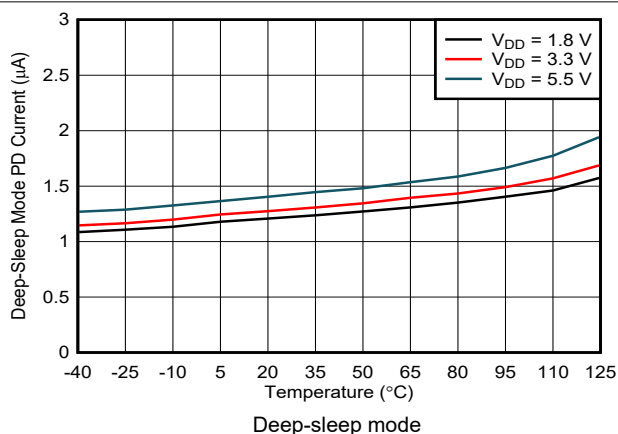
**Figure 6-62. Internal Reference vs Temperature**



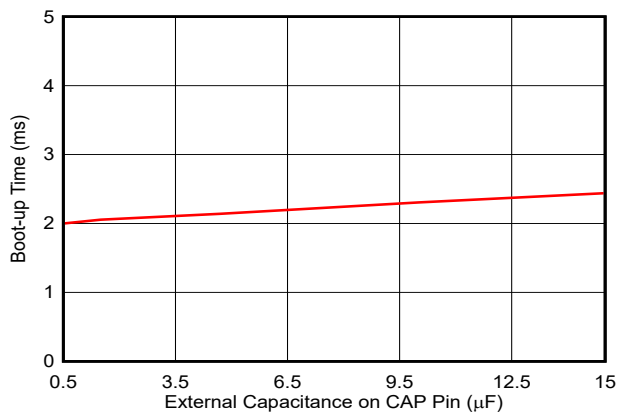
**Figure 6-63. Internal Reference vs Supply Voltage**



**Figure 6-64. Power-Down Current vs Temperature**



**Figure 6-65. Power-Down Current vs Temperature**



**Figure 6-66. Boot-up Time vs Capacitance on CAP pin**

## 7 Detailed Description

### 7.1 Overview

The 12-bit DAC63004 and 10-bit DAC53004 (DACx3004) are a pin-compatible family of ultra-low-power, quad-channel, buffered voltage-output and current-output, smart digital-to-analog converters (DACs). The DAC channels are independently configurable as voltage output or current output. The DAC outputs change to Hi-Z when VDD is off; a feature useful in voltage-margining applications. These smart DACs contain nonvolatile memory (NVM), an internal reference, automatically detectable I<sup>2</sup>C and SPI interface, PMBus-compatibility in I<sup>2</sup>C mode, a force-sense output, and a general-purpose input/output. These devices support Hi-Z power-down modes by default, which can also be configured to 10 k $\Omega$ -GND or 100 k $\Omega$ -GND using the NVM. The DACx3004 have a power-on-reset (POR) circuit that makes sure all the registers start with default or user-programmed settings using NVM. The DACx3004 operate with either an internal reference, external reference, or with a power supply as the reference, and provide a full-scale output between 1.8 V and 5.5 V.

The DACx3004 devices support I<sup>2</sup>C standard mode (100 kbps), fast mode (400 kbps), and fast mode plus (1 Mbps). The I<sup>2</sup>C interface can be configured with four target addresses using the A0 pin. These devices also support specific PMBus commands such as *turn on/off*, *margin high or low*, and more. SPI mode supports a three-wire interface by default, with up to a 50-MHz SCLK input. The GPIO input can be configured as SDO in the NVM for SPI read capability. The GPIO input can also be configured as FAULT-DUMP, LDAC, PD, PROTECT, RESET, and STATUS functions. These devices support deep-sleep mode in addition to sleep (power-down) mode. Deep-sleep mode uses the GPIO pin for power-down and wake up, in which the device draws a very-low power-down current of 3  $\mu$ A. Together with ultra-low-power operation, the DACx3004 are designed for battery-operated applications, such as land mobile radios, medical pulse oximeters, and laptops.

The DACx3004 also include digital slew rate control, and support standard waveform generation such as *sine and cosine*, *triangular*, and *sawtooth*. These devices can generate pulse-width modulation (PWM) output with the combination of the triangular or sawtooth waveform and the FB pin. The force-sense outputs of the DAC channels can be used as programmable comparators. Comparator mode allows programmable hysteresis, latching comparator, and window comparator. These features enable the DACx3004 to go beyond the limitations of a conventional DAC that depends on a processor to function. As a result of processor-less operation and the *smart* feature set, the DACx3004 are called smart DACs.

### 7.2 Functional Block Diagram

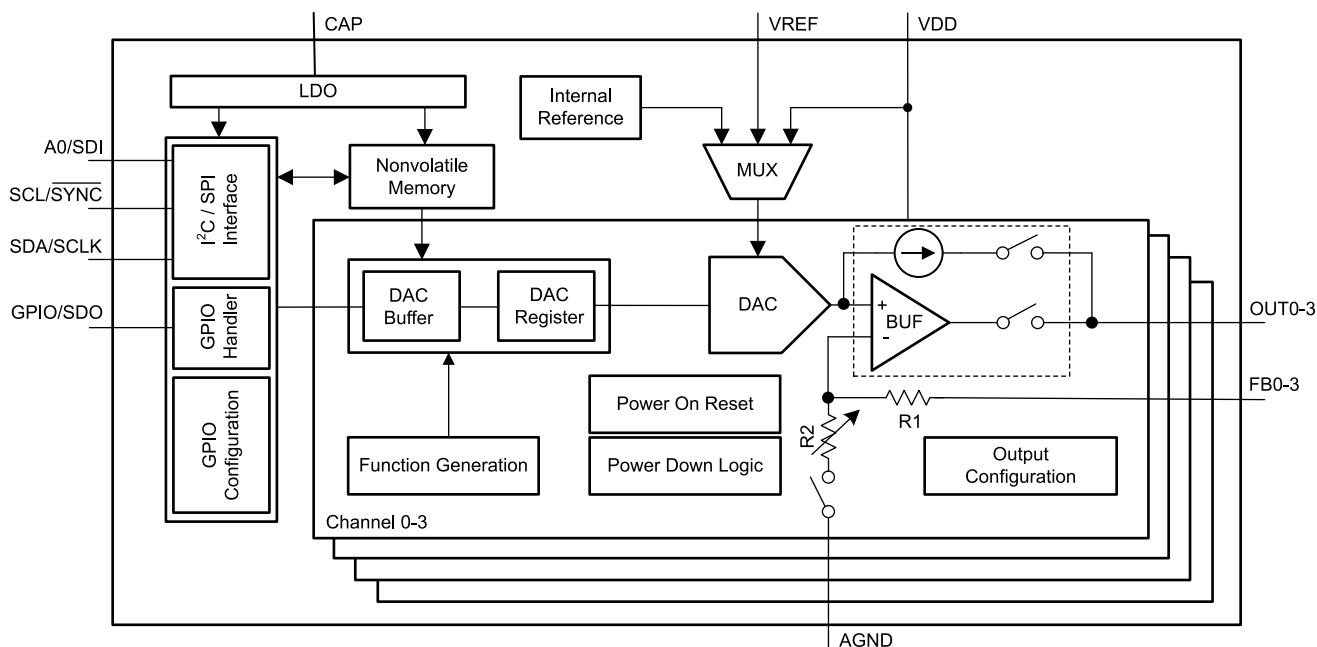


Figure 7-1. Functional Block Diagram

## 7.3 Feature Description

### 7.3.1 Smart Digital-to-Analog Converter (DAC) Architecture

The DACx3004 devices consist of string architecture with a voltage-output amplifier and an external FB pin and voltage-to-current converter for each channel. [Section 7.2](#) shows the DAC architecture within the block diagram, which operates from a 1.8-V to 5.5-V power supply. The DAC has an internal voltage reference of 1.21 V. There is an option to select an external reference on the VREF pin or the power supply as a reference. The voltage output mode uses one of these three reference options. The current output mode uses an internal band gap to generate the current outputs. Both the voltage- and current-output modes support multiple programmable output ranges.

The DACx3004 devices support Hi-Z output when VDD is off, maintaining very low leakage current at the output pins with up to 1.25 V of forced voltage. The DAC output pin also starts up in high-impedance mode by default, making these devices an excellent choice for voltage margining and scaling applications. To change the power-up mode to 10 k $\Omega$ -GND or 100 k $\Omega$ -GND, program the corresponding VOUT-PDN-X field in the COMMON-CONFIG register and load these bits in the device NVM.

The DACx3004 devices support an independent comparator mode for each channel. The respective FBx pins act as the inputs for the comparator. The DAC architecture supports inversion of the comparator output using register settings. The comparator outputs can be push-pull or open-drain. The comparator mode supports programmable hysteresis using *margin-high* and *margin-low* register fields, latching comparator, and window comparator. The comparator outputs are accessible internally by the device.

The DACx3004 devices include a *smart* feature set to enable processor-less operation and high-integration. The NVM enables a predictable start-up. The GPIO triggers the DAC output without the I<sup>2</sup>C interface in the absence of a processor or when the processor or software fails. The integrated functions and the FBx pin enable PWM output for control applications. The FBx pin enables this device to be used as a programmable comparator. The digital slew-rate control and the Hi-Z power-down modes enable a hassle-free voltage margining and scaling function.

### 7.3.2 Digital Input/Output

The DACx3004 have four digital IO pins that include I<sup>2</sup>C, SPI, PMBus, and GPIO interfaces. These devices automatically detect I<sup>2</sup>C and SPI protocols at the first successful communication after power-on, and then connect to the detected interface. After an interface protocol is connected, any change in the protocol is ignored. The I<sup>2</sup>C interface uses the A0 pin to select from among four address options. The SPI interface is a 3-wire interface by default. No readback capability is available in this mode. The GPIO pin can be configured in the register map and then programmed in to the NVM as the SDO pin. The SPI readback mode is slower than the write mode. The programming interface pins are:

- I<sup>2</sup>C: SCL, SDA, A0
- SPI: SCLK, SDI,  $\overline{\text{SYNC}}$ , SDO/GPIO

The GPIO can be configured as multiple functions other than SDO. These are  $\overline{\text{LDAC}}$ ,  $\overline{\text{PD}}$ ,  $\overline{\text{STATUS}}$ ,  $\overline{\text{PROTECT}}$ ,  $\overline{\text{FAULT-DUMP}}$ , and  $\overline{\text{RESET}}$ . All the digital pins are open-drain when used as outputs. Therefore, all the output pins must be pulled up to the desired IO voltage using external resistors.

### 7.3.3 Nonvolatile Memory (NVM)

The DACx3004 contain nonvolatile memory (NVM) bits. These memory bits are user programmable and erasable, and retain the set values in the absence of a power supply. All the register bits, as shown in the highlighted gray cells in [Table 7-20](#), can be stored in the NVM by setting NVM-PROG = 1 in the COMMON-TRIGGER register. The NVM-PROG is an autoresetting bit. The default values for all the registers in the DACx3004 are loaded from NVM as soon as a POR event is issued.

The DACx3004 also implement NVM-RELOAD bit in the COMMON-TRIGGER register. Set this bit to 1 for the device to start an NVM-reload operation. After completion, the device autoresets the NVM-RELOAD bit to 0. During the NVM write or reload operation, all read/write operations to the device are blocked. [Section 6.8](#) provides the timing specification for the NVM write cycle. The processor must wait for the specified duration before resuming any read or write operation on the SPI or I<sup>2</sup>C interface.

### 7.3.4 Power Consumption

The power consumption of the DACx3004 in sleep mode and deep-sleep mode are provided in [Section 6.20](#). In normal operation, the total power consumption of the device depends on the number of channels powered on and the output mode of each channel (voltage or current). In current-output mode, the I<sub>DD</sub> also depends on the output range. The I<sub>DD</sub> calculation excludes the load current. For example, in the ±250 µA output mode with a DAC setting of +125 µA, the total current drawn through the VDD pin is the total I<sub>DD</sub> plus 125 µA. The total I<sub>DD</sub> in normal operation can be calculated using [Equation 1](#).

$$P_{\text{NORMAL\_MODE}} = V_{\text{DD}} \times (I_{\text{DD\_SLEEP}} + I_{\text{DD\_REF}}) + \sum_{X=0}^3 (V_{\text{DD}} \times I_{\text{DD\_X}}) \quad (1)$$

where:

- I<sub>DD\_SLEEP</sub> is the current through V<sub>DD</sub> in sleep mode when all the channels and internal reference are powered down.
- I<sub>DD\_REF</sub> is the reference current, which is:
  - either the current drawn by the reference input impedance when V<sub>DD</sub> is used as reference
  - or the current drawn by the internal reference, if enabled
- I<sub>DD\_X</sub> is the current through V<sub>DD</sub> for every powered-on channel-X.

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#### Note

When an external reference is used, the current is calculated mainly as the current sourced from the external reference, which is equal to the reference voltage divided by the input impedance of the VREF pin.

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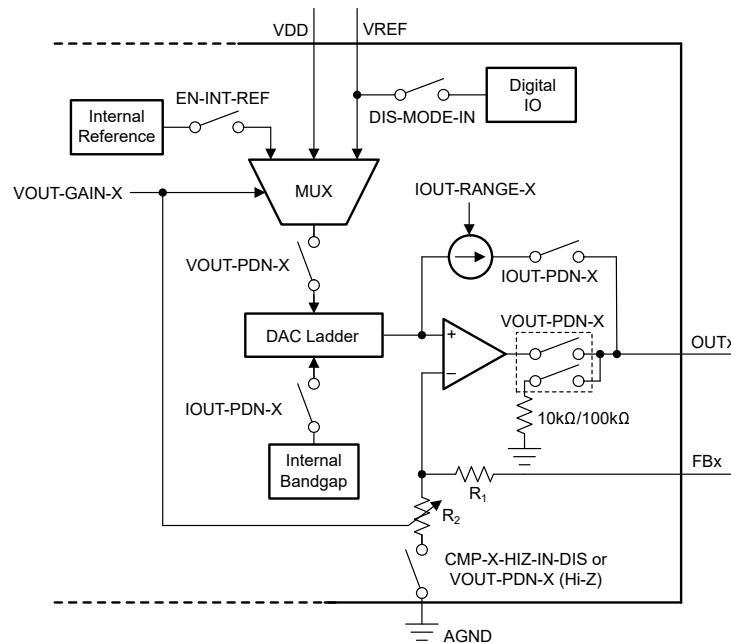
## 7.4 Device Functional Modes

### 7.4.1 Voltage-Output Mode

The voltage-output mode for each DAC channel can be entered by selecting the power-up option in the VOUT-PDN-X fields in the COMMON-CONFIG register and simultaneously powering down the current output option for the respective channels using the IOUT-PDN-X bits in the same register. Short the OUTx and FBx pins of respective channels externally for closed-loop amplifier output. An open FBx pin saturates the amplifier output. To achieve the desired voltage output, select the correct reference option, select the amplifier gain for the required output range, and program the DAC code in the DAC-X-DATA register of the respective channels.

#### 7.4.1.1 Voltage Reference and DAC Transfer Function

There are three voltage reference options possible with the DACx3004: internal reference, external reference, and the power supply as reference, as shown in Figure 7-2. The DAC transfer function in the voltage-output and comparator modes changes based on the voltage reference selection.



**Figure 7-2. Voltage Reference Selection and Power-Down Logic**

##### 7.4.1.1.1 Internal Reference

The DACx3004 contain an internal reference that is disabled by default. To enable the internal reference, write 1 to bit EN-INT-REF in the COMMON-CONFIG register. The internal reference generates a fixed 1.21-V voltage (typical). Use the VOUT-GAIN-X bit in the DAC-X-VOUT-CMP-CONFIG register to achieve gains of 1.5x, 2x, 3x, or 4x for the DAC output voltage ( $V_{OUT}$ ). Equation 2 shows DAC transfer function using the internal reference.

$$V_{OUT} = \frac{DAC\_DATA}{2^N} \times V_{REF} \times GAIN \quad (2)$$

where:

- N is the resolution in bits, 10 (DAC53004), or 12 (DAC63004).
- DAC\_DATA is the decimal equivalent of the binary code that is loaded to the DAC-X-DATA bit in the DAC-X-DATA register. DAC\_DATA ranges from 0 to  $2^N - 1$ .
- $V_{REF}$  is the internal reference voltage = 1.21 V (typical).
- GAIN = 1.5x, 2x, 3x, or 4x, based on VOUT-X-GAIN bits.

#### 7.4.1.1.2 External Reference

By default, the DACx3004 operate from an external reference input. The external reference option can also be selected by configuring the VOUT-GAIN-X field in the DAC-X-VOUT-CMP-CONFIG register appropriately. Write 1 to the DIS-MODE-IN bit in the DEVICE-MODE-CONFIG register to minimize  $I_{DD}$ . The external reference can be between 1.7 V and VDD. Equation 3 shows DAC transfer function when the external reference is used. The gain at the output stage of the DAC is always 1x in the external reference mode.

##### Note

The external reference must be less than VDD in both transient and steady-state conditions. Therefore, the external reference must ramp up after VDD and ramp down before VDD.

$$V_{OUT} = \frac{DAC\_DATA}{2^N} \times V_{REF} \quad (3)$$

where:

- N is the resolution in bits, 10 (DAC53004), or 12 (DAC63004).
- DAC\_DATA is the decimal equivalent of the binary code that is loaded to the DAC-X-DATA field in the DAC-X-DATA register. DAC\_DATA ranges from 0 to  $2^N - 1$ .
- $V_{REF}$  is the external reference voltage.

#### 7.4.1.1.3 Power-Supply as Reference

The DACx3004 can operate with the power-supply pin (VDD) as a reference. Equation 4 shows DAC transfer function when the power-supply pin is used as reference. The gain at the output stage is always 1x.

$$V_{OUT} = \frac{DAC\_DATA}{2^N} \times V_{DD} \quad (4)$$

where:

- N is the resolution in bits, either 10 (DAC53004), or 12 (DAC63004).
- DAC\_DATA is the decimal equivalent of the binary code that is loaded to the DAC-X-DATA bit in the DAC-X-DATA register.
- DAC\_DATA ranges from 0 to  $2^N - 1$ .
- $V_{DD}$  is used as the DAC reference voltage.

#### 7.4.2 Current-Output Mode

To enter current-output mode for each DAC channel, disable the respective IOUT-PDN-X bits in the COMMON-CONFIG register, and set the respective VOUT-PDN-X bits in the same register to Hi-Z power-down mode. Select the desired current-output range by writing to the IOUT-RANGE-X bit in the DAC-X-IOUT-MISC-CONFIG register. To minimize leakage in current-output mode, disconnect the FBx pin. For the best power-on glitch performance, program the NVM with IOUT mode using the smallest output range before powering on the output channel, and then immediately program the DAC code and desired output range. The transfer function of the output current is shown in Equation 5.

$$I_{OUT} = \frac{DAC\_DATA \times (I_{MAX} - I_{MIN})}{2^8} + I_{MIN} \quad (5)$$

where:

- DAC\_DATA is the decimal equivalent of the binary code that is loaded to the DAC-X-DATA bit as specified in Section 7.6.8. DAC\_DATA ranges from 0 to 255.
- $I_{MAX}$  is the signed maximum current in the IOUT-RANGE-X setting as specified in Section 7.6.5.
- $I_{MIN}$  is the signed minimum current in the IOUT-RANGE-X setting as specified in Section 7.6.5.

### 7.4.3 Comparator Mode

All the DAC channels can be configured as programmable comparators in the voltage-output mode. To enter the comparator mode for a channel, write 1 to the CMP-X-EN bit in the respective DAC-X-VOUT-CMP-CONFIG register. The comparator output can be configured as push-pull or open-drain using the CMP-X-OD-EN bit. To enable the comparator output on the output pin, write 1 to the CMP-X-OUT-EN bit. To invert the comparator output, write 1 to the CMP-X-INV-EN bit. The FBx pin has a finite impedance. By default, the FBx pin is in the high-impedance mode. To disable high-impedance on the FBx pin, write 1 to the CMP-X-HIZ-IN-DIS bit. [Table 7-1](#) shows the comparator output at the pin for different bit settings.

#### Note

In the Hi-Z input mode, the comparator input range is limited to:

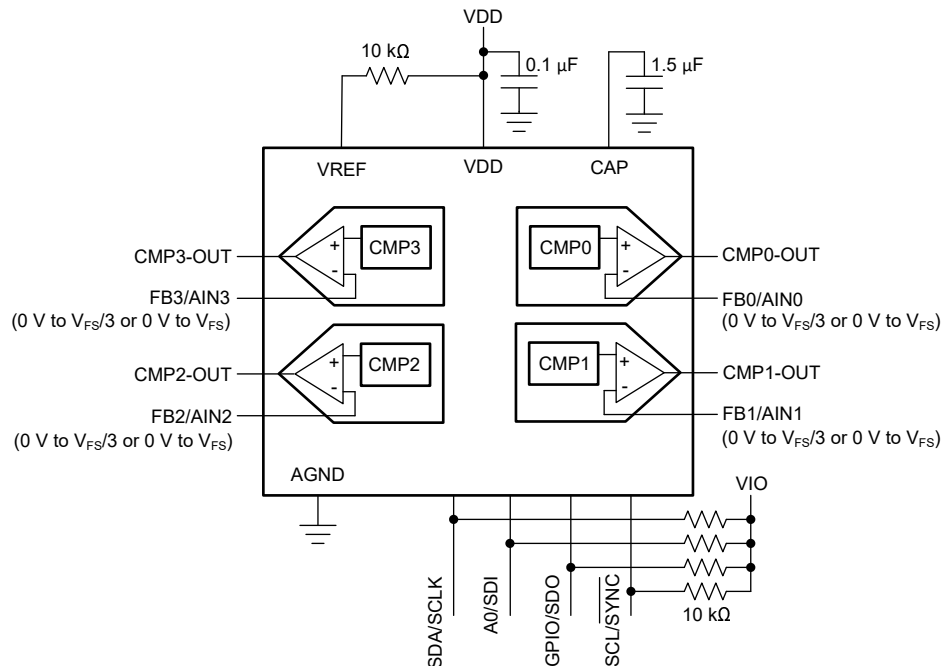
- For GAIN = 1x, 1.5x, or 2x:  $V_{FB} \leq (V_{REF} \times GAIN) / 3$
- For GAIN = 3x, or 4x:  $V_{FB} \leq (V_{REF} \times GAIN) / 6$

Any higher input voltage is clipped.

**Table 7-1. Comparator Output Configuration**

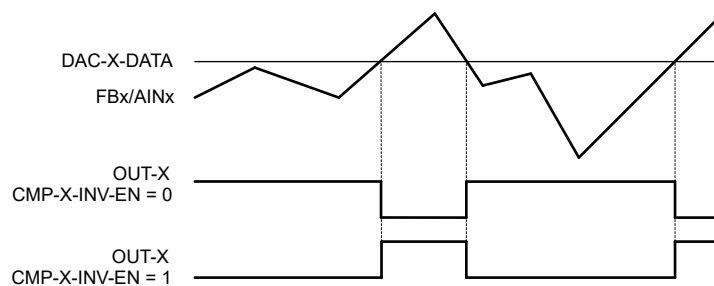
| CMP-X-EN | CMP-X-OUT-EN | CMP-X-OD-EN | CMP-X-INV-EN | CMPX-OUT PIN                   |
|----------|--------------|-------------|--------------|--------------------------------|
| 0        | X            | X           | X            | Comparator not enabled         |
| 1        | 0            | X           | X            | No output                      |
| 1        | 1            | 0           | 0            | Push-pull output               |
| 1        | 1            | 0           | 1            | Push-pull and inverted output  |
| 1        | 1            | 1           | 0            | Open-drain output              |
| 1        | 1            | 1           | 1            | Open-drain and inverted output |

[Figure 7-3](#) shows the interface circuit when all the DAC channels are configured as comparators. The programmable comparator operation is as shown in [Figure 7-4](#). Individual comparator channels can be configured in no-hysteresis, with-hysteresis, and window-comparator modes using the CMP-X-MODE bit in the respective DAC-X-CMP-MODE-CONFIG register, as shown in [Table 7-2](#).



**Figure 7-3. Comparator Interface**



**Figure 7-4. Programmable Comparator Operation****Table 7-2. Comparator Mode Selection**

| CMP-X-MODE BIT FIELD | COMPARATOR CONFIGURATION                                                                         |
|----------------------|--------------------------------------------------------------------------------------------------|
| 00                   | Normal comparator mode. No hysteresis or window operation.                                       |
| 01                   | Hysteresis comparator mode. DAC-X-MARGIN-HIGH and DAC-X-MARGIN-LOW registers set the hysteresis. |
| 10                   | Window comparator mode. DAC-X-MARGIN-HIGH and DAC-X-MARGIN-LOW registers set the window bounds.  |
| 11                   | Invalid setting                                                                                  |

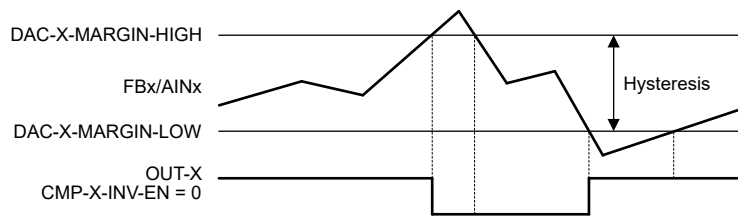
### 7.4.3.1 Programmable Hysteresis Comparator

Comparator mode provides hysteresis when the CMP-X-MODE bit is set to 01b, as shown in [Table 7-2](#). The hysteresis is provided by the DAC-X-MARGIN-HIGH and DAC-X-MARGIN-LOW registers, as shown in [Figure 7-5](#).

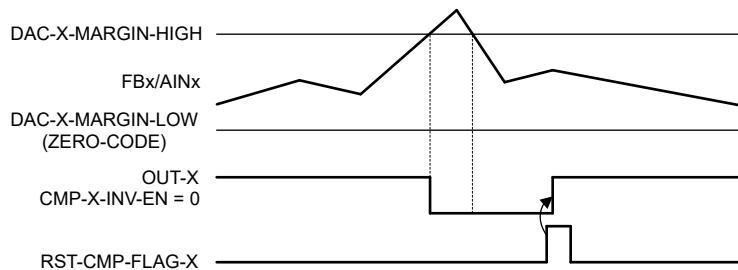
When the DAC-X-MARGIN-HIGH is set to full-code or the DAC-X-MARGIN-LOW is set to zero-code, the comparator works as a latching comparator that is, the output is latched after the threshold is crossed. The latched output can be reset by writing to the corresponding RST-CMP-FLAG-X bit in the COMMON-DAC-TRIG register. [Figure 7-6](#) shows the behavior of a latching comparator with active low output and [Figure 7-7](#) shows the behavior of a latching comparator with active high output.

#### Note

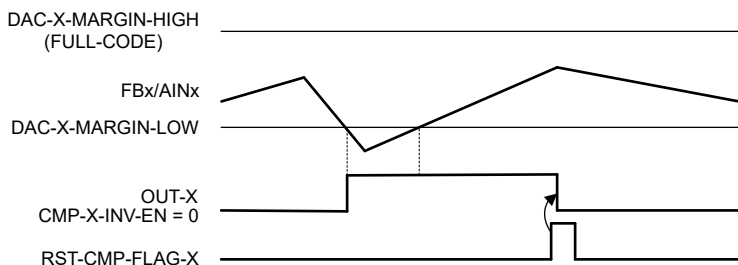
The value of the DAC-X-MARGIN-HIGH register must be greater than the value of the DAC-X-MARGIN-LOW register. The comparator output in the hysteresis mode can only be noninverting that is, the CMP-X-INV-EN bit in the DAC-X-VOULT-CMP-CONFIG register must be set to 0. In latching mode, for the reset to take effect, the input voltage must be within DAC-X-MARGIN-HIGH and DAC-X-MARGIN-LOW.



**Figure 7-5. Programmable Hysteresis Without Latching Output**



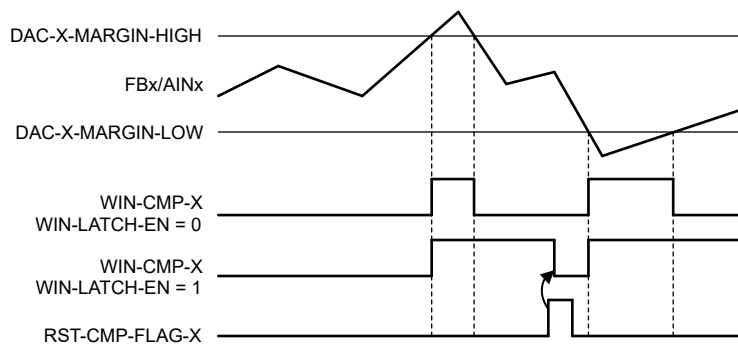
**Figure 7-6. Latching Comparator With Active Low Output**



**Figure 7-7. Latching Comparator With Active High Output**

### 7.4.3.2 Programmable Window Comparator

Window comparator mode is enabled by setting the CMP-X-MODE bit to 10b, as shown in [Table 7-2](#). The window bounds are set by the DAC-X-MARGIN-HIGH and the DAC-X-MARGIN-LOW registers, as shown in [Figure 7-8](#). The output of the window comparator for a given channel is indicated by the respective WIN-CMP-X bit in the CMP-STATUS register. The comparator output (WIN-CMP-X) can be latched by writing 1 to the WIN-LATCH-EN bit in the COMMON-CONFIG register. After being latched, the comparator output can be reset using the corresponding RST-CMP-FLAG-X bit in the COMMON-DAC-TRIG register. For the reset to take effect, the input must be within the window bounds.



**Figure 7-8. Window Comparator Operation**

A single comparator is used per channel to check both the *margin-high* and *margin-low* limits of the window. Therefore, the window comparator function has a finite response time as specified in [Section 6.7](#). Also, the static behavior of the WIN-CMP-X bit is not reflected at the output pins. Set the CMP-X-OUT-EN bit to 0. The WIN-CMP-X bit must be read digitally using the communication interface. This bit can also be mapped to the GPIO pin, as shown in [Table 7-19](#).

#### Note

- The value of the DAC-X-MARGIN-HIGH register must be greater than that of the DAC-X-MARGIN-LOW register.
- Set the SLEW-RATE-X bit to 0000b (no-slew) and LOG-SLEW-EN-X bit to 0b in the DAC-X-FUNC-CONFIG register to get the best response time from the window comparator.
- The CMP-X-OUT-EN bit in the DAC-X-VOOUT-CMP-CONFIG register can be set to 0b to eliminate undesired toggling of the OUT pin.

### 7.4.4 Fault-Dump Mode

The DACx3004 provides a feature to save a few registers into the NVM when the FAULT-DUMP bit is triggered or the GPIO mapped to fault-dump (as shown in [Table 7-18](#)) is triggered. This feature is useful in system-level fault management to capture the state of the device or system just before a fault is triggered, to allow diagnosis after the fault has occurred. The registers saved when fault-dump is triggered, are:

- CMP-STATUS[7:0]
- DAC-0-DATA[15:8]
- DAC-1-DATA[15:8]
- DAC-2-DATA[15:8]
- DAC-3-DATA[15:8]

#### Note

When the fault-dump cycle is in progress, any change in the data can corrupt the final outcome. Make sure the comparator and the DAC codes are stable during the NVM write cycle.

[Table 7-3](#) shows the storage format of the registers in the NVM.

**Table 7-3. Fault-Dump NVM Storage Format**

| NVM ROWS | B31-B24          | B23-B16          | B15-B8           | B7-B0            |
|----------|------------------|------------------|------------------|------------------|
| Row1     | CMP-STATUS[7:0]  | Don't care       |                  |                  |
| Row2     | DAC-0-DATA[15:8] | DAC-1-DATA[15:8] | DAC-2-DATA[15:8] | DAC-3-DATA[15:8] |

The data captured in the NVM after the fault dump can be read in a specific sequence:

1. Set the EE-READ-ADDR bit to 0b in the COMMON-CONFIG register, to select row1 of the NVM.
2. Trigger the read of the selected NVM row by writing 1 to the READ-ONE-TRIG in the COMMON-TRIGGER register; this bit autoresets. This action copies that data from the selected NVM row to SRAM addresses 0x9D (LSB 16 bits from the NVM) and 0x9E (MSB 16 bits from the NVM).
3. To read the SRAM data:
  - a. Write 0x009D to the SRAM-CONFIG register.
  - b. Read the data from the SRAM-DATA register to get the LSB 16 bits.
  - c. Write 0x009E to the SRAM-CONFIG register.
  - d. Read the data from the SRAM-DATA register again to get the MSB bits.
4. Set the EE-READ-ADDR bit to 1b in the COMMON-CONFIG register, to select row2 of the NVM. Repeat steps 2 and 3.

### 7.4.5 Application-Specific Modes

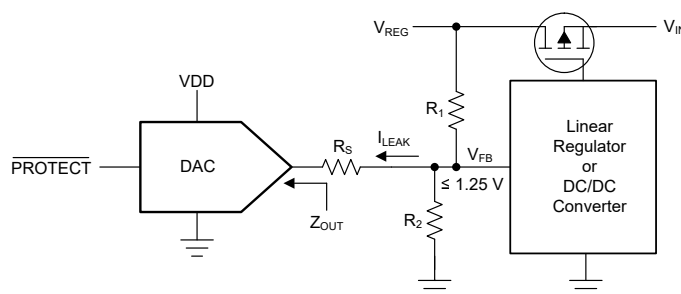
This section provides the details of application-specific functional modes available in DACx3004.

#### 7.4.5.1 Voltage Margining and Scaling

Voltage margining or scaling is a primary application for DACx3004. This section provides specific features available for this application such as Hi-Z output, slew-rate control,  $\overline{\text{PROTECT}}$  input, and PMBus compatibility.

##### 7.4.5.1.1 High-Impedance Output and $\overline{\text{PROTECT}}$ Input

All the DAC output channels remain in high-impedance (Hi-Z) when VDD is off. Figure 7-9 shows a simplified schematic of DACx3004 used in a voltage-margining application. The series resistor  $R_S$  is needed in voltage-output mode, but is optional in current-output mode. Almost all linear regulators and DC/DC converters have a feedback voltage of  $\leq 1.25$  V. The low-leakage currents at the outputs are maintained for  $V_{FB}$  of  $\leq 1.25$  V. Thus, for all practical purposes, the DAC outputs appear as Hi-Z when VDD of the DAC is off in voltage margining and scaling applications. This feature allows for seamless integration of the DACx3004 into a system without any need for additional power-supply sequencing for the DAC.



**Figure 7-9. High-Impedance (Hi-Z) Output and  $\overline{\text{PROTECT}}$  Input**

The DAC channels power down to Hi-Z at boot up. The outputs can power up with a preprogrammed code that corresponds to the nominal output of the DC/DC converter or the linear regulator. This feature allows for smooth power up and power down of the DAC without impacting the feedback loop of the DC/DC converter or the linear regulator.

The GPIO pin of the DACx3004 can be configured as a  $\overline{\text{PROTECT}}$  function, as shown in Table 7-18.  $\overline{\text{PROTECT}}$  takes the DAC outputs to a predictable state with a slewed or direct transition. This function is useful in systems where a fault condition (such as a brownout), a subsystem failure, or a software crash requires that the DAC outputs reach a predefined state without the involvement of a processor. The detected event can be fed to the GPIO pin that is configured as the  $\overline{\text{PROTECT}}$  input. The  $\overline{\text{PROTECT}}$  function can also be triggered using

the PROTECT bit in the COMMON-TRIGGER register. Configure the behavior of the  $\overline{\text{PROTECT}}$  function in the PROTECT-CONFIG field in the DEVICE-MODE-CONFIG register, as shown in [Table 7-4](#).

#### Note

- After the  $\overline{\text{PROTECT}}$  function is triggered, the write functionality is disabled on the communication interface until the function is completed.
- The PROTECT-FLAG bit in the CMP-STATUS register is set to 1 when the  $\overline{\text{PROTECT}}$  function is triggered. This bit can be polled by reading the CMP-STATUS register. After the PROTECT function is complete, a read command on the CMP-STATUS register resets the PROTECT-FLAG bit.

**Table 7-4.  $\overline{\text{PROTECT}}$  Function Configuration**

| PROTECT-CONFIG FIELD | FUNCTION                                                                       |
|----------------------|--------------------------------------------------------------------------------|
| 00                   | Switch to Hi-Z power-down (no slew).                                           |
| 01                   | Switch to DAC code stored in NVM (no slew) and then switch to Hi-Z power-down. |
| 10                   | Slew to margin-low code and then switch to Hi-Z power-down.                    |
| 11                   | Slew to margin-high code and then switch to Hi-Z power-down.                   |

#### 7.4.5.1.2 Programmable Slew-Rate Control

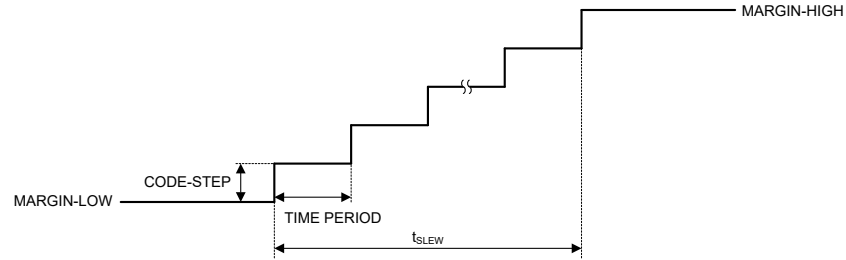
When the DAC data registers are written, the voltage on DAC output ( $V_{\text{OUT}}$ ) immediately transitions to the new code following the slew rate and settling time specified in the *Electrical Characteristics*.

The slew rate control feature allows the user to control the rate at which the output voltage ( $V_{\text{OUT}}$ ) changes. When this feature is enabled (using the SLEW-RATE-X[3:0] bits), the DAC output changes from the current code to the code in the DAC-X-MARGIN-HIGH or DAC-X-MARGIN-LOW registers (when margin high or low commands are issued to the DAC) using the step size and time-period per step set in CODE-STEP-X and SLEW-RATE-X bits in the DAC-X-FUNC-CONFIG register:

- SLEW-RATE-X defines the time-period per step at which the digital slew updates.
- CODE-STEP-X defines the number of LSBs by which the output value changes at each update, for the corresponding channels.

[Table 7-5](#) and [Table 7-6](#) show different settings available for CODE-STEP-X and SLEW-RATE-X. With the default slew rate control setting of no-slew, the output changes immediately at a rate limited by the output drive circuitry and the attached load.

When the slew rate control feature is used, the output changes happen at the programmed slew rate. This configuration results in a staircase formation at the output as shown in [Figure 7-10](#). Do not write to CODE-STEP-X, SLEW-RATE-X, or DAC-X-DATA during the output slew operation. [Equation 6](#) provides the equation for the calculating the slew time ( $t_{\text{SLEW}}$ ).



**Figure 7-10. Programmable Slew-Rate Control**

$$t_{\text{SLEW}} = \frac{\text{SLEW\_RATE} \times (\text{MARGIN\_HIGH} - \text{MARGIN\_LOW} + 1)}{\text{CODE\_STEP}} \quad (6)$$

where:

- SLEW\_RATE is the SLEW-RATE-X setting as specified in [Table 7-6](#).
- CODE\_STEP is the CODE-STEP-X setting as specified in [Table 7-5](#).
- MARGIN\_HIGH is the DAC-X-MAGIN-HIGH as specified in [Section 7.6.2](#).
- MARGIN\_LOW is the DAC-X-MAGIN-LOW as specified in [Section 7.6.3](#).

**Table 7-5. Code Step**

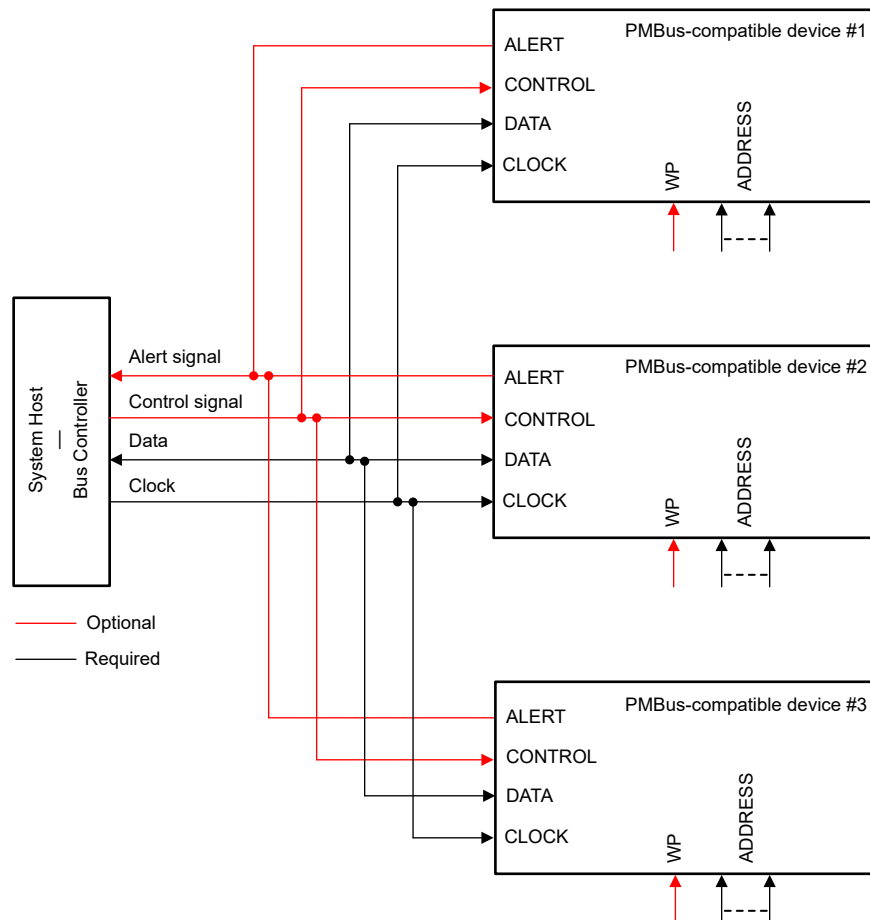
| REGISTER          | CODE-STEP-X[2] | CODE-STEP-X[1] | CODE-STEP-X[0] | CODE STEP SIZE  |
|-------------------|----------------|----------------|----------------|-----------------|
| DAC-X-FUNC-CONFIG | 0              | 0              | 0              | 1 LSB (default) |
|                   | 0              | 0              | 1              | 2 LSB           |
|                   | 0              | 1              | 0              | 3 LSB           |
|                   | 0              | 1              | 1              | 4 LSB           |
|                   | 1              | 0              | 0              | 6 LSB           |
|                   | 1              | 0              | 1              | 8 LSB           |
|                   | 1              | 1              | 0              | 16 LSB          |
|                   | 1              | 1              | 1              | 32 LSB          |

**Table 7-6. Slew Rate**

| REGISTER          | SLEW-RATE-X[3] | SLEW-RATE-X[2] | SLEW-RATE-X[1] | SLEW-RATE-X[0] | TIME PERIOD (PER STEP) |
|-------------------|----------------|----------------|----------------|----------------|------------------------|
| DAC-X-FUNC-CONFIG | 0              | 0              | 0              | 0              | No slew (default)      |
|                   | 0              | 0              | 0              | 1              | 4 μs                   |
|                   | 0              | 0              | 1              | 0              | 8 μs                   |
|                   | 0              | 0              | 1              | 1              | 12 μs                  |
|                   | 0              | 1              | 0              | 0              | 18 μs                  |
|                   | 0              | 1              | 0              | 1              | 27 μs                  |
|                   | 0              | 1              | 1              | 0              | 40.5 μs                |
|                   | 0              | 1              | 1              | 1              | 60.75 μs               |
|                   | 1              | 0              | 0              | 0              | 91.13 μs               |
|                   | 1              | 0              | 0              | 1              | 136.69 μs              |
|                   | 1              | 0              | 1              | 0              | 239.2 μs               |
|                   | 1              | 0              | 1              | 1              | 418.61 μs              |
|                   | 1              | 1              | 0              | 0              | 732.56 μs              |
|                   | 1              | 1              | 0              | 1              | 1281.98 μs             |
|                   | 1              | 1              | 1              | 0              | 2563.96 μs             |
|                   | 1              | 1              | 1              | 1              | 5127.92 μs             |

#### 7.4.5.1.3 PMBus Compatibility Mode

The PMBus protocol is an I<sup>2</sup>C-based communication standard for power-supply management. PMBus contains standard command codes tailored to power supply applications. The DACx3004 implement some PMBus commands such as *Turn Off*, *Turn On*, *Margin Low*, *Margin High*, *Communication Failure Alert Bit (CML)*, as well as *PMBUS revision*. Figure 7-11 shows typical PMBus connections. The EN-PMBUS bit in the INTERFACE-CONFIG register must be set to 1 to enable the PMBus protocol.



**Figure 7-11. PMBus Connections**

Similar to I<sup>2</sup>C, PMBus is a variable length packet of 8-bit data bytes, each with a receiver acknowledge, wrapped between a start and stop bit. The first byte is always a 7-bit *target address* followed by a *write* bit, sometimes called the *even address* that identifies the intended receiver of the packet. The second byte is an 8-bit *command* byte, identifying the PMBus command being transmitted using the respective command code. After the command byte, the transmitter either sends data associated with the command to write to the receiver command register (from least significant byte to most significant byte, as shown in [Table 7-7](#)), or sends a new start bit indicating the desire to read the data associated with the command register from the receiver. Then the receiver transmits the data following the same least significant byte first format (see [Table 7-8](#)).

**Table 7-7. PMBus Update Sequence**

| MSB                                                   | ... | LSB | ACK | MSB                                               | ... | LSB | ACK | MSB              | ... | LSB | ACK | MSB                            | ... | LSB | ACK |
|-------------------------------------------------------|-----|-----|-----|---------------------------------------------------|-----|-----|-----|------------------|-----|-----|-----|--------------------------------|-----|-----|-----|
| Address (A) byte<br><a href="#">Section 7.5.2.2.1</a> |     |     |     | Command byte<br><a href="#">Section 7.5.2.2.2</a> |     |     |     | Data byte - LSDB |     |     |     | Data byte - MSDB<br>(Optional) |     |     |     |
| DB [31:24]                                            |     |     |     | DB [23:16]                                        |     |     |     | DB [15:8]        |     |     |     | DB [7:0]                       |     |     |     |

**Table 7-8. PMBus Read Sequence**

| S               | MSB                               | ... | R/W<br>(0) | ACK    | MSB                               | ... | LSB | ACK | Sr     | MSB                               | ... | R/W<br>(1) | ACK | MSB    | ...         | LSB | ACK | MSB             | ...        | LSB         | ACK |  |  |            |
|-----------------|-----------------------------------|-----|------------|--------|-----------------------------------|-----|-----|-----|--------|-----------------------------------|-----|------------|-----|--------|-------------|-----|-----|-----------------|------------|-------------|-----|--|--|------------|
|                 | ADDRESS BYTE<br>Section 7.5.2.2.1 |     |            |        | COMMAND BYTE<br>Section 7.5.2.2.2 |     |     |     | Sr     | ADDRESS BYTE<br>Section 7.5.2.2.1 |     |            |     | LSDB   |             |     |     | MSDB (Optional) |            |             |     |  |  |            |
| From Controller |                                   |     |            | Target | From Controller                   |     |     |     | Target | From Controller                   |     |            |     | Target | From Target |     |     |                 | Controller | From Target |     |  |  | Controller |

The DACx3004 I<sup>2</sup>C interface implements some of the PMBus commands. [Table 7-9](#) shows the supported PMBus commands that are implemented in DACx3004. The DAC uses DAC-X-MARGIN-LOW, DAC-X-MARGIN-HIGH bits, SLEW-RATE-X, and CODE-STEP-X bits for PMBUS-OPERATION-CMD-X. To access multiple channels, write the PMBus page address as specified in [Table 7-21](#) to the PMBUS-PAGE register first, followed by a write to the channel-specific register.

**Table 7-9. PMBus Operation Commands**

| REGISTER       | PMBUS-OPERATION-CMD-X[15:8] | DESCRIPTION |
|----------------|-----------------------------|-------------|
| PMBUS-OP-CMD-X | 00h                         | Turn off    |
|                | 80h                         | Turn on     |
|                | 94h                         | Margin low  |
|                | A4h                         | Margin high |

The DACx3004 also implement PMBus features such as group command protocol and communication time-out failure. The CML bit in the PMBUS-CML register indicates a communication fault in the PMBus. This bit is reset by writing 1.

To get the PMBus version, read the PMBUS-VERSION register.



### 7.4.5.2 Function Generation

The DACx3004 implement a continuous function or waveform generation feature. These devices can generate a triangular wave, sawtooth wave, and sine wave independently for every channel.

#### 7.4.5.2.1 Triangular Waveform Generation

The triangular waveform uses the DAC-X-MARGIN-LOW and DAC-X-MARGIN-HIGH registers for minimum and maximum levels, respectively. The frequency of the waveform depends on the min and max levels, CODE-STEP and SLEW-RATE settings as shown in Equation 7. An external RC load with a time-constant larger than the slew-rate settings can be dominant over the internal frequency calculation. The CODE-STEP-X and SLEW-RATE-X settings are available in the DAC-X-FUNC-CONFIG register. Writing 0b000 to the FUNC-CONFIG-X bit field in the DAC-X-FUNC-CONFIG register selects triangular waveform.

$$f_{\text{TRIANGLE\_WAVE}} = \frac{1}{2 \times \text{SLEW\_RATE} \times \left( \frac{\text{MARGIN\_HIGH} - \text{MARGIN\_LOW} + 1}{\text{CODE\_STEP}} \right)} \quad (7)$$

where:

- SLEW\_RATE is the SLEW-RATE-X setting as specified in Table 7-6.
- CODE\_STEP is the CODE-STEP-X setting as specified in Table 7-5.
- MARGIN\_HIGH is the DAC-X-MARGIN-HIGH as specified in Section 7.6.2.
- MARGIN\_LOW is the DAC-X-MARGIN-LOW as specified in Section 7.6.3.

#### 7.4.5.2.2 Sawtooth Waveform Generation

The sawtooth and the inverse sawtooth waveforms use the DAC-X-MARGIN-LOW and DAC-X-MARGIN-HIGH registers for minimum and maximum levels, respectively. The frequency of the waveform depends on the min and max levels, CODE-STEP and SLEW-RATE settings as shown in Equation 8. An external RC load with a time constant larger than the slew-rate settings can be dominant over the internal frequency calculation. The CODE-STEP-X and SLEW-RATE-X settings are available in the DAC-X-FUNC-CONFIG register. Write 0b001 to the FUNC-CONFIG-X bit field in the DAC-X-FUNC-CONFIG register to select sawtooth waveform, and write 0b010 to select inverse sawtooth waveform.

$$f_{\text{SAWTOOTH\_WAVE}} = \frac{1}{\text{SLEW\_RATE} \times \left( \frac{\text{MARGIN\_HIGH} - \text{MARGIN\_LOW} + 1}{\text{CODE\_STEP}} \right)} \quad (8)$$

where:

- SLEW\_RATE is the SLEW-RATE-X setting as specified in Table 7-6.
- CODE\_STEP is the CODE-STEP-X setting as specified in Table 7-5.
- MARGIN\_HIGH is the DAC-X-MARGIN-HIGH as specified in Section 7.6.2.
- MARGIN\_LOW is the DAC-X-MARGIN-LOW as specified in Section 7.6.3.

#### 7.4.5.2.3 Sine Waveform Generation

The sine wave function uses 24 preprogrammed points per cycle. The frequency of the sine wave depends on the SLEW-RATE settings as shown in [Equation 9](#):

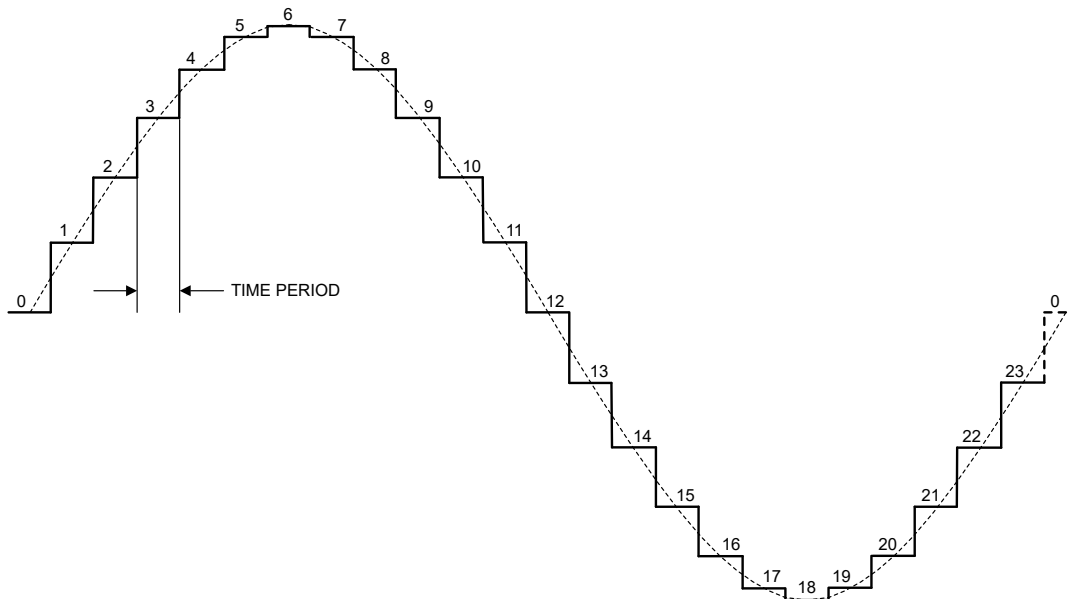
$$f_{\text{SINE\_WAVE}} = \frac{1}{24 \times \text{SLEW\_RATE}} \quad (9)$$

where SLEW\_RATE is the SLEW-RATE-X setting as specified in [Table 7-6](#).

An external RC load with a time constant larger than the slew-rate settings can be dominant over the internal frequency calculation. The SLEW-RATE-X setting is available in the DAC-X-FUNC-CONFIG register. Writing 0b100 to the FUNC-CONFIG-X bit field in the DAC-X-FUNC-CONFIG register selects sine wave. The codes for the sine wave are fixed. Use the gain settings at the output amplifier for changing the full-scale output using the internal reference option. The gain settings are accessible through the VOUT-GAIN-X bits in the DAC-X-VOUT-CMP-CONFIG register. [Table 7-10](#) shows the list of hard-coded discrete points for the sine wave with 12-bit resolution and [Figure 7-12](#) shows the pictorial representation of the sine wave. There are four phase settings available for the sine wave that are selected using the PHASE-SEL-X bit in the DAC-X-FUNC-CONFIG register.

**Table 7-10. Sine Wave Data Points**

| SEQUENCE | 12-BIT VALUE | SEQUENCE | 12-BIT VALUE |
|----------|--------------|----------|--------------|
| 0        | 0x800        | 12       | 0x800        |
| 1        | 0x9A8        | 13       | 0x658        |
| 2        | 0xB33        | 14       | 0x4CD        |
| 3        | 0xC87        | 15       | 0x379        |
| 4        | 0xD8B        | 16       | 0x275        |
| 5        | 0xE2F        | 17       | 0x1D1        |
| 6        | 0xE66        | 18       | 0x19A        |
| 7        | 0xE2F        | 19       | 0x1D1        |
| 8        | 0xD8B        | 20       | 0x275        |
| 9        | 0xC87        | 21       | 0x379        |
| 10       | 0xB33        | 22       | 0x4CD        |
| 11       | 0x9A8        | 23       | 0x658        |



**Figure 7-12. Sine Wave Generation**

## 7.4.6 Device Reset and Fault Management

This section provides the details of power-on-reset (POR), software reset, and other diagnostics and fault-management features of DACx3004.

### 7.4.6.1 Power-On Reset (POR)

The DACx3004 family of devices includes a power-on reset (POR) function that controls the output voltage at power up. After the  $V_{DD}$  supply has been established, a POR event is issued. The POR causes all registers to initialize to default values, and communication with the device is valid only after a POR (boot-up) delay. The default value for all the registers in the DACx3004 is loaded from NVM as soon as the POR event is issued.

When the device powers up, a POR circuit sets the device to the default mode. The POR circuit requires specific  $V_{DD}$  levels, as indicated in Figure 7-13, to make sure that the internal capacitors discharge and reset the device at power up. To make sure that a POR occurs,  $V_{DD}$  must be less than 0.7 V for at least 1 ms. When  $V_{DD}$  drops to less than 1.65 V, but remains greater than 0.7 V (shown as the undefined region), the device may or may not reset under all specified temperature and power-supply conditions. In this case, initiate a POR. When  $V_{DD}$  remains greater than 1.65 V, a POR does not occur.

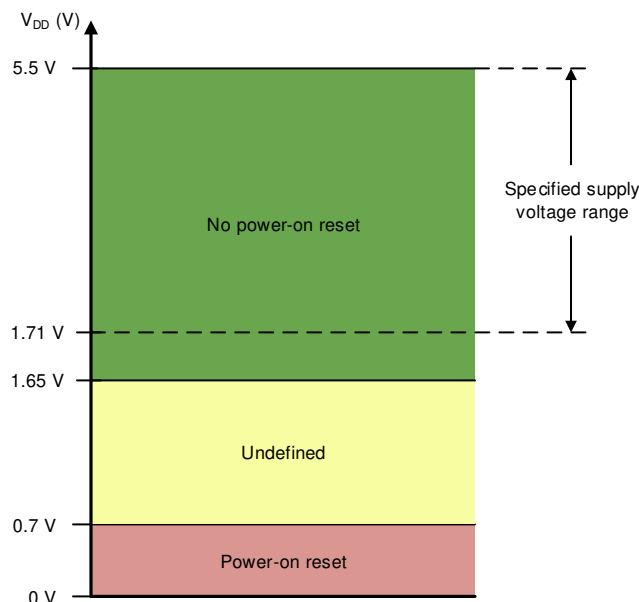


Figure 7-13. Threshold Levels for  $V_{DD}$  POR Circuit

### 7.4.6.2 External Reset

An external reset to the device can be triggered through the GPIO pin or through the register map. To initiate a device software reset event, write the reserved code 1010 to the RESET field in the COMMON-TRIGGER register. A software reset initiates a POR event. The GPIO pin can be configured as a  $\overline{\text{RESET}}$  pin as shown in Table 7-18. This configuration must be programmed into the NVM so that the setting is not cleared after the device reset. The  $\overline{\text{RESET}}$  input must be a low pulse. The device starts the boot-up sequence after the falling edge of the  $\overline{\text{RESET}}$  input. The rising edge of the  $\overline{\text{RESET}}$  input does not have any effect.

### 7.4.6.3 Register-Map Lock

The DACx3004 implement a register-map lock feature that prevents an accidental or unintended write to the DAC registers. The device locks all the registers when the DEV-LOCK bit in the COMMON-CONFIG register is set to 1. However, the software reset function through the COMMON-TRIGGER register is not blocked when using I<sup>2</sup>C interface. To bypass the DEV-LOCK setting, write 0101 to the DEV-UNLOCK bits in the COMMON-TRIGGER register.

#### **7.4.6.4 NVM Cyclic Redundancy Check (CRC)**

The DACx3004 implement a cyclic redundancy check (CRC) feature for the NVM to make sure that the data stored in the NVM is uncorrupted. There are two types of CRC alarm bits implemented in DACx3004:

- NVM-CRC-FAIL-USER
- NVM-CRC-FAIL-INT

The NVM-CRC-FAIL-USER bit indicates the status of user-programmable NVM bits, and the NVM-CRC-FAIL-INT bit indicates the status of internal NVM bits. The CRC feature is implemented by storing a 16-Bit CRC (CRC-16-CCITT) along with the NVM data each time NVM program operation (write or reload) is performed and during the device start up. The device reads the NVM data and validates the data with the stored CRC. The CRC alarm bits (NVM-CRC-FAIL-USER and NVM-CRC-FAIL-INT in the GENERAL-STATUS register) report any errors after the data are read from the device NVM. The alarm bits are set only at boot-up.

##### **7.4.6.4.1 NVM-CRC-FAIL-USER Bit**

A logic 1 on NVM-CRC-FAIL-USER bit indicates that the user-programmable NVM data are corrupt. During this condition, all registers in the DAC are initialized with factory reset values, and any DAC registers can be written to or read from. To reset the alarm bits to 0, issue a software reset (see [Section 7.4.6.2](#)) command, or cycle power to the DAC. A software reset or power-cycle also reloads the user-programmable NVM bits. In case the failure persists, reprogram the NVM.

##### **7.4.6.4.2 NVM-CRC-FAIL-INT Bit**

A logic 1 on NVM-CRC-FAIL-INT bit indicates that the internal NVM data are corrupt. During this condition, all registers in the DAC are initialized with factory reset values, and any DAC registers can be written to or read from. In case of a temporary failure, to reset the alarm bits to 0, issue a software reset (see [Section 7.4.6.2](#)) command or cycle power to the DAC. A permanent failure in the NVM makes the device unusable.

### 7.4.7 Power-Down Mode

The DACx3004 output amplifier and internal reference can be independently powered down through the EN-INT-REF, VOUT-PDN-X, and IOUT-PDN-X bits in the COMMON-CONFIG register, as shown in [Figure 7-2](#). At power up, the DAC output and the internal reference are disabled by default. In power-down mode, the DAC outputs (OUTx pins) are in a high-impedance state. To change this state to 10 kΩ-A<sub>GND</sub> or 100 kΩ-A<sub>GND</sub> in voltage-output mode (at power up), use the VOUT-PDN-X bits. The power-down state for current-output mode is always high-impedance.

The DAC power-up state can be programmed to any state (power-down or normal mode) using the NVM. [Table 7-11](#) shows the DAC power-down bits. The individual channel power-down bits can be mapped to the GPIO pin using the GPIO-CONFIG register. This function is called sleep mode. In this mode, the internal low-dropout regulator (LDO) and the common functional blocks are still powered-on, and the device draws a maximum of 28 µA of current through the power supply.

**Table 7-11. DAC Power-Down Bits**

| REGISTER      | VOUT-PDN-X[1] | VOUT-PDN-X[0] | IOUT-PDN-X | DESCRIPTION                                                          |
|---------------|---------------|---------------|------------|----------------------------------------------------------------------|
| COMMON-CONFIG | 0             | 0             | 1          | Power up VOUT-X                                                      |
|               | 0             | 1             | 1          | Power down VOUT-X with 10 kΩ to AGND.<br>Power down IOUT-X to Hi-Z.  |
|               | 1             | 0             | 1          | Power down VOUT-X with 100 kΩ to AGND.<br>Power down IOUT-X to Hi-Z. |
|               | 1             | 1             | 1          | Power down VOUT-X to Hi-Z.<br>Power down IOUT-X to Hi-Z (default).   |
|               | 1             | 1             | 0          | Power down VOUT-X to Hi-Z.<br>Power up IOUT-X.                       |

#### 7.4.7.1 Deep-Sleep Mode

The DACx3004 provides a deep-sleep mode, where the internal LDO and most of the common functional blocks are powered-down. The GPIO pin must be used to enter and exit this mode. The I<sup>2</sup>C or SPI interface does not work during the deep-sleep mode. The steps to enter and exit the deep-sleep mode are:

1. Make sure that the GPIO pin is pulled high.
2. Write 1 to the DEEP-SLEEP-EN bit in the GPIO-CONFIG register.
3. Disable GP output and SDO by writing 0 to GPO-EN and SDO-EN bits.
4. Enable GPIO input mode by writing 1 to GPI-EN and 0b0000 to GPI-CONFIG bits.
5. To program these settings into the NVM, write 1 to the NVM-PROG bit in the COMMON-TRIGGER register.
6. A negative-edge trigger on the GPIO puts the device into the deep-sleep mode. The LDO takes approximately 550 µs to switch off. The device remains in this mode as long as the signal is low.
7. To bring the device out of the deep-sleep mode, pull the GPIO pin high. The digital circuitry and the LDO takes approximately 550 µs to switch on.

## 7.5 Programming

The DACx3004 are programmed through either a 3-wire SPI or 2-wire I<sup>2</sup>C interface. A 4-wire SPI mode is enabled by mapping the GPIO pin as SDO. The SPI readback operates at a lower SCLK than the standard SPI write operation. The type of interface is determined based on the first protocol to communicate after device power up. After the interface type is determined, the device ignores any change in the type while the device is on. The interface type can be changed after a power cycle.

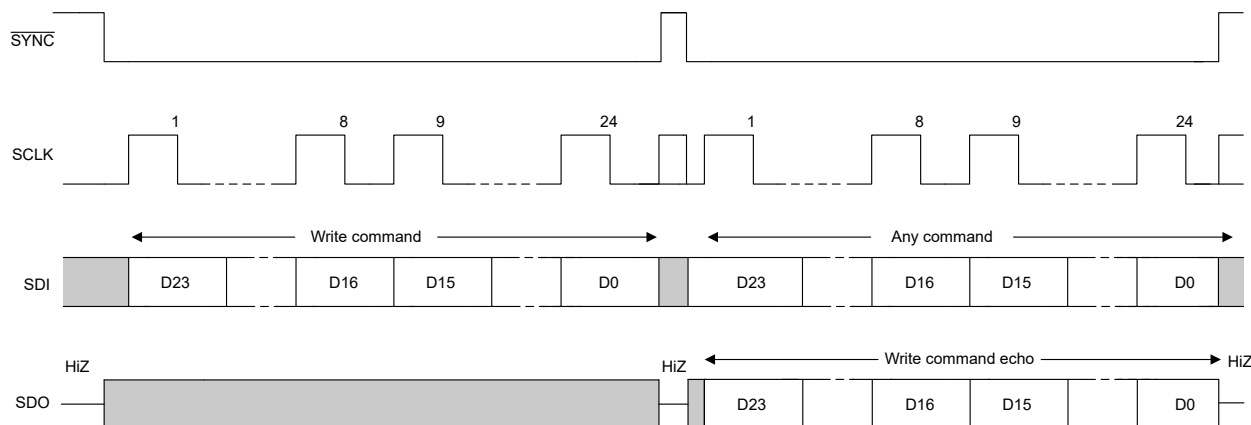
### 7.5.1 SPI Programming Mode

An SPI access cycle for DACx3004 is initiated by asserting the  $\overline{\text{SYNC}}$  pin low. The serial clock, SCLK, can be a continuous or gated clock. SDI data are clocked on SCLK falling edges. The SPI frame for DACx3004 is 24 bits long. Therefore, the  $\overline{\text{SYNC}}$  pin must stay low for at least 24 SCLK falling edges. The access cycle ends when the  $\overline{\text{SYNC}}$  pin is deasserted high. If the access cycle contains less than the minimum clock edges, the communication is ignored. By default, the SDO pin is not enabled (three-wire SPI). In the three-wire SPI mode, if the access cycle contains more than the minimum clock edges, only the first 24 bits are used by the device. When  $\overline{\text{SYNC}}$  is high, the SCLK and SDI signals are blocked, and SDO becomes Hi-Z to allow data readback from other devices connected on the bus.

Table 7-12 and Figure 7-14 describe the format for the 24-bit SPI access cycle. The first byte input to SDI is the instruction cycle. The instruction cycle identifies the request as a read or write command and the 7-bit address that is to be accessed. The last 16 bits in the cycle form the data cycle.

**Table 7-12. SPI Read/Write Access Cycle**

| BIT   | FIELD                    | DESCRIPTION                                                                                                                                                                                     |
|-------|--------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23    | R/ $\overline{\text{W}}$ | Identifies the communication as a read or write command to the address register: R/ $\overline{\text{W}}$ = 0 sets a write operation. R/ $\overline{\text{W}}$ = 1 sets a read operation        |
| 22-16 | A[6:0]                   | Register address: specifies the register to be accessed during the read or write operation                                                                                                      |
| 15-0  | DI[15:0]                 | Data cycle bits: If a write command, the data cycle bits are the values to be written to the register with address A[6:0]. If a read command, the data cycle bits are <i>don't care</i> values. |



**Figure 7-14. SPI Write Cycle**

Read operations require that the SDO pin is first enabled by setting the SDO-EN bit in the INTERFACE-CONFIG register. This configuration is called four-wire SPI. A read operation is initiated by issuing a read command access cycle. After the read command, a second access cycle must be issued to get the requested data. The output data format is shown in Table 7-13 and Figure 7-15. Data are clocked out on the SDO pin either on the falling edge or rising edge of SCLK according to the FSDO bit, as shown in Figure 6-3.

**Table 7-13. SDO Output Access Cycle**

| BIT   | FIELD                    | DESCRIPTION                                              |
|-------|--------------------------|----------------------------------------------------------|
| 23    | R/ $\overline{\text{W}}$ | Echo R/ $\overline{\text{W}}$ from previous access cycle |
| 22-16 | A[6:0]                   | Echo register address from previous access cycle         |
| 15-0  | DI[15:0]                 | Readback data requested on previous access cycle         |

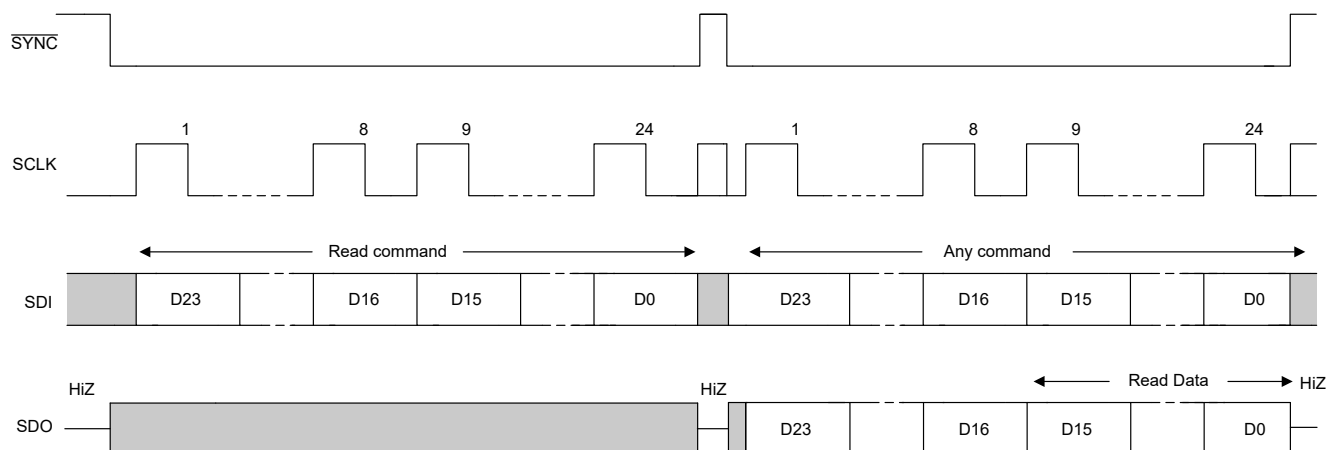


Figure 7-15. SPI Read Cycle

The daisy-chain operation is also enabled with the SDO pin. In daisy-chain mode, multiple devices are connected in a *chain* with the SDO pin of one device is connected to SDI pin of the following device, as shown in Figure 7-16. The SPI host drives the SDI pin of the first device in the chain. The SDO pin of the last device in the chain is connected to the POCI pin of the SPI host. In four-wire SPI mode, if the access cycle contains multiples of 24 clock edges, only the last 24 bits are used by the device first device in the chain. If the access cycle contains clock edges that are not in multiples of 24, the SPI packet is ignored by the device. Figure 7-17 describes the packet format for the daisy-chain write cycle.

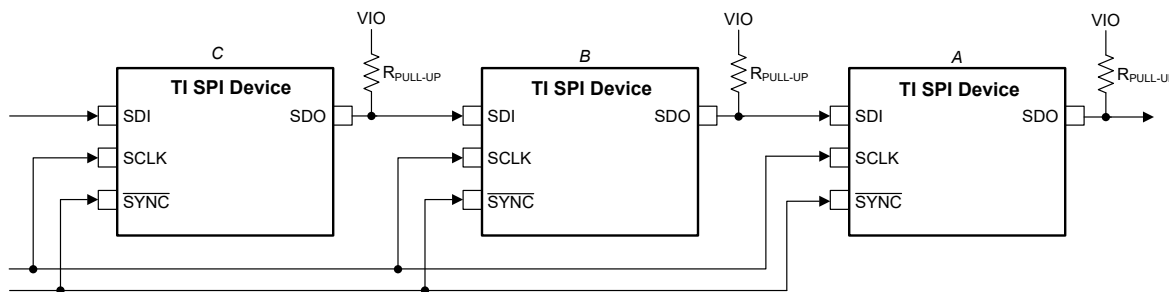


Figure 7-16. SPI Daisy-Chain Connection

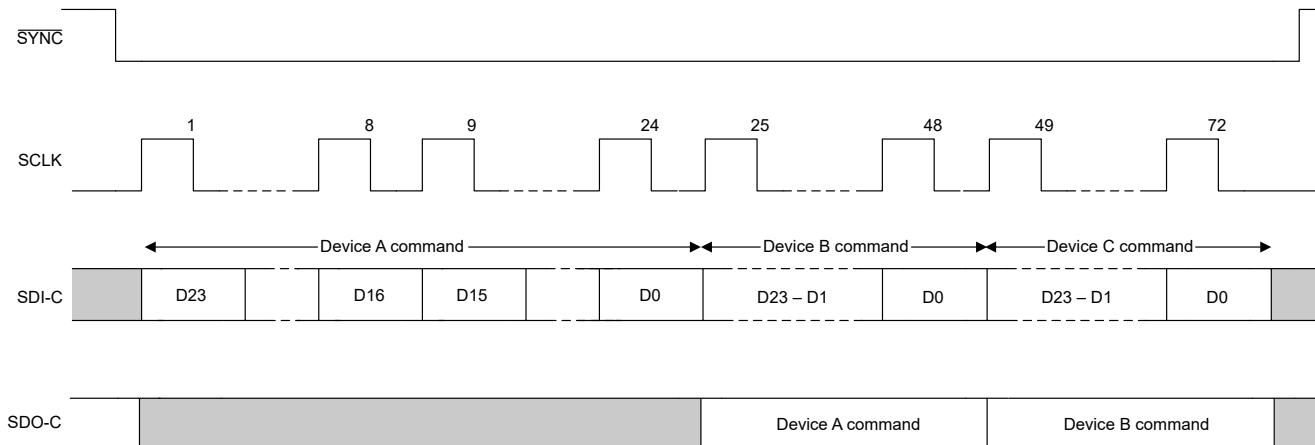


Figure 7-17. SPI Daisy-Chain Write Cycle

## 7.5.2 I<sup>2</sup>C Programming Mode

The DACx3004 devices have a 2-wire serial interface (SCL and SDA), and one address pin (A0), as shown in the pin diagram, [Figure 5-1](#). The I<sup>2</sup>C bus consists of a data line (SDA) and a clock line (SCL) with pullup structures. When the bus is idle, both SDA and SCL lines are pulled high. All the I<sup>2</sup>C-compatible devices connect to the I<sup>2</sup>C bus through the open drain I/O pins, SDA and SCL.

The I<sup>2</sup>C specification states that the device that controls communication is called a *controller*, and the devices that are controlled by the controller are called *targets*. The controller generates the SCL signal. The controller also generates special timing conditions (start condition, repeated start condition, and stop condition) on the bus to indicate the start or stop of a data transfer. Device addressing is completed by the controller. The controller on an I<sup>2</sup>C bus is typically a microcontroller or digital signal processor (DSP). The DACx3004 family operates as a target on the I<sup>2</sup>C bus. A target acknowledges controller commands, and upon controller control, receives or transmits data.

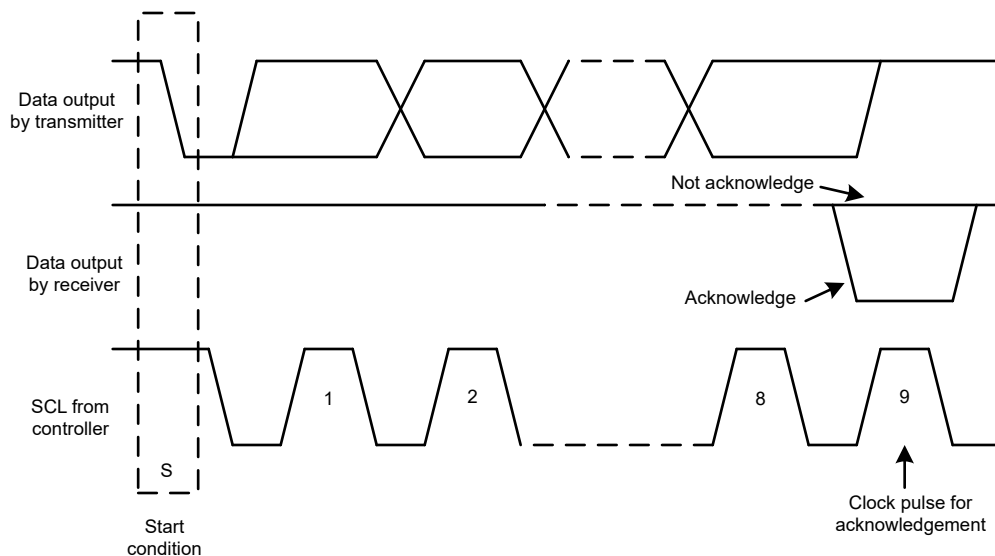
Typically, the DACx3004 family operates as a target receiver. A controller writes to the DACx3004, a target receiver. However, if a controller requires the DACx3004 internal register data, the DACx3004 operate as a target transmitter. In this case, the controller reads from the DACx3004. According to I<sup>2</sup>C terminology, read and write refer to the controller.

The DACx3004 family supports the following data transfer modes:

- Standard mode (100 kbps)
- Fast mode (400 kbps)
- Fast mode plus (1.0 Mbps)

The data transfer protocol for standard and fast modes is exactly the same; therefore, both modes are referred to as *F/S-mode* in this document. The fast mode plus protocol is supported in terms of data transfer speed, but not output current. The low-level output current would be 3 mA; similar to the case of standard and fast modes. The DACx3004 family supports 7-bit addressing. The 10-bit addressing mode is not supported. The device supports the general call reset function. Sending the following sequence initiates a software reset within the device: start or repeated start, 0x00, 0x06, stop. The reset is asserted within the device on the rising edge of the ACK bit, following the second byte.

Other than specific timing signals, the I<sup>2</sup>C interface works with serial bytes. At the end of each byte, a ninth clock cycle generates and detects an acknowledge signal. An acknowledge is when the SDA line is pulled low during the high period of the ninth clock cycle. A not-acknowledge is when the SDA line is left high during the high period of the ninth clock cycle, as shown in [Figure 7-18](#).



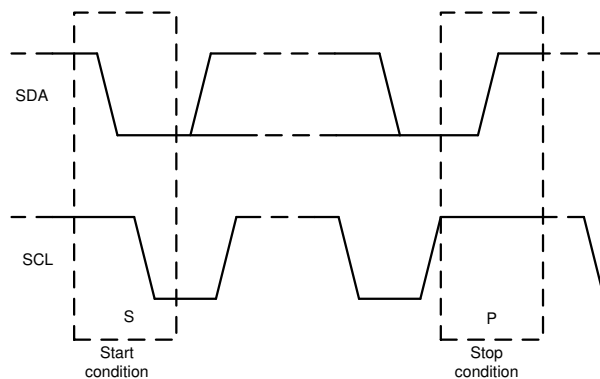
**Figure 7-18. Acknowledge and Not Acknowledge on the I<sup>2</sup>C Bus**



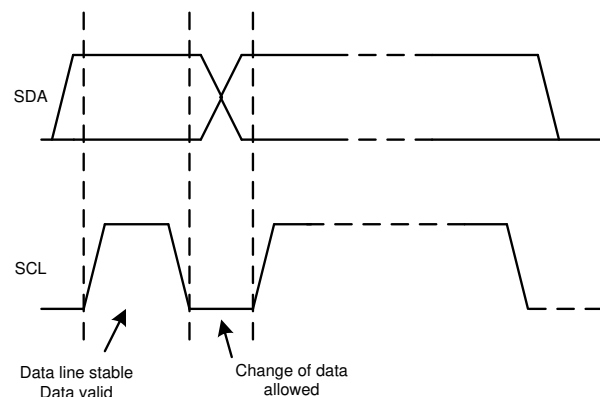
### 7.5.2.1 F/S Mode Protocol

The following steps explain a complete transaction in F/S mode.

1. The controller initiates data transfer by generating a start condition. The start condition is when a high-to-low transition occurs on the SDA line while SCL is high, as shown in [Figure 7-19](#). All I<sup>2</sup>C-compatible devices recognize a start condition.
2. The controller then generates the SCL pulses, and transmits the 7-bit address and the read/write direction bit ( $R/\overline{W}$ ) on the SDA line. During all transmissions, the controller makes sure that data are valid. A valid data condition requires the SDA line to be stable during the entire high period of the clock pulse, as shown in [Figure 7-20](#). All devices recognize the address sent by the controller and compare the address to the respective internal fixed address. Only the target device with a matching address generates an acknowledge by pulling the SDA line low during the entire high period of the 9th SCL cycle, as shown in [Figure 7-18](#). When the controller detects this acknowledge, the communication link with a target has been established.
3. The controller generates further SCL cycles to transmit ( $R/\overline{W}$  bit 0) or receive ( $R/\overline{W}$  bit 1) data to the target. In either case, the receiver must acknowledge the data sent by the transmitter. The acknowledge signal can be generated by the controller or by the target, depending on which is the receiver. The 9-bit valid data sequences consists of eight data bits and one acknowledge-bit, and can continue as long as necessary.
4. To signal the end of the data transfer, the controller generates a stop condition by pulling the SDA line from low-to-high while the SCL line is high, as shown in [Figure 7-19](#). This action releases the bus and stops the communication link with the addressed target. All I<sup>2</sup>C-compatible devices recognize the stop condition. Upon receipt of a stop condition, the bus is released, and all target devices then wait for a start condition followed by a matching address.



**Figure 7-19. Start and Stop Conditions**



**Figure 7-20. Bit Transfer on the I<sup>2</sup>C Bus**

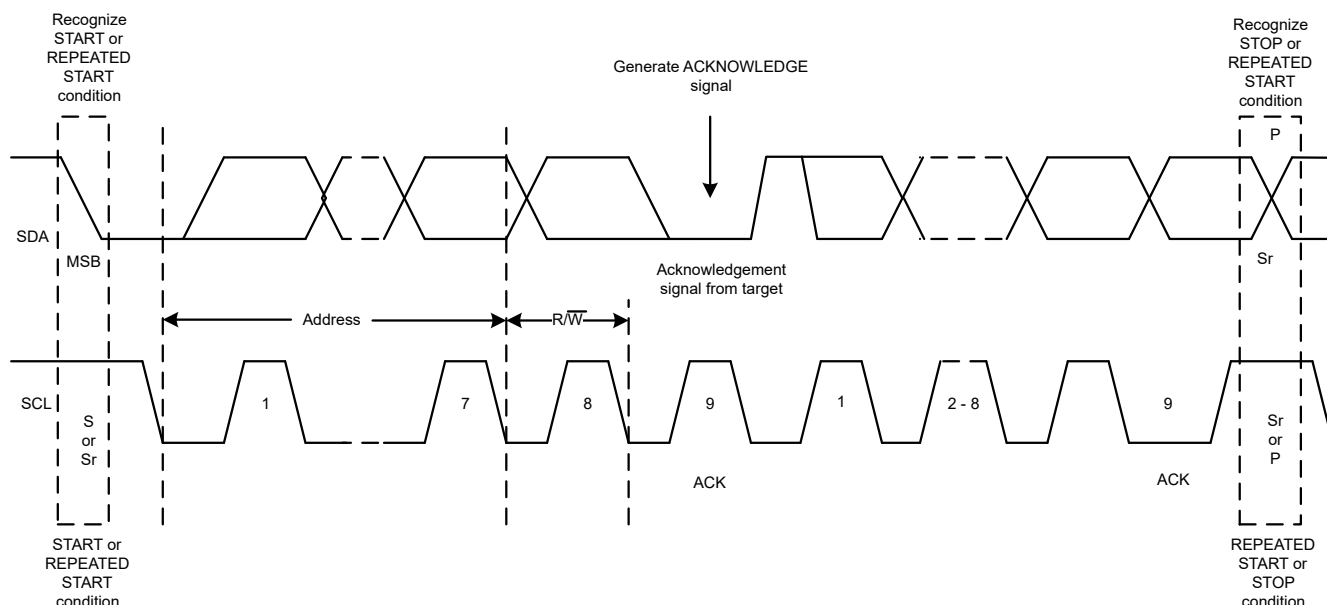
### 7.5.2.2 I<sup>2</sup>C Update Sequence

For a single update, the DACx3004 require a start condition, a valid I<sup>2</sup>C address byte, a command byte, and two data bytes, as listed in [Table 7-14](#).

**Table 7-14. Update Sequence**

| MSB                                                   | .... | LSB | ACK | MSB                                               | ... | LSB | ACK | MSB              | ... | LSB | ACK | MSB              | ... | LSB | ACK |
|-------------------------------------------------------|------|-----|-----|---------------------------------------------------|-----|-----|-----|------------------|-----|-----|-----|------------------|-----|-----|-----|
| Address (A) byte<br><a href="#">Section 7.5.2.2.1</a> |      |     |     | Command byte<br><a href="#">Section 7.5.2.2.2</a> |     |     |     | Data byte - MSDB |     |     |     | Data byte - LSDB |     |     |     |
| DB [31:24]                                            |      |     |     | DB [23:16]                                        |     |     |     | DB [15:8]        |     |     |     | DB [7:0]         |     |     |     |

After each byte is received, the DACx3004 family acknowledges the byte by pulling the SDA line low during the high period of a single clock pulse, as shown in [Figure 7-21](#). These four bytes and acknowledge cycles make up the 36 clock cycles required for a single update to occur. A valid I<sup>2</sup>C address byte selects the DACx3004.



**Figure 7-21. I<sup>2</sup>C Bus Protocol**

The command byte sets the operating mode of the selected DACx3004 device. For a data update to occur when the operating mode is selected by this byte, the DACx3004 device must receive two data bytes: the most significant data byte (MSDB) and least significant data byte (LSDB). The DACx3004 device performs an update on the falling edge of the acknowledge signal that follows the LSDB.

When using fast mode (clock = 400 kHz), the maximum DAC update rate is limited to 10 kSPS. Using fast mode plus (clock = 1 MHz), the maximum DAC update rate is limited to 25 kSPS. When a stop condition is received, the DACx3004 device releases the I<sup>2</sup>C bus and awaits a new start condition.

### 7.5.2.2.1 Address Byte

The address byte, as shown in [Table 7-15](#), is the first byte received from the controller device following the start condition. The first four bits (MSBs) of the address are factory preset to 1001. The next three bits of the address are controlled by the A0 pin. The A0 pin input can be connected to VDD, AGND, SCL, or SDA. The A0 pin is sampled during the first byte of each data frame to determine the address. The device latches the value of the address pin, and consequently responds to that particular address according to [Table 7-16](#).

**Table 7-15. Address Byte**

| COMMENT           | MSB |     |     |     |                                                           |     |     | LSB    |
|-------------------|-----|-----|-----|-----|-----------------------------------------------------------|-----|-----|--------|
| —                 | AD6 | AD5 | AD4 | AD3 | AD2                                                       | AD1 | AD0 | R/W    |
| General address   | 1   | 0   | 0   | 1   | See <a href="#">Table 7-16</a><br>(target address column) |     |     | 0 or 1 |
| Broadcast address | 1   | 0   | 0   | 0   | 1                                                         | 1   | 1   | 0      |

**Table 7-16. Address Format**

| TARGET ADDRESS | A0 PIN |
|----------------|--------|
| 000            | AGND   |
| 001            | VDD    |
| 010            | SDA    |
| 011            | SCL    |

The DACx3004 supports broadcast addressing, which is used for synchronously updating or powering down multiple DACx3004 devices. When the broadcast address is used, the DACx3004 responds regardless of the address pin state. Broadcast is supported only in write mode.

### 7.5.2.2.2 Command Byte

[Table 7-21](#) lists the command byte in the ADDRESS column.

### 7.5.2.3 I<sup>2</sup>C Read Sequence

To read any register the following command sequence must be used:

1. Send a start or repeated start command with a target address and the  $\overline{R/\overline{W}}$  bit set to 0 for writing. The device acknowledges this event.
2. Send a command byte for the register to be read. The device acknowledges this event again.
3. Send a repeated start with the target address and the  $\overline{R/\overline{W}}$  bit set to 1 for reading. The device acknowledges this event.
4. The device writes the MSDB byte of the addressed register. The controller must acknowledge this byte.
5. Finally, the device writes out the LSDB of the register.

The broadcast address cannot be used for reading.

**Table 7-17. Read Sequence**

| S               | MSB                               | ... | R/W<br>(0) | ACK    | MSB                               | ... | LSB | ACK | Sr     | MSB                               | ... | R/W<br>(1) | ACK | MSB    | ...         | LSB | ACK | MSB  | ...        | LSB         | ACK |  |  |            |
|-----------------|-----------------------------------|-----|------------|--------|-----------------------------------|-----|-----|-----|--------|-----------------------------------|-----|------------|-----|--------|-------------|-----|-----|------|------------|-------------|-----|--|--|------------|
|                 | ADDRESS BYTE<br>Section 7.5.2.2.1 |     |            |        | COMMAND BYTE<br>Section 7.5.2.2.2 |     |     |     | Sr     | ADDRESS BYTE<br>Section 7.5.2.2.1 |     |            |     | MSDB   |             |     |     | LSDB |            |             |     |  |  |            |
| From Controller |                                   |     |            | Target | From Controller                   |     |     |     | Target | From Controller                   |     |            |     | Target | From Target |     |     |      | Controller | From Target |     |  |  | Controller |

### 7.5.3 General-Purpose Input/Output (GPIO) Modes

Together with I<sup>2</sup>C and SPI, the DACx3004 also support a GPIO that can be configured in the NVM for multiple functions. This pin allows for updating the DAC output channels and reading status bits without using the programming interface, thus enabling processor-less operation. In the GPIO-CONFIG register, write 1 to the GPI-EN bit to set the GPIO pin as an input, or write 1 to the GPO-EN bit to set the pin as output. There are global and channel-specific functions mapped to the GPIO pin. For channel-specific functions, select the channels using the GPI-CH-SEL field in the GPIO-CONFIG register. [Table 7-18](#) lists the functional options available for the GPIO as input and [Table 7-19](#) lists the options for the GPIO as output. Some of the GP input operations are edge-triggered after the device boots up. After the power supply ramps up, the device registers the GPI level and executes the associated command. This feature allows the user to configure the initial output state at power-on. By default, the GPIO pin is not mapped to any operation. When the GPIO pin is mapped to a specific input function, the corresponding software bit functionality is disabled to avoid a race condition. When used as a  $\overline{\text{RESET}}$  input, the GPIO pin must transmit an active-low pulse for triggering a device reset. All other constraints of the functions are applied to the GPIO-based trigger.

#### Note

Pull the GPIO pin to high or low when not used. When the GPIO pin is used as  $\overline{\text{RESET}}$ , the configuration must be programmed into the NVM. Otherwise, the setting is cleared after the device resets.

**Table 7-18. General-Purpose Input Function Map**

| REGISTER    | BIT FIELD  | VALUE  | CHANNELS                                                                                           | GPIO EDGE / LEVEL | FUNCTION                                                                                                                                         |
|-------------|------------|--------|----------------------------------------------------------------------------------------------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| GPIO-CONFIG | GPI-CONFIG | 0000   | All                                                                                                | Falling-edge      | Trigger DEEP-SLEEP mode.                                                                                                                         |
|             |            |        |                                                                                                    | Rising-edge       | Bring the device out of deep-sleep.                                                                                                              |
|             |            | 0010   | All                                                                                                | Falling-edge      | Trigger FAULT-DUMP                                                                                                                               |
|             |            |        |                                                                                                    | Rising-edge       | No effect                                                                                                                                        |
|             |            | 0011   | As per GPI-CH-SEL                                                                                  | Falling-edge      | IOUT power-down                                                                                                                                  |
|             |            |        |                                                                                                    | Rising-edge       | IOUT power-up                                                                                                                                    |
|             |            | 0100   | As per GPI-CH-SEL                                                                                  | Falling-edge      | VOUT power-down. Pulldown resistor as per the VOUT-PDN-X setting                                                                                 |
|             |            |        |                                                                                                    | Rising-edge       | VOUT power-up                                                                                                                                    |
|             |            | 0101   | All                                                                                                | Falling-edge      | Trigger PROTECT function                                                                                                                         |
|             |            |        |                                                                                                    | Rising-edge       | No effect                                                                                                                                        |
|             |            | 0111   | All                                                                                                | Falling-edge      | Trigger CLR function                                                                                                                             |
|             |            |        |                                                                                                    | Rising-edge       | No effect                                                                                                                                        |
|             |            | 1000   | As per GPI-CH-SEL. Both the SYNC-CONFIG-X and the GPI-CH-SEL must be configured for every channel. | Falling-edge      | Trigger LDAC function                                                                                                                            |
|             |            |        |                                                                                                    | Rising-edge       | No effect                                                                                                                                        |
|             |            | 1001   | As per GPI-CH-SEL                                                                                  | Falling-edge      | Stop function generation                                                                                                                         |
|             |            |        |                                                                                                    | Rising-edge       | Start function generation                                                                                                                        |
|             |            | 1010   | As per GPI-CH-SEL                                                                                  | Falling-edge      | Trigger margin-low                                                                                                                               |
|             |            |        |                                                                                                    | Rising-edge       | Trigger margin-high                                                                                                                              |
|             |            | 1011   | All                                                                                                | Low pulse         | Trigger device RESET. The RESET configuration must be programmed into the NVM.                                                                   |
|             |            |        |                                                                                                    | Rising-edge       | No effect                                                                                                                                        |
|             |            | 1100   | All                                                                                                | Falling-edge      | Allows NVM programming                                                                                                                           |
|             |            |        |                                                                                                    | Rising-edge       | Blocks NVM programming                                                                                                                           |
|             |            | 1101   | All                                                                                                | Falling-edge      | Allows register map update                                                                                                                       |
|             |            |        |                                                                                                    | rising-edge       | Blocks register map write except a write to the DEV-UNLOCK field through I <sup>2</sup> C or SPI and to the RESET field through I <sup>2</sup> C |
|             |            | Others | NA                                                                                                 | NA                | Not applicable                                                                                                                                   |

**Table 7-19. General-Purpose Output (STATUS) Function Map**

| REGISTER    | BIT FIELD  | VALUE  | FUNCTION       |
|-------------|------------|--------|----------------|
| GPIO-CONFIG | GPO-CONFIG | 0001   | NVM-BUSY       |
|             |            | 0100   | DAC-0-BUSY     |
|             |            | 0101   | DAC-1-BUSY     |
|             |            | 0110   | DAC-2-BUSY     |
|             |            | 0111   | DAC-3-BUSY     |
|             |            | 1000   | WIN-CMP-0      |
|             |            | 1001   | WIN-CMP-1      |
|             |            | 1010   | WIN-CMP-2      |
|             |            | 1011   | WIN-CMP-3      |
|             |            | Others | Not applicable |

## 7.6 Register Map

**Table 7-20. Register Map**

| REGISTER <sup>(1)</sup> (2) | MOST SIGNIFICANT DATA BYTE (MSDB) |                   |               |                         |                |               |                |              | LEAST SIGNIFICANT DATA BYTE (LSDB) |               |               |              |                |                  |               |              |
|-----------------------------|-----------------------------------|-------------------|---------------|-------------------------|----------------|---------------|----------------|--------------|------------------------------------|---------------|---------------|--------------|----------------|------------------|---------------|--------------|
|                             | BIT15                             | BIT14             | BIT13         | BIT12                   | BIT11          | BIT10         | BIT9           | BIT8         | BIT7                               | BIT6          | BIT5          | BIT4         | BIT3           | BIT2             | BIT1          | BIT0         |
| NOP                         | NOP                               |                   |               |                         |                |               |                |              |                                    |               |               |              |                |                  |               |              |
| DAC-X-MARGIN-HIGH           | DAC-X-MARGIN-HIGH                 |                   |               |                         |                |               |                |              |                                    |               |               |              | X              |                  |               |              |
| DAC-X-MARGIN-LOW            | DAC-X-MARGIN-LOW                  |                   |               |                         |                |               |                |              |                                    |               |               |              | X              |                  |               |              |
| DAC-X-VOUT-CMP-CONFIG       | X                                 |                   |               | VOUT-X-GAIN             |                |               | X              |              |                                    |               |               | CMP-X-OD-EN  | CMP-X-OUT-EN   | CMP-X-HIZ-IN-DIS | CMP-X-INV-EN  | CMP-X-EN     |
| DAC-X-IOUT-MISC-CONFIG      | X                                 |                   |               | IOUT-X-RANGE            |                |               |                | X            |                                    |               |               |              |                |                  |               |              |
| DAC-X-CMP-MODE-CONFIG       | X                                 |                   |               |                         | CMP-X-MODE     |               |                | X            |                                    |               |               |              |                |                  |               |              |
| DAC-X-FUNC-CONFIG           | CLR-SEL-X                         | SYNC-CONFIG-X     | BRD-CONFIG-X  | FUNC-GEN-CONFIG-BLOCK-X |                |               |                |              |                                    |               |               |              |                |                  |               |              |
| DAC-X-DATA                  | DAC-X-DATA                        |                   |               |                         |                |               |                |              |                                    |               |               |              | X              |                  |               |              |
| COMMON-CONFIG               | WIN-LATCH-EN                      | DEV-LOCK          | EE-READ-ADDR  | EN-INT-REF              | VOUT-PDN-3     |               | IOUT-PDN-3     | VOUT-PDN-2   |                                    | IOUT-PDN-2    | VOUT-PDN-1    |              | IOUT-PDN-1     | VOUT-PDN-0       |               | IOUT-PDN-0   |
| COMMON-TRIGGER              | DEV-UNLOCK                        |                   |               |                         | RESET          |               |                |              | LDAC                               | CLR           | X             | FAULT-DUMP   | PROTECT        | READ-ONE-TRIG    | NVM-PROG      | NVM-RELOAD   |
| COMMON-DAC-TRIG             | RST-CMP-FLAG-0                    | TRIG-MAR-LO-0     | TRIG-MAR-HI-0 | START-FUNC-0            | RST-CMP-FLAG-1 | TRIG-MAR-LO-1 | TRIG-MAR-HI-1  | START-FUNC-1 | RST-CMP-FLAG-2                     | TRIG-MAR-LO-2 | TRIG-MAR-HI-2 | START-FUNC-2 | RST-CMP-FLAG-3 | TRIG-MAR-LO-3    | TRIG-MAR-HI-3 | START-FUNC-3 |
| GENERAL-STATUS              | NVM-CRC-FAIL-INT                  | NVM-CRC-FAIL-USER | X             | DAC-BUSY-3              | DAC-BUSY-2     | DAC-BUSY-1    | DAC-BUSY-0     | NVM-BUSY     | DEVICE-ID                          |               |               |              |                |                  |               |              |
| CMP-STATUS                  | X                                 |                   |               |                         |                |               |                | PROTECT-FLAG | WIN-CMP-3                          | WIN-CMP-2     | WIN-CMP-1     | WIN-CMP-0    | CMP-FLAG-3     | CMP-FLAG-2       | CMP-FLAG-1    | CMP-FLAG-0   |
| GPIO-CONFIG                 | GF-EN                             | DEEP-SLEEP-EN     | GPO-EN        | GPO-CONFIG              |                |               |                | GPI-CH-SEL   |                                    |               |               | GPI-CONFIG   |                |                  |               | GPI-EN       |
| DEVICE-MODE-CONFIG          | RESERVED                          |                   | DIS-MODE-IN   | RESERVED                |                |               | PROTECT-CONFIG |              | RESERVED                           |               |               |              | X              |                  |               |              |
| INTERFACE-CONFIG            | X                                 |                   |               | TIMEOUT-EN              | X              |               |                | EN-PMBUS     | X                                  |               |               |              |                | FAST-SDO-EN      | X             | SDO-EN       |
| SRAM-CONFIG                 | X                                 |                   |               |                         |                |               |                |              | SRAM-ADDR                          |               |               |              |                |                  |               |              |
| SRAM-DATA                   | SRAM-DATA                         |                   |               |                         |                |               |                |              |                                    |               |               |              |                |                  |               |              |
| DAC-X-DATA-8BIT             | DAC-X-DATA-8BIT                   |                   |               |                         |                |               |                |              | X                                  |               |               |              |                |                  |               |              |
| BRDCAST-DATA                | BRDCAST-DATA                      |                   |               |                         |                |               |                |              |                                    |               |               |              | X              |                  |               |              |
| PMBUS-PAGE                  | PMBUS-PAGE                        |                   |               |                         |                |               |                |              | NA                                 |               |               |              |                |                  |               |              |
| PMBUS-OP-CMD                | PMBUS-OPERATION-CMD-X             |                   |               |                         |                |               |                |              | NA                                 |               |               |              |                |                  |               |              |
| PMBUS-CML                   | X                                 |                   |               |                         |                |               | CML            | X            | NA                                 |               |               |              |                |                  |               |              |
| PMBUS-VERSION               | PMBUS-VERSION                     |                   |               |                         |                |               |                |              | NA                                 |               |               |              |                |                  |               |              |

(1) The highlighted gray cells indicate the register bits or fields that are stored in the NVM.

(2) X = Don't care.

**Table 7-21. Register Names**

| I <sup>2</sup> C/SPI ADDRESS | PMBUS PAGE ADDR | PMBUS REGISTER ADDR | REGISTER NAME          | SECTION                        |
|------------------------------|-----------------|---------------------|------------------------|--------------------------------|
| 00h                          | FFh             | D0h                 | NOP                    | <a href="#">Section 7.6.1</a>  |
| 01h                          | 00h             | 25h                 | DAC-0-MARGIN-HIGH      | <a href="#">Section 7.6.2</a>  |
| 02h                          | 00h             | 26h                 | DAC-0-MARGIN-LOW       | <a href="#">Section 7.6.3</a>  |
| 03h                          | FFh             | D1h                 | DAC-0-VOOUT-CMP-CONFIG | <a href="#">Section 7.6.4</a>  |
| 04h                          | FFh             | D2h                 | DAC-0-IOUT-MISC-CONFIG | <a href="#">Section 7.6.5</a>  |
| 05h                          | FFh             | D3h                 | DAC-0-CMP-MODE-CONFIG  | <a href="#">Section 7.6.6</a>  |
| 06h                          | FFh             | D4h                 | DAC-0-FUNC-CONFIG      | <a href="#">Section 7.6.7</a>  |
| 07h                          | 01h             | 25h                 | DAC-1-MARGIN-HIGH      | <a href="#">Section 7.6.1</a>  |
| 08h                          | 01h             | 26h                 | DAC-1-MARGIN-LOW       | <a href="#">Section 7.6.2</a>  |
| 09h                          | FFh             | D5h                 | DAC-1-VOOUT-CMP-CONFIG | <a href="#">Section 7.6.3</a>  |
| 0Ah                          | FFh             | D6h                 | DAC-1-IOUT-MISC-CONFIG | <a href="#">Section 7.6.4</a>  |
| 0Bh                          | FFh             | D7h                 | DAC-1-CMP-MODE-CONFIG  | <a href="#">Section 7.6.5</a>  |
| 0Ch                          | FFh             | D8h                 | DAC-1-FUNC-CONFIG      | <a href="#">Section 7.6.6</a>  |
| 0Dh                          | 02h             | 25h                 | DAC-2-MARGIN-HIGH      | <a href="#">Section 7.6.1</a>  |
| 0Eh                          | 02h             | 26h                 | DAC-2-MARGIN-LOW       | <a href="#">Section 7.6.2</a>  |
| 0Fh                          | FFh             | D9h                 | DAC-2-VOOUT-CMP-CONFIG | <a href="#">Section 7.6.3</a>  |
| 10h                          | FFh             | DAh                 | DAC-2-IOUT-MISC-CONFIG | <a href="#">Section 7.6.4</a>  |
| 11h                          | FFh             | DBh                 | DAC-2-CMP-MODE-CONFIG  | <a href="#">Section 7.6.5</a>  |
| 12h                          | FFh             | DCh                 | DAC-2-FUNC-CONFIG      | <a href="#">Section 7.6.6</a>  |
| 13h                          | 03h             | 25h                 | DAC-3-MARGIN-HIGH      | <a href="#">Section 7.6.1</a>  |
| 14h                          | 03h             | 26h                 | DAC-3-MARGIN-LOW       | <a href="#">Section 7.6.2</a>  |
| 15h                          | FFh             | DDh                 | DAC-3-VOOUT-CMP-CONFIG | <a href="#">Section 7.6.3</a>  |
| 16h                          | FFh             | DEh                 | DAC-3-IOUT-MISC-CONFIG | <a href="#">Section 7.6.4</a>  |
| 17h                          | FFh             | DFh                 | DAC-3-CMP-MODE-CONFIG  | <a href="#">Section 7.6.5</a>  |
| 18h                          | FFh             | E0h                 | DAC-3-FUNC-CONFIG      | <a href="#">Section 7.6.6</a>  |
| 19h                          | 00h             | 21h                 | DAC-0-DATA             | <a href="#">Section 7.6.8</a>  |
| 1Ah                          | 01h             | 21h                 | DAC-1-DATA             | <a href="#">Section 7.6.8</a>  |
| 1Bh                          | 02h             | 21h                 | DAC-2-DATA             | <a href="#">Section 7.6.8</a>  |
| 1Ch                          | 03h             | 21h                 | DAC-3-DATA             | <a href="#">Section 7.6.8</a>  |
| 1Fh                          | FFh             | E3h                 | COMMON-CONFIG          | <a href="#">Section 7.6.9</a>  |
| 20h                          | FFh             | E4h                 | COMMON-TRIGGER         | <a href="#">Section 7.6.10</a> |
| 21h                          | FFh             | E5h                 | COMMON-DAC-TRIG        | <a href="#">Section 7.6.11</a> |

**Table 7-21. Register Names (continued)**

| I <sup>2</sup> C/SPI ADDRESS | PMBUS PAGE ADDR | PMBUS REGISTER ADDR | REGISTER NAME      | SECTION                        |
|------------------------------|-----------------|---------------------|--------------------|--------------------------------|
| 22h                          | FFh             | E6h                 | GENERAL-STATUS     | <a href="#">Section 7.6.12</a> |
| 23h                          | FFh             | E7h                 | CMP-STATUS         | <a href="#">Section 7.6.13</a> |
| 24h                          | FFh             | E8h                 | GPIO-CONFIG        | <a href="#">Section 7.6.14</a> |
| 25h                          | FFh             | E9h                 | DEVICE-MODE-CONFIG | <a href="#">Section 7.6.15</a> |
| 26h                          | FFh             | EAh                 | INTERFACE-CONFIG   | <a href="#">Section 7.6.16</a> |
| 2Bh                          | FFh             | EFh                 | SRAM-CONFIG        | <a href="#">Section 7.6.17</a> |
| 2Ch                          | FFh             | F0h                 | SRAM-DATA          | <a href="#">Section 7.6.18</a> |
| 40h                          | NA              | NA                  | DAC-0-DATA-8BIT    | <a href="#">Section 7.6.19</a> |
| 41h                          | NA              | NA                  | DAC-1-DATA-8BIT    | <a href="#">Section 7.6.19</a> |
| 42h                          | NA              | NA                  | DAC-2-DATA-8BIT    | <a href="#">Section 7.6.19</a> |
| 43h                          | NA              | NA                  | DAC-3-DATA-8BIT    | <a href="#">Section 7.6.19</a> |
| 50h                          | FFh             | F1h                 | BRDCAST-DATA       | <a href="#">Section 7.6.20</a> |
| NA                           | All pages       | 00h                 | PMBUS-PAGE         | <a href="#">Section 7.6.21</a> |
| NA                           | 00h             | 01h                 | PMBIS-OP-CMD-0     | <a href="#">Section 7.6.22</a> |
| NA                           | 01h             | 01h                 | PMBUS-OP-CMD-1     | <a href="#">Section 7.6.22</a> |
| NA                           | 02h             | 01h                 | PMBUS-OP-CMD-2     | <a href="#">Section 7.6.22</a> |
| NA                           | 03h             | 01h                 | PMBUS-OP-CMD-3     | <a href="#">Section 7.6.22</a> |
| NA                           | All pages       | 78h                 | PMBUS-CML          | <a href="#">Section 7.6.23</a> |
| NA                           | All pages       | 98h                 | PMBUS-VERSION      | <a href="#">Section 7.6.24</a> |

**Table 7-22. Access Type Codes**

| Access Type            | Code | Description                            |
|------------------------|------|----------------------------------------|
| X                      | X    | Don't care                             |
| Read Type              |      |                                        |
| R                      | R    | Read                                   |
| Write Type             |      |                                        |
| W                      | W    | Write                                  |
| Reset or Default Value |      |                                        |
| -n                     |      | Value after reset or the default value |



### 7.6.1 NOP Register (address = 00h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = D0h

**Figure 7-22. NOP Register**

| 15   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| NOP  |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| R-0h |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**Table 7-23. NOP Register Field Descriptions**

| Bit  | Field | Type | Reset | Description  |
|------|-------|------|-------|--------------|
| 15-0 | NOP   | R    | 0000h | No operation |

### 7.6.2 DAC-X-MARGIN-HIGH Register (address = 01h, 07h, 0Dh, 13h) [reset = 0000h]

PMBus page address = 00h, 01h, 02h, 03h, PMBus register address = 25h

**Figure 7-23. DAC-X-MARGIN-HIGH Register (X = 0, 1, 2, 3)**

| 15                                                | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3    | 2 | 1 | 0 |
|---------------------------------------------------|----|----|----|----|----|---|---|---|---|---|---|------|---|---|---|
| DAC-X-MARGIN-HIGH[11:0]<br>DAC-X-MARGIN-HIGH[9:0] |    |    |    |    |    |   |   |   |   |   |   | X    |   |   |   |
| R/W-0h                                            |    |    |    |    |    |   |   |   |   |   |   | X-0h |   |   |   |

**Table 7-24. DAC-X-MARGIN-HIGH Register Field Descriptions**

| Bit  | Field                                             | Type | Reset | Description                                                                                                                                                                                                                             |
|------|---------------------------------------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-4 | DAC-X-MARGIN-HIGH[11:0]<br>DAC-X-MARGIN-HIGH[9:0] | R/W  | 000h  | Margin-high code for DAC output<br>Data are in straight-binary format. MSB left-aligned.<br>Use the following bit-alignment:<br>DAC63004: {DAC-X-MARGIN-HIGH[11:0]}<br>DAC53004: {DAC-X-MARGIN-HIGH[9:0], X, X}<br>X = Don't care bits. |
| 3-0  | X                                                 | X    | 0     | Don't care                                                                                                                                                                                                                              |

### 7.6.3 DAC-X-MARGIN-LOW Register (address = 02h, 08h, 0Eh, 14h) [reset = 0000h]

PMBus page address = 00h, 01h, 02h, 03h, PMBus register address = 26h

**Figure 7-24. DAC-X-MARGIN-LOW Register (X = 0, 1, 2, 3)**

| 15                                              | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3    | 2 | 1 | 0 |
|-------------------------------------------------|----|----|----|----|----|---|---|---|---|---|---|------|---|---|---|
| DAC-X-MARGIN-LOW[11:0]<br>DAC-X-MARGIN-LOW[9:0] |    |    |    |    |    |   |   |   |   |   |   | X    |   |   |   |
| R/W-0h                                          |    |    |    |    |    |   |   |   |   |   |   | X-0h |   |   |   |

**Table 7-25. DAC-X-MARGIN-LOW Register Field Descriptions**

| Bit  | Field                                           | Type | Reset | Description                                                                                                                                                                                                                          |
|------|-------------------------------------------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-4 | DAC-X-MARGIN-LOW[11:0]<br>DAC-X-MARGIN-LOW[9:0] | R/W  | 000h  | Margin-low code for DAC output<br>Data are in straight-binary format. MSB left-aligned.<br>Use the following bit-alignment:<br>DAC63004: {DAC-X-MARGIN-LOW[11:0]}<br>DAC53004: {DAC-X-MARGIN-LOW[9:0], X, X}<br>X = Don't care bits. |
| 3-0  | X                                               | X    | 0     | Don't care                                                                                                                                                                                                                           |

#### 7.6.4 DAC-X-VOUT-CMP-CONFIG Register (address = 03h, 09h, 0Fh, 15h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = D1h, D5h, D9h, DDh

**Figure 7-25. DAC-X-VOUT-CMP-CONFIG Register (X = 0, 1, 2, 3)**

| 15   | 14 | 13          | 12 | 11 | 10 | 9    | 8 | 7 | 6      | 5 | 4           | 3            | 2                | 1            | 0        |
|------|----|-------------|----|----|----|------|---|---|--------|---|-------------|--------------|------------------|--------------|----------|
| X    |    | VOUT-GAIN-X |    |    |    | X    |   |   |        |   | CMP-X-OD-EN | CMP-X-OUT-EN | CMP-X-HIZ-IN-DIS | CMP-X-INV-EN | CMP-X-EN |
| X-0h |    | R/W-0h      |    |    |    | X-0h |   |   | R/W-0h |   | R/W-0h      | R/W-0h       | R/W-0h           | R/W-0h       | R/W-0h   |

**Table 7-26. DAC-X-VOUT-CMP-CONFIG Register Field Descriptions**

| Bit   | Field            | Type | Reset | Description                                                                                                                                                                                                                                                     |
|-------|------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-13 | X                | X    | 0h    | Don't care                                                                                                                                                                                                                                                      |
| 12-10 | VOUT-GAIN-X      | R/W  | 0h    | 000: Gain = 1x, external reference on VREF pin<br>001: Gain = 1x, VDD as reference<br>010: Gain = 1.5x, internal reference<br>011: Gain = 2x, internal reference<br>100: Gain = 3x, internal reference<br>101: Gain = 4x, internal reference<br>Others: Invalid |
| 9-5   | X                | X    | 0h    | Don't care                                                                                                                                                                                                                                                      |
| 4     | CMP-X-OD-EN      | R/W  | 0     | 0: Set OUTx pin as push-pull<br>1: Set OUTx pin as open-drain in comparator mode (CMP-X-EN = 1 and CMP-X-OUT-EN = 1)                                                                                                                                            |
| 3     | CMP-X-OUT-EN     | R/W  | 0     | 0: Generate comparator output but consume internally<br>1: Bring comparator output to the respective OUTx pin                                                                                                                                                   |
| 2     | CMP-X-HIZ-IN-DIS | R/W  | 0     | 0: FBx input has high-impedance. Input voltage range is limited.<br>1: FBx input is connected to resistor divider and has finite impedance. Input voltage range is same as full-scale.                                                                          |
| 1     | CMP-X-INV-EN     | R/W  | 0     | 0: Don't invert the comparator output<br>1: Invert the comparator output                                                                                                                                                                                        |
| 0     | CMP-X-EN         | R/W  | 0     | 0: Disable comparator mode<br>1: Enable comparator mode. Current-output must be in power-down. Voltage-output mode must be enabled.                                                                                                                             |

### 7.6.5 DAC-X-IOUT-MISC-CONFIG Register (address = 04h, 0Ah, 10h, 16h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = D2h, D6h, DAh, DEh

**Figure 7-26. DAC-X-IOUT-MISC-CONFIG Register (X = 0, 1, 2, 3)**

| 15   | 14 | 13 | 12           | 11 | 10 | 9 | 8 | 7    | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|--------------|----|----|---|---|------|---|---|---|---|---|---|---|
| X    |    |    | IOUT-RANGE-X |    |    |   |   | X    |   |   |   |   |   |   |   |
| X-0h |    |    | R/W-0h       |    |    |   |   | X-0h |   |   |   |   |   |   |   |

**Table 7-27. DAC-X-IOUT-MISC-CONFIG Register Field Descriptions**

| Bit   | Field        | Type              | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                         |
|-------|--------------|-------------------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-13 | X            | X                 | 0h    | Don't care                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 12-9  | IOUT-RANGE-X | R/ $\overline{W}$ | 0000  | 0000: 0 $\mu$ A to 25 $\mu$ A<br>0001: 0 $\mu$ A to 50 $\mu$ A<br>0010: 0 $\mu$ A to 125 $\mu$ A<br>0011: 0 $\mu$ A to 250 $\mu$ A<br>0100: 0 $\mu$ A to –24 $\mu$ A<br>0101: 0 $\mu$ A to –48 $\mu$ A<br>0110: 0 $\mu$ A to –120 $\mu$ A<br>0111: 0 $\mu$ A to –240 $\mu$ A<br>1000: –25 $\mu$ A to +25 $\mu$ A<br>1001: –50 $\mu$ A to +50 $\mu$ A<br>1010: –125 $\mu$ A to +125 $\mu$ A<br>1011: –250 $\mu$ A to +250 $\mu$ A<br>Others: Invalid |
| 8-0   | X            | X                 | 000h  | Don't care                                                                                                                                                                                                                                                                                                                                                                                                                                          |

### 7.6.6 DAC-X-CMP-MODE-CONFIG Register (address = 05h, 0Bh, 11h, 17h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = D3h, D7h, DBh, DFh

**Figure 7-27. DAC-X-CMP-MODE-CONFIG Register (X = 0, 1, 2, 3)**

| 15   | 14 | 13 | 12 | 11         | 10 | 9 | 8 | 7    | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|------------|----|---|---|------|---|---|---|---|---|---|---|
| X    |    |    |    | CMP-X-MODE |    | X |   |      |   |   |   |   |   |   |   |
| X-0h |    |    |    | R/W-0h     |    |   |   | X-0h |   |   |   |   |   |   |   |

**Table 7-28. DAC-X-CMP-MODE-CONFIG Register Field Descriptions**

| Bit   | Field      | Type              | Reset | Description                                                                                                                                                                                                                                     |
|-------|------------|-------------------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-12 | X          | X                 | 00h   | Don't care                                                                                                                                                                                                                                      |
| 11-10 | CMP-X-MODE | R/ $\overline{W}$ | 00    | 00: No hysteresis or window function<br>01: Hysteresis provided using DAC-X-MARGIN-HIGH and DAC-X-MARGIN-LOW registers<br>10: Window comparator mode with DAC-X-MARGIN-HIGH and DAC-X-MARGIN-LOW registers setting window bounds<br>11: Invalid |
| 9-0   | X          | X                 | 000h  | Don't care                                                                                                                                                                                                                                      |

### 7.6.7 DAC-X-FUNC-CONFIG Register (address = 06h, 0Ch, 12h, 18h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = D4h, D8h, DCh, E0h

**Figure 7-28. DAC-X-FUNC-CONFIG Register (X = 0, 1, 2, 3)**

| 15        | 14            | 13           | 12                    | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----------|---------------|--------------|-----------------------|----|----|---|---|---|---|---|---|---|---|---|---|
| CLR-SEL-X | SYNC-CONFIG-X | BRD-CONFIG-X | FUNC-GEN-CONFIG-BLOCK |    |    |   |   |   |   |   |   |   |   |   |   |
| R/W-0h    | R/W-0h        | R/W-0h       | R/W-0h                |    |    |   |   |   |   |   |   |   |   |   |   |

**Table 7-29. DAC-X-FUNC-CONFIG Register Field Descriptions**

| Bit | Field         | Type | Reset | Description                                                                                                                                                                     |
|-----|---------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15  | CLR-SEL-X     | R/W  | 0     | 0: Clear DAC-X to zero-scale<br>1: Clear DAC-X to mid-scale                                                                                                                     |
| 14  | SYNC-CONFIG-X | R/W  | 0     | 0: DAC-X output updates immediately after a write command<br>1: DAC-X output updates with LDAC pin falling-edge or when the LDAC bit in the COMMON-TRIGGER register is set to 1 |
| 13  | BRD-CONFIG-X  | R/W  | 0     | 0: Don't update DAC-X with broadcast command<br>1: Update DAC-X with broadcast command                                                                                          |

**Table 7-30. Linear-Slew Mode: FUNC-GEN-CONFIG-BLOCK Field Descriptions**

| Bit   | Field         | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-------|---------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 12-11 | PHASE-SEL-X   | R/W  | 0     | 00: 0°<br>01: 120°<br>10: 240°<br>11: 90°                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 10-8  | FUNC-CONFIG-X | R/W  | 0     | 000: Triangular wave<br>001: Sawtooth wave<br>010: Inverse sawtooth wave<br>100: Sine wave<br>111: Disable function generation<br>Others: Invalid                                                                                                                                                                                                                                                                                                                  |
| 7     | LOG-SLEW-EN-X | R/W  | 0     | 0: Enable linear slew                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| 6-4   | CODE-STEP-X   | R/W  | 0     | CODE-STEP for linear slew mode:<br>000: 1-LSB<br>001: 2-LSB<br>010: 3-LSB<br>011: 4-LSB<br>100: 6-LSB<br>101: 8-LSB<br>110: 16-LSB<br>111: 32-LSB                                                                                                                                                                                                                                                                                                                  |
| 3-0   | SLEW-RATE-X   | R/W  | 0     | SLEW-RATE for linear slew mode:<br>0000: No slew for margin-high and margin-low. Invalid for waveform generation.<br>0001: 4 µs/step<br>0010: 8 µs/step<br>0011: 12 µs/step<br>0100: 18 µs/step<br>0101: 27.04 µs/step<br>0110: 40.48 µs/step<br>0111: 60.72 µs/step<br>1000: 91.12 µs/step<br>1001: 136.72 µs/step<br>1010: 239.2 µs/step<br>1011: 418.64 µs/step<br>1100: 732.56 µs/step<br>1101: 1282 µs/step<br>1110: 2563.96 µs/step<br>1111: 5127.92 µs/step |

**Table 7-31. Logarithmic-Slew Mode: FUNC-GEN-CONFIG-BLOCK Field Descriptions**

| Bit    | Field         | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|--------|---------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 12-11  | PHASE-SEL-X   | R/W  | 0     | 00: 0°<br>01: 120°<br>10: 240°<br>11: 90°                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| 10 - 8 | FUNC-CONFIG-X | R/W  | 0     | 000: Triangular wave<br>001: Sawtooth wave<br>010: Inverse sawtooth wave<br>100: Sine wave<br>111: Disable function generation<br>Others: Invalid                                                                                                                                                                                                                                                                                                                                                                         |
| 7      | LOG-SLEW-EN-X | R/W  | 0     | 1: Enable logarithmic slew.<br>In logarithmic slew mode, the DAC output moves from the DAC-X-MARGIN-LOW code to the DAC-X-MARGIN-HIGH code, or vice versa, in 3.125% steps.<br>When slewing in the positive direction, the next step is (1 + 0.03125) times the current step.<br>When slewing in the negative direction, the next step is (1 – 0.03125) times the current step.<br>When DAC-X-MARGIN-LOW is 0, the slew starts from code 1.<br>The time interval for each step is defined by RISE-SLEW-X and FALL-SLEW-X. |
| 6-4    | RISE-SLEW-X   | R/W  | 0     | SLEW-RATE for logarithmic slew mode (DAC-X-MARGIN-LOW to DAC-X-MARGIN-HIGH):<br>000: 4 µs/step<br>001: 12 µs/step<br>010: 27.04 µs/step<br>011: 60.72 µs/step<br>100: 136.72 µs/step<br>101: 418.64 µs/step<br>110: 1282 µs/step<br>111: 5127.92 µs/step                                                                                                                                                                                                                                                                  |
| 3-1    | FALL-SLEW-X   | R/W  | 0     | SLEW-RATE for logarithmic slew mode (DAC-X-MARGIN-HIGH to DAC-X-MARGIN-LOW):<br>000: 4 µs/step<br>001: 12 µs/step<br>010: 27.04 µs/step<br>011: 60.72 µs/step<br>100: 136.72 µs/step<br>101: 418.64 µs/step<br>110: 1282 µs/step<br>111: 5127.92 µs/step                                                                                                                                                                                                                                                                  |
| 0      | X             | X    | 0     | Don't care                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |

### 7.6.8 DAC-X-DATA Register (address = 19h, 1Ah, 1Bh, 1Ch) [reset = 0000h]

PMBus page address = 00h, 01h, 02h, 03h, PMBus register address = 21h

**Figure 7-29. DAC-X-DATA Register (X = 0, 1, 2, 3)**

| 15                                  | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3    | 2 | 1 | 0 |
|-------------------------------------|----|----|----|----|----|---|---|---|---|---|---|------|---|---|---|
| DAC-X-DATA[11:0]<br>DAC-X-DATA[9:0] |    |    |    |    |    |   |   |   |   |   |   | X    |   |   |   |
| R/W-0h                              |    |    |    |    |    |   |   |   |   |   |   | X-0h |   |   |   |

**Table 7-32. DAC-X-DATA Register Field Descriptions**

| Bit  | Field                               | Type | Reset | Description                                                                                                                                                                                                                  |
|------|-------------------------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-4 | DAC-X-DATA[11:0]<br>DAC-X-DATA[9:0] | R/W  | 000h  | Data for DAC output<br>Data are in straight-binary format. MSB left-aligned. MSB left-aligned. Use the following bit-alignment:<br>DAC63004: {DAC-X-DATA[11:0]}<br>DAC53004: {DAC-X-DATA[9:0], X, X}<br>X = Don't care bits. |
| 3-0  | X                                   | X    | 0h    | Don't care                                                                                                                                                                                                                   |

### 7.6.9 COMMON-CONFIG Register (address = 1Fh) [reset = 0FFFh]

PMBus page address = FFh, PMBus register address = E3h

**Figure 7-30. COMMON-CONFIG Register**

| 15           | 14       | 13           | 12         | 11         | 10         | 9          | 8          | 7          | 6          | 5          | 4          | 3       | 2       | 1       | 0      |
|--------------|----------|--------------|------------|------------|------------|------------|------------|------------|------------|------------|------------|---------|---------|---------|--------|
| WIN-LATCH-EN | DEV-LOCK | EE-READ-ADDR | EN-INT-REF | VOUT-PDN-3 | IOUT-PDN-3 | VOUT-PDN-2 | IOUT-PDN-2 | VOUT-PDN-1 | IOUT-PDN-1 | VOUT-PDN-0 | IOUT-PDN-0 |         |         |         |        |
| R/W-0h       | R/W-0h   | R/W-0h       | R/W-0h     | R/W-11b    | R/W-1b     | R/W-11b    | R/W-1b     | R/W-11b    | R/W-1b     | R/W-11b    | R/W-1b     | R/W-11b | R/W-11b | R/W-11b | R/W-1b |

**Table 7-33. COMMON-CONFIG Register Field Descriptions**

| Bit                  | Field        | Type | Reset | Description                                                                                                                                                                                                                                                   |
|----------------------|--------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15                   | WIN-LATCH-EN | R/W  | 0     | 0: Non-latching window-comparator output<br>1: Latching window-comparator output                                                                                                                                                                              |
| 14                   | DEV-LOCK     | R/W  | 0     | 0: Device not locked<br>1: Device locked, the device locks all the registers. To set this bit back to 0 (unlock device), write to the unlock code to the DEV-UNLOCK field in the COMMON-TRIGGER register first, followed by a write to the DEV-LOCK bit as 0. |
| 13                   | EE-READ-ADDR | R/W  | 0     | 0: Fault-dump read enable at address 0x00<br>1: Fault-dump read enable at address 0x01                                                                                                                                                                        |
| 12                   | EN-INT-REF   | R/W  | 0     | 0: Disable internal reference<br>1: Enable internal reference. This bit must be set before using internal reference gain settings.                                                                                                                            |
| 11-10, 8-7, 5-4, 2-1 | VOUT-PDN-X   | R/W  | 11    | 00: Power-up VOUT-X<br>01: Power-down VOUT-X with 10 KΩ to AGND<br>10: Power-down VOUT-X with 100 KΩ to AGND<br>11: Power-down VOUT-X with Hi-Z to AGND                                                                                                       |
| 9, 6, 3, 0           | IOUT-PDN-X   | R/W  | 1     | 0: Power-up IOUT-X<br>1: Power-down IOUT-X                                                                                                                                                                                                                    |

### 7.6.10 COMMON-TRIGGER Register (address = 20h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = E4h

**Figure 7-31. COMMON-TRIGGER Register**

| 15         | 14 | 13 | 12 | 11     | 10 | 9 | 8 | 7      | 6      | 5    | 4          | 3       | 2             | 1        | 0          |
|------------|----|----|----|--------|----|---|---|--------|--------|------|------------|---------|---------------|----------|------------|
| DEV-UNLOCK |    |    |    | RESET  |    |   |   | LDAC   | CLR    | X    | FAULT-DUMP | PROTECT | READ-ONE-TRIG | NVM-PROG | NVM-RELOAD |
| R/W-0h     |    |    |    | R/W-0h |    |   |   | R/W-0h | R/W-0h | X-0h | R/W-0h     | R/W-0h  | R/W-0h        | R/W-0h   | R/W-0h     |

**Table 7-34. COMMON-TRIGGER Register Field Descriptions**

| Bit    | Field         | Type | Reset | Description                                                                                                                                                                                         |
|--------|---------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-12  | DEV-UNLOCK    | R/W  | 0000  | 0101: Device unlocking password<br>Others: Don't care                                                                                                                                               |
| 11 - 8 | RESET         | W    | 0000  | 1010: POR reset triggered. This bit self-resets.<br>Others: Don't care                                                                                                                              |
| 7      | LDAC          | R/W  | 0     | 0: LDAC operation not triggered<br>1: LDAC operation triggered if the respective SYNC-CONFIG-X bit in the DAC-X-FUNC-CONFIG register is 1. This bit self-resets.                                    |
| 6      | CLR           | R/W  | 0     | 0: DAC registers and outputs unaffected<br>1: DAC registers and outputs set to zero-code or mid-code based on the respective CLR-SEL-X bit in the DAC-X-FUNC-CONFIG register. This bit self-resets. |
| 5      | X             | X    | 0     | Don't care                                                                                                                                                                                          |
| 4      | FAULT-DUMP    | R/W  | 0     | 0: Fault-dump is not triggered<br>1: Triggers fault-dump sequence. This bit self-resets.                                                                                                            |
| 3      | PROTECT       | R/W  | 0     | 0: PROTECT function not triggered<br>1: Trigger PROTECT function. This bit is self-resetting.                                                                                                       |
| 2      | READ-ONE-TRIG | R/W  | 0     | 0: Fault-dump read not triggered<br>1: Read one row of NVM for fault-dump. This bit self-resets.                                                                                                    |
| 1      | NVM-PROG      | R/W  | 0     | 0: NVM write not triggered<br>1: NVM write triggered. This bit self-resets.                                                                                                                         |
| 0      | NVM-RELOAD    | R/W  | 0     | 0: NVM reload not triggered<br>1: Reload data from NVM to register map. This bit self-resets.                                                                                                       |

### 7.6.11 COMMON-DAC-TRIG Register (address = 21h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = E5h

**Figure 7-32. COMMON-DAC-TRIG Register**

| 15               | 14            | 13            | 12               | 11               | 10            | 9             | 8                | 7                | 6             | 5             | 4                | 3                | 2             | 1             | 0                |
|------------------|---------------|---------------|------------------|------------------|---------------|---------------|------------------|------------------|---------------|---------------|------------------|------------------|---------------|---------------|------------------|
| RESET-CMP-FLAG-0 | TRIG-MAR-LO-0 | TRIG-MAR-HI-0 | START-FUNC-0     | RESET-CMP-FLAG-1 | TRIG-MAR-LO-1 | TRIG-MAR-HI-1 | START-FUNC-1     | RESET-CMP-FLAG-2 | TRIG-MAR-LO-2 | TRIG-MAR-HI-2 | START-FUNC-2     | RESET-CMP-FLAG-2 | TRIG-MAR-LO-3 | TRIG-MAR-HI-3 | START-FUNC-3     |
| $\bar{W}$ -0h    | $\bar{W}$ -0h | $\bar{W}$ -0h | R/ $\bar{W}$ -0h | $\bar{W}$ -0h    | $\bar{W}$ -0h | $\bar{W}$ -0h | R/ $\bar{W}$ -0h | $\bar{W}$ -0h    | $\bar{W}$ -0h | $\bar{W}$ -0h | R/ $\bar{W}$ -0h | $\bar{W}$ -0h    | $\bar{W}$ -0h | $\bar{W}$ -0h | R/ $\bar{W}$ -0h |

**Table 7-35. COMMON-DAC-TRIG Register Field Descriptions**

| Bit          | Field            | Type         | Reset | Description                                                                                                                  |
|--------------|------------------|--------------|-------|------------------------------------------------------------------------------------------------------------------------------|
| 15, 11, 7, 3 | RESET-CMP-FLAG-X | $\bar{W}$    | 0     | 0: Latching-comparator output unaffected<br>1: Reset latching-comparator and window-comparator output. This bit self-resets. |
| 14, 10, 6, 2 | TRIG-MAR-LO-X    | $\bar{W}$    | 0     | 0: Don't care<br>1: Trigger margin-low command. This bit self-resets.                                                        |
| 13, 9, 5, 1  | TRIG-MAR-HI-X    | $\bar{W}$    | 0     | 0: Don't care<br>1: Trigger margin-high command. This bit self-resets.                                                       |
| 12, 8, 4, 0  | START-FUNC-X     | R/ $\bar{W}$ | 0     | 0: Stop function generation<br>1: Start function generation as per FUNC-GEN-CONFIG-X in the DAC-X-FUNC-CONFIG register.      |



### 7.6.12 GENERAL-STATUS Register (address = 22h) [reset = 00h, DEVICE-ID, VERSION-ID]

PMBus page address = FFh, PMBus register address = E6h

**Figure 7-33. GENERAL-STATUS Register**

| 15               | 14                | 13   | 12         | 11         | 10         | 9          | 8    | 7         | 6 | 5 | 4 | 3 | 2 | 1          | 0 |
|------------------|-------------------|------|------------|------------|------------|------------|------|-----------|---|---|---|---|---|------------|---|
| NVM-CRC-FAIL-INT | NVM-CRC-FAIL-USER | X    | DAC-3-BUSY | DAC-2-BUSY | DAC-1-BUSY | DAC-0-BUSY | X    | DEVICE-ID |   |   |   |   |   | VERSION-ID |   |
| R-0h             | R-0h              | R-0h | R-0h       | R-0h       | R-0h       | R-0h       | X-0h | R         |   |   |   |   |   | R-0h       |   |

**Table 7-36. GENERAL-STATUS Register Field Descriptions**

| Bit | Field             | Type | Reset                          | Description                                                                                                                                                                                                                                                                                    |
|-----|-------------------|------|--------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15  | NVM-CRC-FAIL-INT  | R    | 0                              | 0: No CRC error in OTP<br>1: Indicates a failure in OTP loading. A software reset or power-cycle can bring the device out of this condition in case of temporary failure.                                                                                                                      |
| 14  | NVM-CRC-FAIL-USER | R    | 0                              | 0: No CRC error in NVM loading<br>1: Indicates a failure in NVM loading. The register settings are corrupted. The device allows all operations during this error condition. Reprogram the NVM to get original state. A software reset brings the device out of this temporary error condition. |
| 13  | X                 | R    | 0                              | Don't care                                                                                                                                                                                                                                                                                     |
| 12  | DAC-3-BUSY        | R    | 0                              | 0: DAC-3 channel can accept commands<br>1: DAC-3 channel does not accept commands                                                                                                                                                                                                              |
| 11  | DAC-2-BUSY        | R    | 0                              | 0: DAC-2 channel can accept commands<br>1: DAC-2 channel does not accept commands                                                                                                                                                                                                              |
| 10  | DAC-1-BUSY        | R    | 0                              | 0: DAC-1 channel can accept commands<br>1: DAC-1 channel does not accept commands                                                                                                                                                                                                              |
| 9   | DAC-0-BUSY        | R    | 0                              | 0: DAC-0 channel can accept commands<br>1: DAC-0 channel does not accept commands                                                                                                                                                                                                              |
| 8   | X                 | R    | 0                              | Don't care                                                                                                                                                                                                                                                                                     |
| 7-2 | DEVICE-ID         | R    | DAC53004: 05h<br>DAC63004: 04h | Device identifier                                                                                                                                                                                                                                                                              |
| 1-0 | VERSION-ID        | R    | 00                             | Version identifier                                                                                                                                                                                                                                                                             |

### 7.6.13 CMP-STATUS Register (address = 23h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = E7h

**Figure 7-34. CMP-STATUS Register**

| 15   | 14 | 13 | 12 | 11 | 10 | 9 | 8                | 7             | 6             | 5             | 4             | 3                  | 2                  | 1                  | 0                  |
|------|----|----|----|----|----|---|------------------|---------------|---------------|---------------|---------------|--------------------|--------------------|--------------------|--------------------|
| X    |    |    |    |    |    |   | PROTECT-<br>FLAG | WIN-<br>CMP-3 | WIN-<br>CMP-2 | WIN-<br>CMP-1 | WIN-<br>CMP-0 | CMP-<br>FLAG-<br>3 | CMP-<br>FLAG-<br>2 | CMP-<br>FLAG-<br>1 | CMP-<br>FLAG-<br>0 |
| X-0h |    |    |    |    |    |   | R-0h             | R-0h          | R-0h          | R-0h          | R-0h          | R-0h               | R-0h               | R-0h               | R-0h               |

**Table 7-37. CMP-STATUS Register Field Descriptions**

| Bit        | Field        | Type | Reset | Description                                                                                                                                               |
|------------|--------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-9       | X            | X    | 0     | Don't care                                                                                                                                                |
| 8          | PROTECT-FLAG | R    | 0     | 0: PROTECT operation not triggered.<br>1: PROTECT function is completed or in progress. This bit resets to 0 when read.                                   |
| 7, 6, 5, 4 | WIN-CMP-X    | R    | 0     | Window comparator output from respective channels. The output is latched or unlatched based on the WINDOW-LATCH-EN setting in the COMMON-CONFIG register. |
| 3, 2, 1, 0 | CMP-FLAG-X   | R    | 0     | Synchronized comparator output from respective channels.                                                                                                  |

### 7.6.14 GPIO-CONFIG Register (address = 24h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = E8h

**Figure 7-35. GPIO-CONFIG Register**

| 15     | 14                    | 13     | 12         | 11 | 10 | 9 | 8          | 7 | 6 | 5 | 4          | 3 | 2 | 1 | 0      |
|--------|-----------------------|--------|------------|----|----|---|------------|---|---|---|------------|---|---|---|--------|
| GF-EN  | DEEP-<br>SLEEP-<br>EN | GPO-EN | GPO-CONFIG |    |    |   | GPI-CH-SEL |   |   |   | GPI-CONFIG |   |   |   | GPI-EN |
| R/W-0h | R/W-0h                | R/W-0h | R/W-0h     |    |    |   | R/W-0h     |   |   |   | R/W-0h     |   |   |   | R/W-0h |

**Table 7-38. GPIO-CONFIG Register Field Descriptions**

| Bit  | Field         | Type | Reset | Description                                                                                                                                                                                                                                                                                |
|------|---------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15   | GF-EN         | R/W  | 0     | 0: Glitch filter disabled for GP input. This setting provides faster response.<br>1: Glitch filter enabled for GP input. This setting introduces additional propagation delay but provides robustness.                                                                                     |
| 14   | DEEP-SLEEP-EN | R/W  | 0     | 0: Deep-sleep mode disabled<br>1: Deep-sleep mode enabled for GP input                                                                                                                                                                                                                     |
| 13   | GPO-EN        | R/W  | 0     | 0: Disable output mode for GPIO pin<br>1: Enable output mode for GPIO pin                                                                                                                                                                                                                  |
| 12-9 | GPO-CONFIG    | R/W  | 0000  | STATUS function setting. The GPIO pin is mapped to the following register bits as output:<br>0001: NVM-BUSY<br>0100: DAC-0-BUSY<br>0101: DAC-1-BUSY<br>0110: DAC-2-BUSY<br>0111: DAC-3-BUSY<br>1000: WIN-CMP-0<br>1001: WIN-CMP-1<br>1010: WIN-CMP-2<br>1011: WIN-CMP-3<br>Others: Invalid |

**Table 7-38. GPIO-CONFIG Register Field Descriptions (continued)**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-----|------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 8-5 | GPI-CH-SEL | R/W  | 0000  | <p>Each bit corresponds to a DAC channel. 0b is <i>disabled</i> and 1b is <i>enabled</i>.</p> <p>GPI-CH-SEL[0]: Channel 0<br/> GPI-CH-SEL[1]: Channel 1<br/> GPI-CH-SEL[2]: Channel 2<br/> GPI-CH-SEL[3]: Channel 3</p> <p>Example: when GPI-CH-SEL is 0101, both channel-0 and channel-2 are enabled and both channel-1 and channel-3 are disabled.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 4-1 | GPI-CONFIG | R/W  | 0000  | <p>GPIO pin input configuration. Global settings act on the entire device. Channel-specific settings are dependent on the channel selection by the GPI-CH-SEL bits:</p> <p>0000: <math>\overline{\text{DEEP-SLEEP}}</math> (global). GPIO falling-edge triggers deep-sleep mode, GPIO rising-edge takes the device out of deep-sleep mode.</p> <p>0010: <math>\overline{\text{FAULT-DUMP}}</math> (global). GPIO falling-edge triggers fault-dump, GPIO = 1 has no effect.</p> <p>0011: IOUT power-up, down (channel-specific). GPIO falling-edge triggers power-down, GPIO rising-edge triggers power-up.</p> <p>0100: VOUT power-up/down (channel-specific). The output load is as per the VOUT-PDN-X setting. GPIO falling-edge triggers power-down, GPIO rising-edge triggers power-up.</p> <p>0101: <math>\overline{\text{PROTECT}}</math> input (global). GPIO falling-edge asserts <math>\overline{\text{PROTECT}}</math> function, GPIO = 1 has no effect.</p> <p>0111: <math>\overline{\text{CLR}}</math> input (global). GPIO = 0 asserts <math>\overline{\text{CLR}}</math> function, GPIO = 1 has no effect.</p> <p>1000: <math>\overline{\text{LDAC}}</math> input (channel-specific). GPIO falling-edge asserts <math>\overline{\text{LDAC}}</math> function, GPIO = 1 has no effect. Both the SYNC-CONFIG-X and the GPI-CH-SEL must be configured for every channel.</p> <p>1001: Start, stop function generation (channel-specific). GPIO falling-edge stops function generation. GPIO rising-edge starts function generation.</p> <p>1010: Trigger margin-high, low (channel-specific). GPIO falling-edge triggers margin-low. GPIO rising-edge triggers margin-high.</p> <p>1011: <math>\overline{\text{RESET}}</math> input (global). The falling-edge of the GPIO pin asserts the <math>\overline{\text{RESET}}</math> function. The <math>\overline{\text{RESET}}</math> input must be a pulse. The GPIO rising-edge brings the device out of reset. The <math>\overline{\text{RESET}}</math> configuration must be programmed into the NVM. Otherwise the setting will be cleared after the device reset.</p> <p>1100: NVM write-protection (global). GPIO falling-edge allows NVM programming. GPIO rising-edge blocks NVM programming.</p> <p>1101: Register-map lock (global). GPIO falling-edge allows update to the register map. GPIO rising-edge blocks any register map update except a write to the DEV-UNLOCK field through I<sup>2</sup>C or SPI and to the RESET field through I<sup>2</sup>C.</p> <p>Others: Not applicable</p> |
| 0   | GPI-EN     | R/W  | 0     | <p>0: Disable input mode for GPIO pin<br/> 1: Enable input mode for GPIO pin</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

### 7.6.15 DEVICE-MODE-CONFIG Register (address = 25h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = E9h

**Figure 7-36. DEVICE-MODE-CONFIG Register**

| 15       | 14 | 13          | 12 | 11       | 10 | 9              | 8 | 7        | 6 | 5 | 4 | 3 | 2    | 1 | 0 |
|----------|----|-------------|----|----------|----|----------------|---|----------|---|---|---|---|------|---|---|
| RESERVED |    | DIS-MODE-IN |    | RESERVED |    | PROTECT-CONFIG |   | RESERVED |   |   |   |   | X    |   |   |
| R/W-0h   |    | R/W-0h      |    | R/W-0h   |    | R/W-0h         |   | R/W-0h   |   |   |   |   | X-0h |   |   |

**Table 7-39. DEVICE-MODE-CONFIG Register Field Descriptions**

| Bit   | Field          | Type | Reset | Description                                                                                                                                                                                                                                                       |
|-------|----------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-14 | RESERVED       | R/W  | 00    | Always write 0b00                                                                                                                                                                                                                                                 |
| 13    | DIS-MODE-IN    | R/W  | 0     | Write 1 to this bit for low-power consumption.                                                                                                                                                                                                                    |
| 12-10 | RESERVED       | R/W  | 0     | Always write 0b000                                                                                                                                                                                                                                                |
| 9-8   | PROTECT-CONFIG | R/W  | 00    | 00: Switch to Hi-Z power-down (no slew)<br>01: Switch to DAC code stored in NVM (no slew) and then switch to Hi-Z power-down<br>10: Slew to margin-low code and then switch to Hi-Z power-down<br>11: Slew to margin-high code and then switch to Hi-Z power-down |
| 7-5   | RESERVED       | R/W  | 0     | Always write 0b000                                                                                                                                                                                                                                                |
| 4-0   | X              | R/W  | 00h   | Don't care                                                                                                                                                                                                                                                        |

### 7.6.16 INTERFACE-CONFIG Register (address = 26h) [reset = 0000h]

**Figure 7-37. INTERFACE-CONFIG Register**

| 15   | 14 | 13         | 12 | 11   | 10 | 9        | 8 | 7    | 6 | 5 | 4 | 3       | 2    | 1      | 0 |
|------|----|------------|----|------|----|----------|---|------|---|---|---|---------|------|--------|---|
| X    |    | TIMEOUT-EN |    | X    |    | EN-PMBUS |   | X    |   |   |   | FSDO-EN | X    | SDO-EN |   |
| X-0h |    | R/W-0h     |    | X-0h |    | R/W-0h   |   | X-0h |   |   |   | R/W-0h  | X-0h | R/W-0h |   |

**Table 7-40. INTERFACE-CONFIG Register Field Descriptions**

| Bit   | Field      | Type | Reset | Description                                                                 |
|-------|------------|------|-------|-----------------------------------------------------------------------------|
| 15-13 | X          | X    | 0h    | Don't care                                                                  |
| 12    | TIMEOUT-EN | R/W  | 0     | 0: I <sup>2</sup> C timeout disabled<br>1: I <sup>2</sup> C timeout enabled |
| 11-9  | X          | X    | 0h    | Don't care                                                                  |
| 8     | EN-PMBUS   | R/W  | 0     | 0: PMBus disabled<br>1: Enable PMBus                                        |
| 7-3   | X          | X    | 00h   | Don't care                                                                  |
| 2     | FSDO-EN    | R/W  | 0     | 0: Fast SDO disabled<br>1: Fast SDO enabled                                 |
| 1     | X          | X    | 0     | Don't care                                                                  |
| 0     | SDO-EN     | R/W  | 0     | 0: SDO disabled<br>1: SDO enabled on GPIO pin                               |

### 7.6.17 SRAM-CONFIG Register (address = 2Bh) [reset = 0000h]

PMBus page address = FFh, PMBus register address = EFh

**Figure 7-38. SRAM-CONFIG Register**

| 15   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7         | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----|---|---|-----------|---|---|---|---|---|---|---|
| X    |    |    |    |    |    |   |   | SRAM-ADDR |   |   |   |   |   |   |   |
| X-0h |    |    |    |    |    |   |   | R/W-0h    |   |   |   |   |   |   |   |

**Table 7-41. SRAM-CONFIG Register Field Descriptions**

| Bit  | Field     | Type | Reset | Description                                                                                                                                                          |
|------|-----------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-8 | X         | X    | 0h    | Don't care                                                                                                                                                           |
| 7-0  | SRAM-ADDR | R/W  | 0h    | 8-bit SRAM address. Writing to this register field configures the SRAM address to be accessed next. This address automatically increments after a write to the SRAM. |

### 7.6.18 SRAM-DATA Register (address = 2Ch) [reset = 0000h]

PMBus page address = FFh, PMBus register address = F0h

**Figure 7-39. SRAM-DATA Register**

| 15        | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| SRAM-DATA |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| R/W-0h    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**Table 7-42. SRAM-DATA Register Field Descriptions**

| Bit  | Field     | Type | Reset | Description                                                                                                |
|------|-----------|------|-------|------------------------------------------------------------------------------------------------------------|
| 15-0 | SRAM-ADDR | R/W  | 0h    | 16-bit SRAM data. This data is written to or read from the address configured in the SRAM-CONFIG register. |

### 7.6.19 DAC-X-DATA-8BIT Register (address = 40h, 41h, 42h, 43h) [reset = 0000h]

PMBus page address = Not applicable, PMBus register address = Not applicable

**Figure 7-40. DAC-X-DATA-8BIT Register**

| 15                   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7    | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------------------|----|----|----|----|----|---|---|------|---|---|---|---|---|---|---|
| DAC-X-DATA-8BIT[7:0] |    |    |    |    |    |   |   | X    |   |   |   |   |   |   |   |
| R/W-0h               |    |    |    |    |    |   |   | X-0h |   |   |   |   |   |   |   |

**Table 7-43. DAC-X-DATA-8BIT Register Field Descriptions**

| Bit  | Field                | Type | Reset | Description                                                                                                                               |
|------|----------------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------|
| 15-8 | DAC-X-DATA-8BIT[7:0] | R/W  | 00h   | 8-bit data for current output. This register provides faster update rate in the I <sup>2</sup> C mode. Data are in straight-binary format |
| 7-0  | X                    | X    | 00h   | Not applicable                                                                                                                            |

### 7.6.20 BRDCAST-DATA Register (address = 50h) [reset = 0000h]

PMBus page address = FFh, PMBus register address = F1h

**Figure 7-41. BRDCAST-DATA Register**

| 15                                      | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3    | 2 | 1 | 0 |
|-----------------------------------------|----|----|----|----|----|---|---|---|---|---|---|------|---|---|---|
| BRDCAST-DATA[11:0]<br>BRDCAST-DATA[9:0] |    |    |    |    |    |   |   |   |   |   |   | X    |   |   |   |
| R/W-0h                                  |    |    |    |    |    |   |   |   |   |   |   | X-0h |   |   |   |

**Table 7-44. BRDCAST-DATA Register Field Descriptions**

| Bit  | Field                                   | Type | Reset | Description                                                                                                                                                                                                                                                                                                                           |
|------|-----------------------------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-4 | BRDCAST-DATA[11:0]<br>BRDCAST-DATA[9:0] | R/W  | 000h  | Broadcast code for all DAC channels<br>Data are in straight-binary format. MSB left-aligned. Use the following bit-alignment:<br>DAC63004: {BRDCAST-DATA[11:0]}<br>DAC53004: {BRDCAST-DATA[9:0], X, X}<br>X = Don't care bits.<br>The BRD-CONFIG-X bit in the DAC-X-FUNC-CONFIG register must be enabled for the respective channels. |
| 3-0  | X                                       | X    | 0h    | Don't care.                                                                                                                                                                                                                                                                                                                           |

### 7.6.21 PMBUS-PAGE Register [reset = 0300h]

PMBus page address = X, PMBus register address = 00h

**Figure 7-42. PMBUS-PAGE Register**

| 15         | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|----|----|----|----|----|---|---|-------|---|---|---|---|---|---|---|
| PMBUS-PAGE |    |    |    |    |    |   |   | X     |   |   |   |   |   |   |   |
| R/W-03h    |    |    |    |    |    |   |   | X-00h |   |   |   |   |   |   |   |

**Table 7-45. PMBUS\_OPERATION Register Field Descriptions**

| Bit  | Field      | Type | Reset | Description                                                           |
|------|------------|------|-------|-----------------------------------------------------------------------|
| 15-8 | PMBUS-PAGE | R/W  | 03h   | 8-bit PMBus page address as specified in <a href="#">Table 7-21</a> . |
| 7-0  | X          | X    | 00h   | Not applicable                                                        |

### 7.6.22 PMBUS-OP-CMD-X Register [reset = 0000h]

PMBus page address = 00h, 01h, 02h, 03h, PMBus register address = 01h

**Figure 7-43. PMBUS-OP-CMD-X Register (X = 0, 1, 2, 3)**

| 15                    | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-----------------------|----|----|----|----|----|---|---|-------|---|---|---|---|---|---|---|
| PMBUS-OPERATION-CMD-X |    |    |    |    |    |   |   | X     |   |   |   |   |   |   |   |
| R/W-00h               |    |    |    |    |    |   |   | X-00h |   |   |   |   |   |   |   |

**Table 7-46. PMBUS-OP-CMD-X Register Field Descriptions**

| Bit  | Field                 | Type | Reset | Description                                                                                                                                                                                           |
|------|-----------------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-8 | PMBUS-OPERATION-CMD-X | R/W  | 00h   | PMBus operation commands:<br>00h: Turn off<br>80h: Turn on<br>A4h: Margin high, DAC output margins high to DAC-X-MARGIN-HIGH code<br>94h: Margin low, DAC output margins low to DAC-X-MARGIN-LOW code |
| 7-0  | X                     | X    | 00h   | Not applicable                                                                                                                                                                                        |

### 7.6.23 PMBUS-CML Register [reset = 0000h]

PMBus page address = X, PMBus register address = 78h

**Figure 7-44. PMBUS-CML Register**

| 15    | 14 | 13 | 12 | 11 | 10 | 9      | 8    | 7     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|----|----|----|----|----|--------|------|-------|---|---|---|---|---|---|---|
| X     |    |    |    |    |    | CML    | X    | N/A   |   |   |   |   |   |   |   |
| X-00h |    |    |    |    |    | R/W-0h | X-0h | X-00h |   |   |   |   |   |   |   |

**Table 7-47. PMBUS-CML Register Field Descriptions**

| Bit   | Field | Type | Reset | Description                                                                                                                                                                                                                  |
|-------|-------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-10 | X     | X    | 00h   | Don't care                                                                                                                                                                                                                   |
| 9     | CML   | R/W  | 0     | 0: No communication fault<br>1: PMBus communication fault for write with incorrect number of clocks, read before write command, invalid command address, and invalid or unsupported data value; reset this bit by writing 1. |
| 8     | X     | X    | 0h    | Don't care                                                                                                                                                                                                                   |
| 7-0   | X     | X    | 00h   | Not applicable                                                                                                                                                                                                               |

### 7.6.24 PMBUS-VERSION Register [reset = 2200h]

PMBus page address = X, PMBus register address = 98h

**Figure 7-45. PMBUS-VERSION Register**

| 15            | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7     | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---------------|----|----|----|----|----|---|---|-------|---|---|---|---|---|---|---|
| PMBUS-VERSION |    |    |    |    |    |   |   | X     |   |   |   |   |   |   |   |
| R-22h         |    |    |    |    |    |   |   | X-00h |   |   |   |   |   |   |   |

**Table 7-48. PMBUS-VERSION Register Field Descriptions**

| Bit  | Field         | Type | Reset | Description    |
|------|---------------|------|-------|----------------|
| 15-8 | PMBUS-VERSION | R    | 22h   | PMBus version  |
| 7-0  | X             | X    | 00h   | Not applicable |

## 8 Application and Implementation

### Note

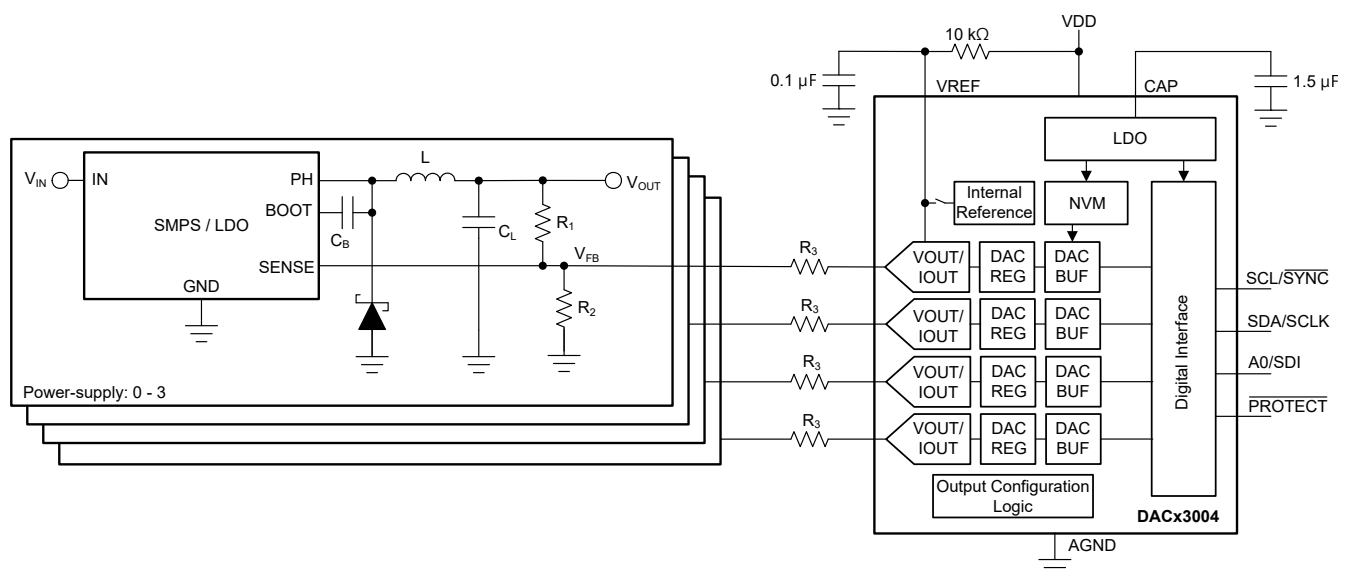
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

The DACx3004 are quad-channel buffered, force-sense output, voltage-output and current-output smart DACs that include an NVM and internal reference, and available in a tiny 3-mm × 3-mm package. In voltage-output mode, short the OUTx and FBx pins for each channel. In current-output mode, leave the FBx pins unconnected. The FBx pins function as inputs in comparator mode. The external reference must not exceed VDD, either during transient or steady-state conditions. For the best Hi-Z output performance, use a pullup resistor on the VREF pin to VDD. In case the VDD remains floating during the off condition, place a 100-kΩ resistor to AGND for proper detection of the VDD off condition. All the digital outputs are open drain; use external pullup resistors on these pins. The interface protocol is detected at power-on, and the device locks to the protocol as long as VDD is on. In I<sup>2</sup>C mode, when allocating the I<sup>2</sup>C addresses in the system, consider the broadcast address as well. I<sup>2</sup>C timeout can be enabled for robustness. SPI mode is 3-wire by default. Configure the GPIO pin as SDO in the NVM for SPI readback capability. The SPI clock speed in readback mode is slower than that in write mode. Power-down mode sets the DAC outputs in Hi-Z by default. Change the configuration appropriately for different power-down settings. The DAC channels can also power-up with a programmed DAC code in the NVM.

### 8.2 Typical Application

A power-supply margining and scaling circuit is used to trim, scale, or test the output of a power converter. This example circuit is used to test a system by margining the power supplies for adaptive voltage scaling or to program a desired value at the output. Adjustable power supplies, such as low-dropout regulators (LDOs) and DC/DC converters, provide a feedback or adjust the input that is used to set the desired output. A precision voltage-output DAC is the best choice for controlling the power-supply output linearly. Figure 8-1 shows a control circuit for a switch-mode power supply (SMPS) using the DACx3004. Typical applications of power-supply margining are communications equipment, enterprise servers, test and measurement, and general-purpose power-supply modules.



**Figure 8-1. Voltage Margining and Scaling**



## 8.2.1 Design Requirements

**Table 8-1. Design Parameters**

| PARAMETER                                       | VALUE                                  |
|-------------------------------------------------|----------------------------------------|
| Power-supply nominal output                     | 3.3 V                                  |
| Reference voltage of the converter ( $V_{FB}$ ) | 0.6 V                                  |
| Margin                                          | $\pm 10\%$ (that is, 2.97 V to 3.63 V) |
| DAC output range                                | 1.8 V                                  |
| Nominal current through $R_1$ and $R_2$         | 100 $\mu$ A                            |

## 8.2.2 Detailed Design Procedure

The DACx3004 features a Hi-Z power-down mode that is set by default at power-up, unless the device is programmed otherwise using the NVM. When the DAC output is at Hi-Z, the current through  $R_3$  is zero and the SMPS is set at the nominal output voltage of 3.3 V. To have the same nominal condition when the DAC powers up, bring up the device at the same output as  $V_{FB}$  (that is 0.6 V). This configuration makes sure there is no current through  $R_3$  even at power-up. Calculate  $R_1$  as  $(V_{OUT} - V_{FB}) / 100 \mu\text{A} = 27 \text{ k}\Omega$ .

To achieve  $\pm 10\%$  margin-high and margin-low conditions, the DAC must sink or source additional current through  $R_1$ . Calculate the current from the DAC ( $I_{MARGIN}$ ) using Equation 10 as 12  $\mu$ A.

$$I_{MARGIN} = \left( \frac{V_{OUT} \times (1 + \text{MARGIN}) - V_{FB}}{R_1} \right) - I_{NOMINAL} \quad (10)$$

where

- $I_{MARGIN}$  is the margin current sourced or sinked from the DAC.
- MARGIN is the percentage margin value divided by 100.
- $I_{NOMINAL}$  is the nominal current through  $R_1$  and  $R_2$ .

To calculate the value of  $R_3$ , first decide the DAC output range, and make sure to avoid the codes near zero-scale and full-scale for safe operation in the linear region. A DAC output of 20 mV is a safe consideration as the minimum output, and  $(1.8 \text{ V} - 0.6 \text{ V} - 20 \text{ mV} = 1.18 \text{ V})$  as the maximum output. When the DAC output is at 20 mV, the power supply goes to margin high, and when the DAC output is at 1.18 V, the power supply goes to margin low. Calculate the value of  $R_3$  using Equation 11 as 48.3 k $\Omega$ . Choose a standard resistor value and adjust the DAC outputs. Choosing  $R_3 = 47 \text{ k}\Omega$  makes the DAC margin high code as 1.164 V and the DAC margin low code as 36 mV.

$$R_3 = \frac{|V_{DAC} - V_{FB}|}{I_{MARGIN}} \quad (11)$$

When the DACx3004 are set in the current-output mode, the series resistor  $R_3$  is not required. Set the DAC output at the current-output range of  $-25 \mu\text{A}$  to  $+25 \mu\text{A}$ , and set the DAC code appropriately to achieve a margin current of  $\pm 12 \mu\text{A}$ .

The DACx3004 have a slew-rate feature that is used to toggle between margin high, margin low, and nominal outputs with a defined slew rate. See Section 7.6.7 for the slew-rate setting details.

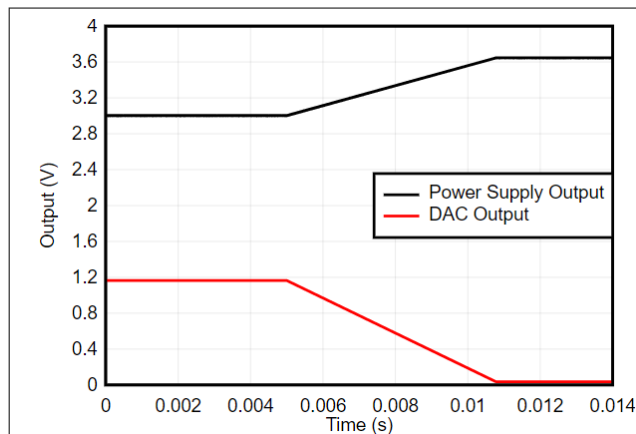
### Note

The DAC-X-MARGIN-HIGH register value in DACx3004 results in the *margin-low* value at the power supply output. Similarly, the DAC-X-MARGIN-LOW register value in DACx3004 results in the *margin-high* value at the power-supply output.

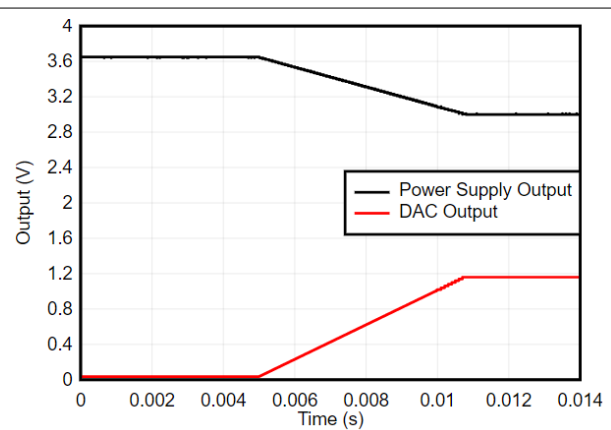
The pseudocode for getting started with a power-supply control application is as follows:

```
//SYNTAX: WRITE <REGISTER NAME (Hex code)>, <MSB DATA>, <LSB DATA>
//Write DAC code for nominal output (repeat for all DAC channels)
//For a 1.8-V output range, the 10-bit hex code for 0.6 V is 0x155. With 16-bit left alignment,
this becomes 0x5540
WRITE DAC_DATA(0x19), 0x55, 0x40
//Power-up voltage output on all channels, enables internal reference WRITE COMMON-CONFIG(0x1F),
0x12, 0x49
//Set channel 0 gain setting to 1.5x internal reference (1.8 V)
WRITE DAC-0-VOOUT-CMP-CONFIG(0x3), 0x08, 0x00
//Set channel 1 gain setting to 1.5x internal reference (1.8 V)
WRITE DAC-1-VOOUT-CMP-CONFIG(0x9), 0x08, 0x00
//Set channel 2 gain setting to 1.5x internal reference (1.8 V)
WRITE DAC-2-VOOUT-CMP-CONFIG(0xF), 0x08, 0x00
//Set channel 3 gain setting to 1.5x internal reference (1.8 V)
WRITE DAC-3-VOOUT-CMP-CONFIG(0x15), 0x08, 0x00
//Configure GPI for Margin-High, Low trigger for all channels
WRITE GPIO-CONFIG(0x24), 0x01, 0xF5
//Set slew rate and code step (repeat for all channels)
//CODE STEP: 2 LSB, SLEW_RATE: 60.72  $\mu$ s/step
WRITE DAC-0-FUNC-CONFIG(0x06), 0x00, 0x17
//Write DAC margin high code (repeat for all channels)
//For a 1.8-V output range, the 10-bit hex code for 1.164 V is 0x296. With 16-bit left alignment,
this becomes 0xA540
WRITE DAC-0-MARGIN-HIGH(0x01), 0xA5, 0x40
//Write DAC margin low code (repeat for all channels)
//For a 1.8-V output range, the 10-bit hex code for 36 mV is 0x14. With 16-bit left alignment, this
becomes 0x0500
WRITE DAC-0-MARGIN-LOW(0x02), 0x05, 0x00
//Save settings to NVM
WRITE COMMON-TRIGGER(0x20), 0x00, 0x02
```

### 8.2.3 Application Curves



**Figure 8-2. Power-Supply Margin High**



**Figure 8-3. Power-Supply Margin Low**

## 9 Power Supply Recommendations

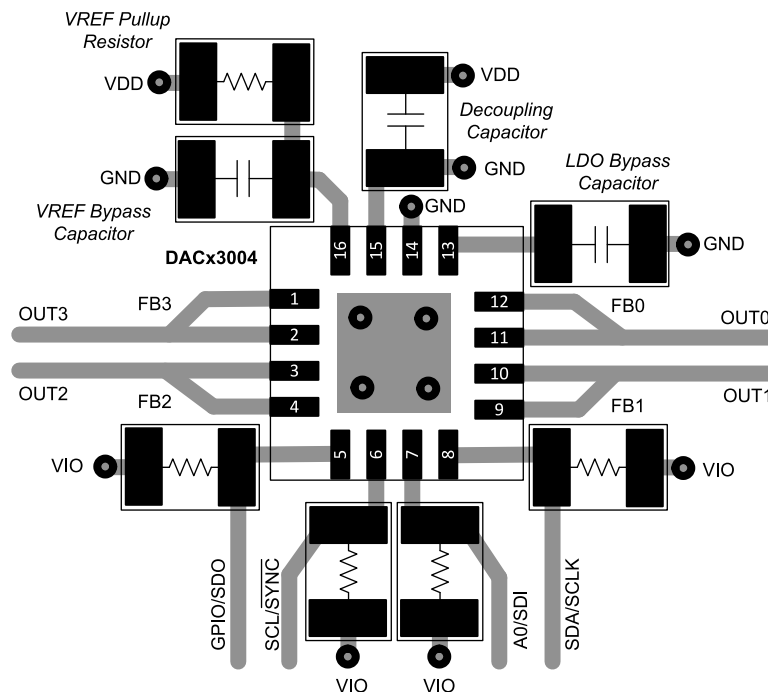
The DACx3004 family of devices does not require specific power-supply sequencing. These devices require a single power supply,  $V_{DD}$ . However, make sure the external voltage reference is applied after  $V_{DD}$ . Use a 0.1- $\mu\text{F}$  decoupling capacitor for the  $V_{DD}$  pin. Use a bypass capacitor with a value approximately 1.5  $\mu\text{F}$  for the CAP pin.

## 10 Layout

### 10.1 Layout Guidelines

The DACx3004 pin configuration separates the analog, digital, and power pins for an optimized layout. For signal integrity, separate the digital and analog traces, and place decoupling capacitors close to the device pins.

### 10.2 Layout Example



**Figure 10-1. Layout Example**

Note: The ground and power planes have been omitted for clarity. Connect the thermal pad to ground.

## 11 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

### 11.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.2 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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### 11.3 Trademarks

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TI E2E™ is a trademark of Texas Instruments.

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### 11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.5 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">DAC53004RTER</a> | Active        | Production           | WQFN (RTE)   16 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D53004              |
| DAC53004RTER.A               | Active        | Production           | WQFN (RTE)   16 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D53004              |
| <a href="#">DAC53004RTET</a> | Active        | Production           | WQFN (RTE)   16 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D53004              |
| DAC53004RTET.A               | Active        | Production           | WQFN (RTE)   16 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D53004              |
| <a href="#">DAC63004RTER</a> | Active        | Production           | WQFN (RTE)   16 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D63004              |
| DAC63004RTER.A               | Active        | Production           | WQFN (RTE)   16 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D63004              |
| <a href="#">DAC63004RTET</a> | Active        | Production           | WQFN (RTE)   16 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D63004              |
| DAC63004RTET.A               | Active        | Production           | WQFN (RTE)   16 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | D63004              |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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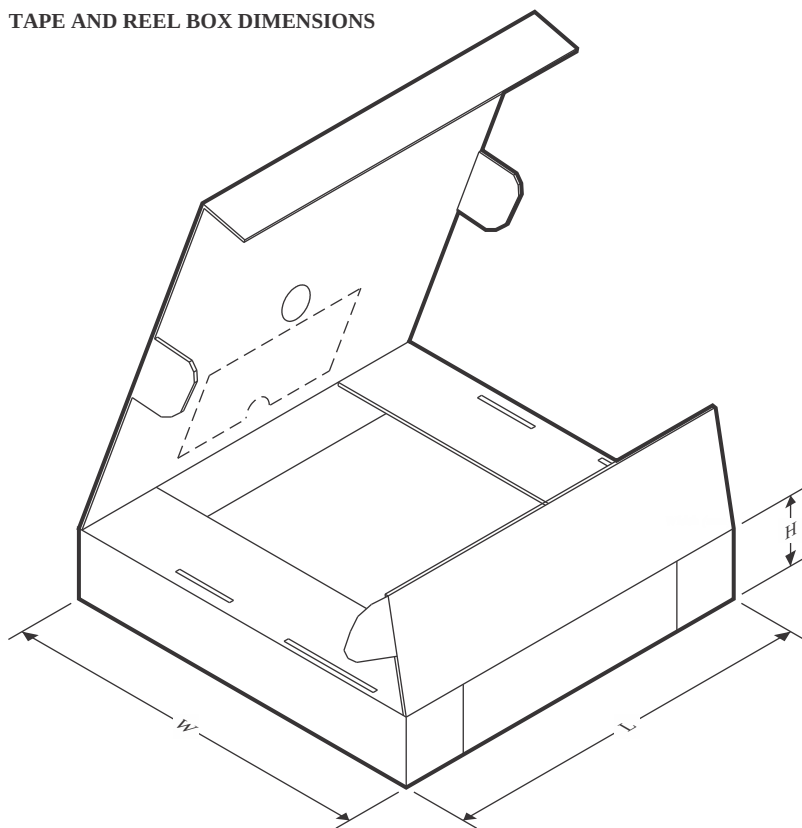
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| DAC53004RTER | WQFN         | RTE             | 16   | 3000 | 330.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |
| DAC53004RTET | WQFN         | RTE             | 16   | 250  | 180.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |
| DAC63004RTER | WQFN         | RTE             | 16   | 3000 | 330.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |
| DAC63004RTET | WQFN         | RTE             | 16   | 250  | 180.0              | 12.4               | 3.3     | 3.3     | 1.1     | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DAC53004RTER | WQFN         | RTE             | 16   | 3000 | 367.0       | 367.0      | 35.0        |
| DAC53004RTET | WQFN         | RTE             | 16   | 250  | 210.0       | 185.0      | 35.0        |
| DAC63004RTER | WQFN         | RTE             | 16   | 3000 | 367.0       | 367.0      | 35.0        |
| DAC63004RTET | WQFN         | RTE             | 16   | 250  | 210.0       | 185.0      | 35.0        |



## GENERIC PACKAGE VIEW

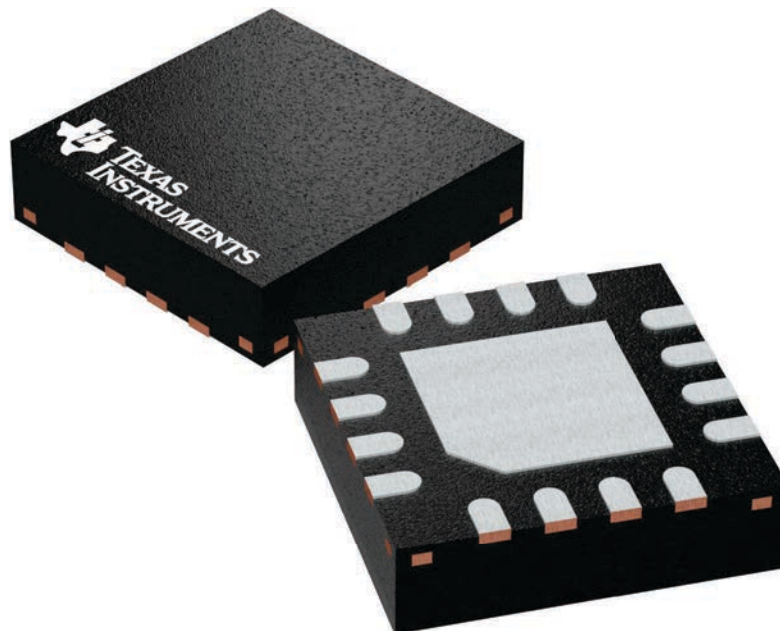
**RTE 16**

**WQFN - 0.8 mm max height**

3 x 3, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

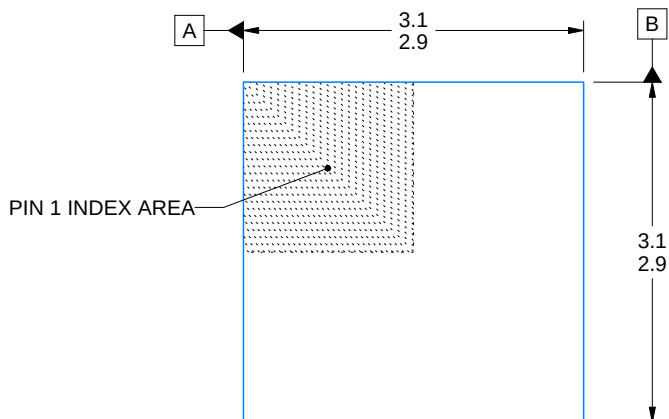
This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



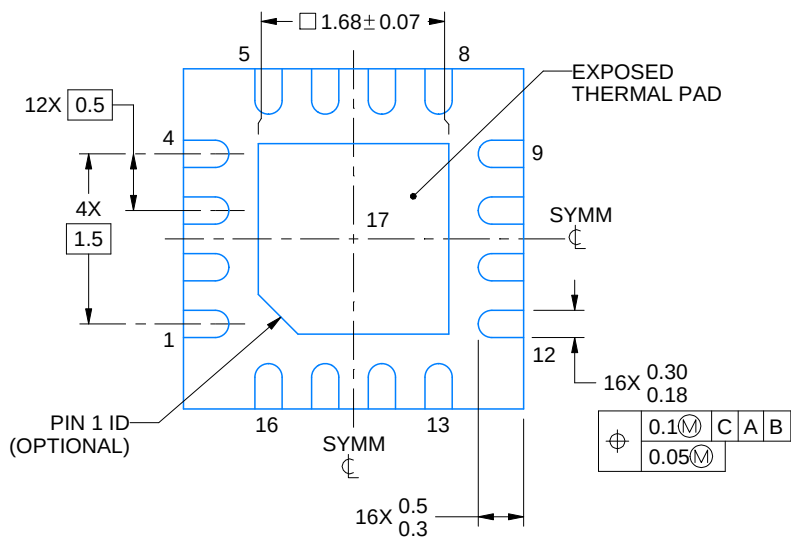
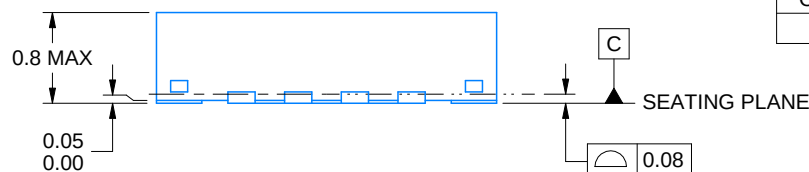


## WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



| SIDE WALL<br>METAL THICKNESS<br>DIM A |          |
|---------------------------------------|----------|
| OPTION 1                              | OPTION 2 |
| 0.1                                   | 0.2      |



→| |← (DIM A) TYP

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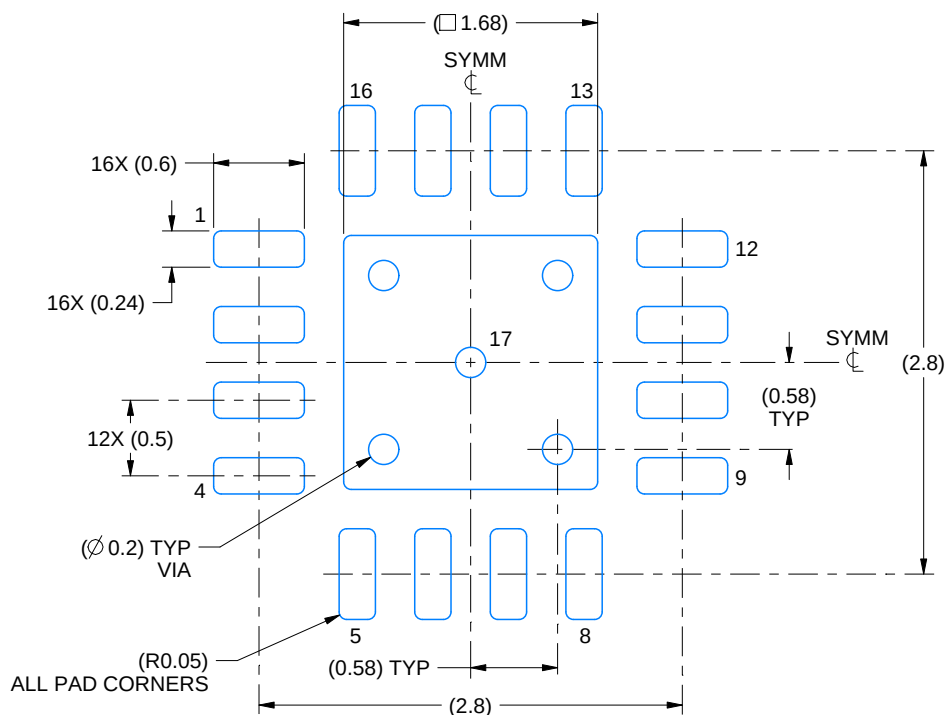
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

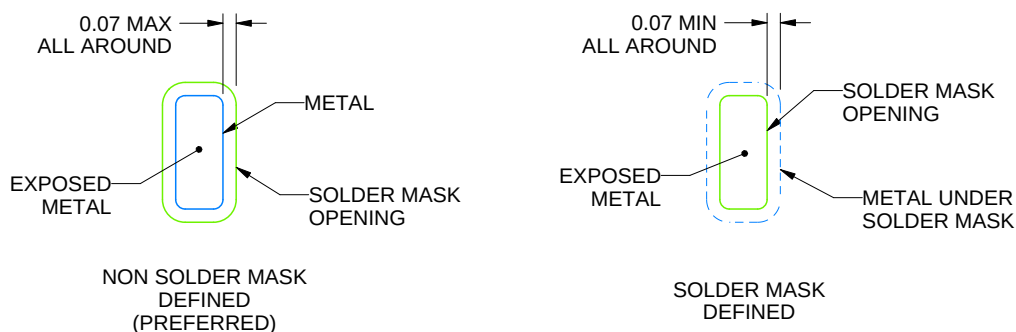
**RTE0016C**

**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:20X



## SOLDER MASK DETAILS

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NOTES: (continued)

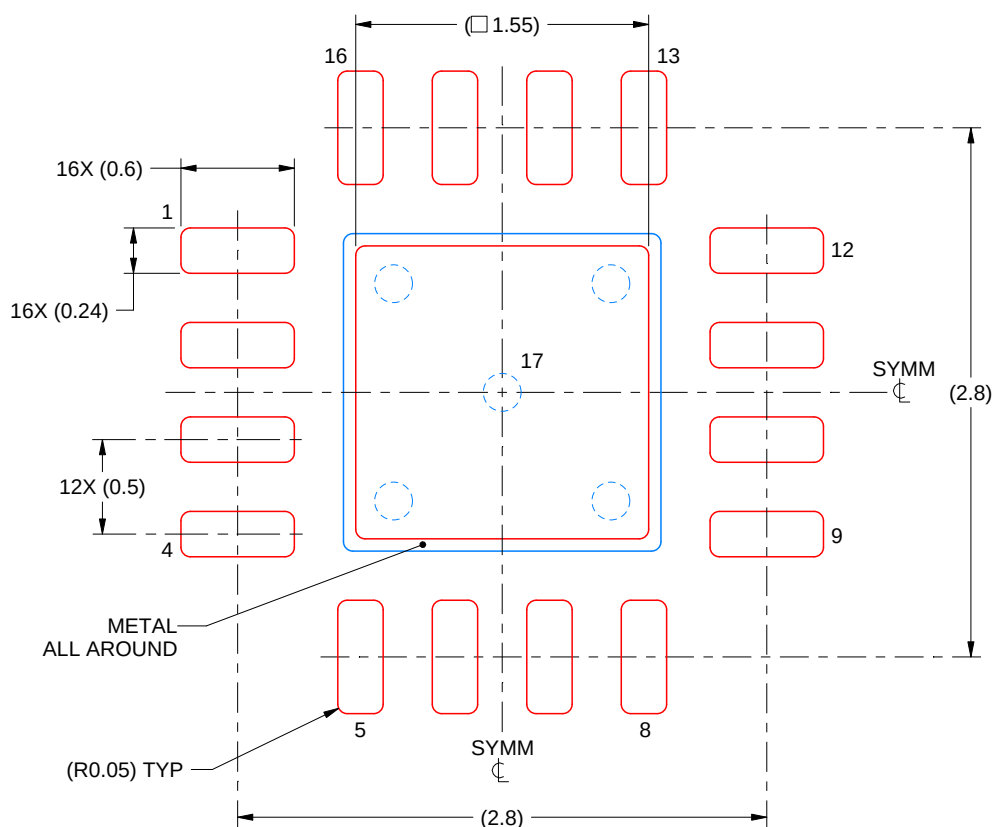
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RTE0016C

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 17:  
85% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:25X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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